

# DESIGN AND VERIFICATION OF WISHBONE BUS INTERFACE FOR SOC INTEGRATION

A thesis submitted in partial fulfilment of the requirements for the  
degree of

*Master of Technology (Research)*  
*in*  
*Electronics & Communication Engineering*

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January 2010

***Dedicated to  
my family***



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## CERTIFICATE

This is to certify that the thesis titled “**Design and Verification of WISHBONE Bus Interface for SOC Integration**” submitted to the National Institute of Technology, Rourkela by **Ayas Kanta Swain**, Roll No. **60609001** for the award of the degree of **Master of Technology (Research)** in Electronics & Communication Engineering, is a bonafide record of research work carried out by him under my supervision and guidance.

The candidate has fulfilled all the prescribed requirements.

The thesis, which is based on candidate’s own work, has not been submitted elsewhere for a degree/diploma.

In my opinion, the thesis is of standard required for the award of a Master of Technology (Research) degree in Electronics & Communication Engineering.

To the best of my knowledge, he bears a good moral character and decent behaviour.

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## **ABSTRACT**

The rapid development in the field of mobile communication, digital signal processing (DSP) motivated the design engineer to integrate complex systems of multimillion transistors in a single chip. The integration of the transistor in a single chip greatly increases the performance of the system while reduction in system size. Recently, there is a considerable increase in the application front in several areas of engineering and technology. Moore's law states that integration density gets doubled every two years, so the complexity of the integrated circuits also increases by keeping the used chip area constant. In order to keep pace with the levels of integration available, design engineers have developed new methodologies and techniques to manage the increased complexity in these large chips.

System-on-Chip (SOC) design is proposed as an extended methodology to this problem where pre-designed and pre-verified IP cores of embedded processors, memory blocks, interface blocks, and analog blocks are combined on a single chip targeting a specific application. These chips may have one or more processors on chip, a large amount of memory, bus-base architectures, peripherals, co processors, and I/O channels. These chips integrates systems far more similar to the boards designed ten years ago that to the chips of even a few years ago. The primary drivers for this are the reduction of power, smaller form factor, and lower overall cost. SOC offers many benefits such as smaller space requirements with higher performance. Design reuse- the use of predesigned and pre-verified cores – is now the cornerstone of SOC design. It uses reusable IP blocks that supports plug and play integration and in turn allows huge chips to be designed at an acceptable cost, and quality.

The benefits SOC design methodology also come with challenges such as: larger design space, higher design and prototype costs. Apart from these challenges, the design again needs an expertise in both hardware and software levels for proper hardware and software co-design. Another important aspect of SOC integration is the development of a proper test methodology for post manufacturing test. All these integration issues makes the design time consuming and also expensive.

To deal with this inherent integration problems and reduction in design cycle time, platform based SoC design was proposed where new designs could be quickly

created from the original platform over many design derivatives. More specifically a platform is an abstraction level that covers a number of refinements to a lower level resulting in improvement of the design productivity. In other side, a new concept that is gaining interest is the Open Core SoC design methodology which is based on publishing all necessary information about the hardware. Open Core group has provided many pre-synthesized and pre-verified hardware core for the designer under GPL/LGPL license.

This thesis investigates the Open core based SOC design platform. Open Core uses a standard bus WISHBONE to alleviate System-on-Chip problem. The various issues related to Open Core WISHBONE bus interfaces are presented in this thesis. These include WISHBONE specification, types of interconnections, WISHBONE Bus cycles.etc. A comparison of three bus protocol has been discussed. The issues related to design of a WISHBONE compatible IP core, Point-to-Point interconnection, shared bus interconnection is also presented in this investigation. All the designs are validated by XILINX ISE simulation results and real time debugging signals through ChipScope Pro. A SOC design methodology has been presented for a proposed SOC architecture. Afterwards a SOC architecture of 32-bit RISC CPU, memory, System Controller, UART and PIO has been proposed and the design methodology used to implement the SOC in FPGA has been discussed. The functionality of CPU operation in SOC architecture is verified by simulation results and corresponding steps for FPGA implementation of the SOC architecture with synthesis results have been presented. Finally, application software has been developed in C and the object file is ported to FPGA system for validation of the SOC functionality of the SOC architecture.

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## List of Abbreviations:

SOC	System on Chip
IP	Intellectual Property
PBD	Platform Based Design
CAD	Computer Aided Design
GPL	General Public License
LGPL	Lesser General Public License
RTL	Register Transfer Logic
VGA	Video Graphics Array
UART	Universal Asynchronous Receiver/Transmitter
MAC	Multiply and Accumulate
PCI	Peripheral Interconnect Component
VME	VERSAmodule Eurocard bus
ISA	Instruction Set Architecture
RISC	Reduction Instruction Set Architecture
DSP	Digital Signal Processing
ASIC	Application Specific Integrated Circuit
FPGA	Field Programmable Gate Array
VHDL	VHSIC Hardware Description Language
RMW	Read Modify Write
ASB	Advanced System Bus
AHB	Advanced High performance Bus
APB	Advanced Peripheral Bus
PLB	Processor Local Bus
OPB	On-Chip Peripheral Bus

# Chapter 1

## System-on-Chip: An Overview

- **Concept of System-on-Chip**
- **History of SOC**
- **Design Reuse Concept**
- **The system on chip design flow and process**
- **System level Design Issues**
- **Motivation**
- **Work Presented in the Thesis**
- **Thesis Outline**
- **Conclusions**

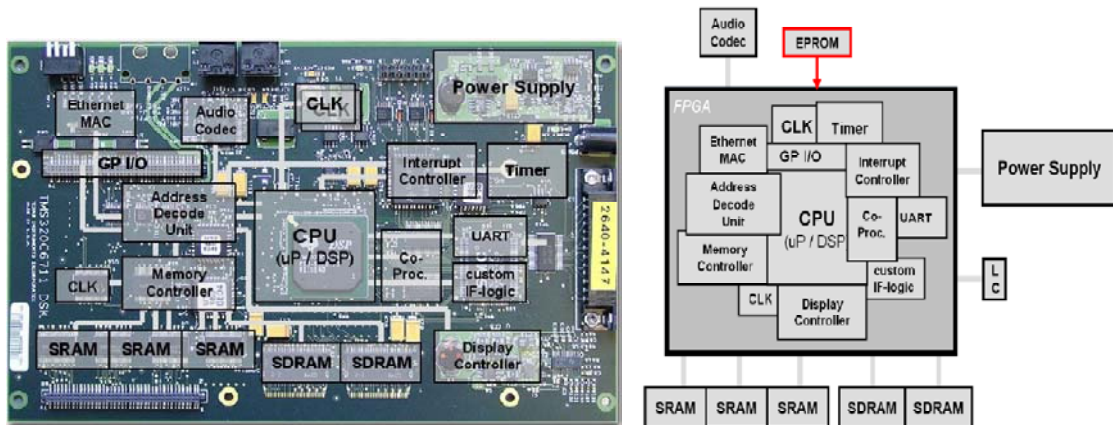
This chapter describes the System-on-Chip (SOC) design concept. Various issues related to SOC design such as “Design Reuse”, system design flow and system design processes are discussed in this chapter. The system level issues such as on-chip buses, SOC test methodologies and SOC verifications are also discussed. In the final section the motivation behind the thesis, work presented in this thesis with thesis outline is presented.

## **1.1 Concept of System-on-Chip**

The rapid development in the field of mobile communication, digital signal processing (DSP) motivated the design engineer to integrate complex systems of multimillion transistors in a single chip. The integration of the transistor in a single chip greatly increases the performance of the system while reduction in system size. There is a considerable increase in the application front in recent time. Moore’s law states that integration density gets doubled every two years so the complexity of the integrated systems also increases by keeping the used chip area constant. In order to keep pace with the levels of integration available, design engineers have developed new methodologies and techniques to manage the increased complexity in these large chips [1].

System-on-Chip (SOC) design is proposed as an extended methodology to this problem where IP cores of embedded processors, memory blocks, interface blocks, and analog blocks are combined on a single chip targeting a specific application. These chips may have one or more processors on chip, a large amount of memory, bus-based architectures, peripherals, co- processors, and I/O channels [2]. These chips integrates systems far more similar to the boards designed ten years ago than to the chips of even a few years ago [2]. The integration process involves connecting the IP blocks to the communication network, implementing design-for-test (DFT) techniques and using methodologies to verify and validate the overall system-level design [1].

Figure: 1.1 shows idea of SOC the a system of several ICs out of a printed circuit board is being integrated into a single chip while maintaining the overall structure the same.



**Figure: 1. 1 Idea of SOC design**

The benefits of SOC design include:

- Smaller space requirements.
- Reduction in chip count.
- Lower memory requirements.
- Greater design freedom.
- Lower consumer costs.
- Higher performance and more reliable as the system will be on a single chip.

These benefits also come with challenges including:

- Larger design space, higher design and prototype costs
- A high level of debugging methodology,
- Power management,
- Longer design and prototyping cycle time

Apart from these challenges, the design again needs an expertise in both hardware and software levels for proper hardware and software co-design. Another important aspect of SOC integration is the development of a proper test methodology for post manufacturing test. All these integration issues makes the design time consuming and also expensive.

## 1.2 History of SOC

In 1974 digital Watch is the first developed System-On-Chip Integrated Circuit. The Microma liquid crystal display (LCD) digital watch is the first product to integrate a complete electronic system onto a single silicon chip, called a System-on-Chip. The first true SOC appeared in a Microma watch in 1974 when Peter Stoll integrated the LCD driver transistors as well as the timing functions onto a single Intel 5810 CMOS chip [14]. Many ASIC vendors addressed SOC opportunities in the 1990s by embedding microcontrollers and DSPs into system-level chips that enabled hand-held games and instruments, as well as speech processing, data communications, and PC peripheral products.

## 1.3 Design Reuse Concept

With the evolution of technology, the ways of designing the chips have been changed. It differs from the traditional design procedure such as writing the RTL from scratch, integrating RTL blocks into a top-level designing and doing synthesis followed by placement & routing.

**Design reuse** – the use of pre-designed and pre-verified cores – is now the cornerstone of SOC design [2]. It uses reusable IP blocks that supports plug and play integration and in turn allows huge chips to be designed at an acceptable cost, and quality. This section discusses various issues related to design of reusable Intellectual Property (IP) core, integration of cores to form a System on Chip design.

As Submicron technology is being used to design, the SOC it presents a whole set of design challenges including interconnect delays, clock and power distribution, and the placement and routing of millions of gates. These may have impact on the functional design of the SOCs and the design process itself. Hence Interconnect issues, floor planning and timing design must be engaged early in the design processes.

SOC design is now a driver for many other improvements in the IC industry like buses, bus interface, IP exchange formats, documentation, IP protection and tracking and test wrapper [1]. It has also forced suppliers to improve the quality of reusable IP.

SOC design also involves development of software in addition to the hardware itself; software plays an essential role in the design, integration, and test of SOC systems.

Hence the designers and developers migrated to the system level to address hardware/software co-design issues.

### 1.3.1 Design for reuse

Extensive libraries of reusable blocks or macros are used to design block-based design methodology [2]. A set of design methodology has to be followed in order to produce consistently reusable cores.

The methodologies are based on the following rules:

1. The macros must be extremely easy to integrate into the overall chip design.
2. The macros must be so robust that the integrator has to perform no functional verification of internals of the macros.

Some of the techniques for design reuse are good documentation, good code, thorough commenting, well designed verification environments, and robust scripts. In addition to the requirements mentioned above for a robust design, there are some additional requirements for a design to be fully re useable [2].

The macros may be:

- **Design must be configurable and use in multiple technologies**

The macros must be easily configurable to fit different applications. The soft macros should be supplied with a synthesis script which would produce quality of results with a variety of libraries. In the case of hard macros, this means having an effective porting strategy for mapping the macro onto new technologies.

- **Design for simulation with a variety of simulators**

Both Verilog and VHDL version of model and test bench should be available, and they should work with all the major commercial simulators.

- **Designed with Standards- based interfaces**

Unique or custom interfaces should be used only if no standards- based interface exists.

- **Verified independently of the chip in which it will be used and to a high level of confidence**

Macros are designed and only partially tested before being integrated into a chip for verification, thus saving the effort of developing a full test bench for the design.

Reusable designs must have full, stand-alone test benches and verification suites that afford very high levels of test coverage. A rigorous verification is done and a physical prototype is being build that is tested in an actual system running real software.

- **Fully documented in terms of appropriate restrictions and applications:-**

Valid configuration and parameter values must be documented. How the macro can be used and the restrictions on configurations or parameters must be stated.

## 1.4 The system on chip design flow and process

### 1.4.1 A canonical SOC design

Real SOC designs are much more complex than the generic form of SOC design shown in Figure: 1.2, but this miniature version of SOC design allows us to discuss the challenges of developing these chips utilizing reusable IP cores. The design process comprises specifying such a system for developing and verifying the cores, and integrates them into a single fabricated chip.

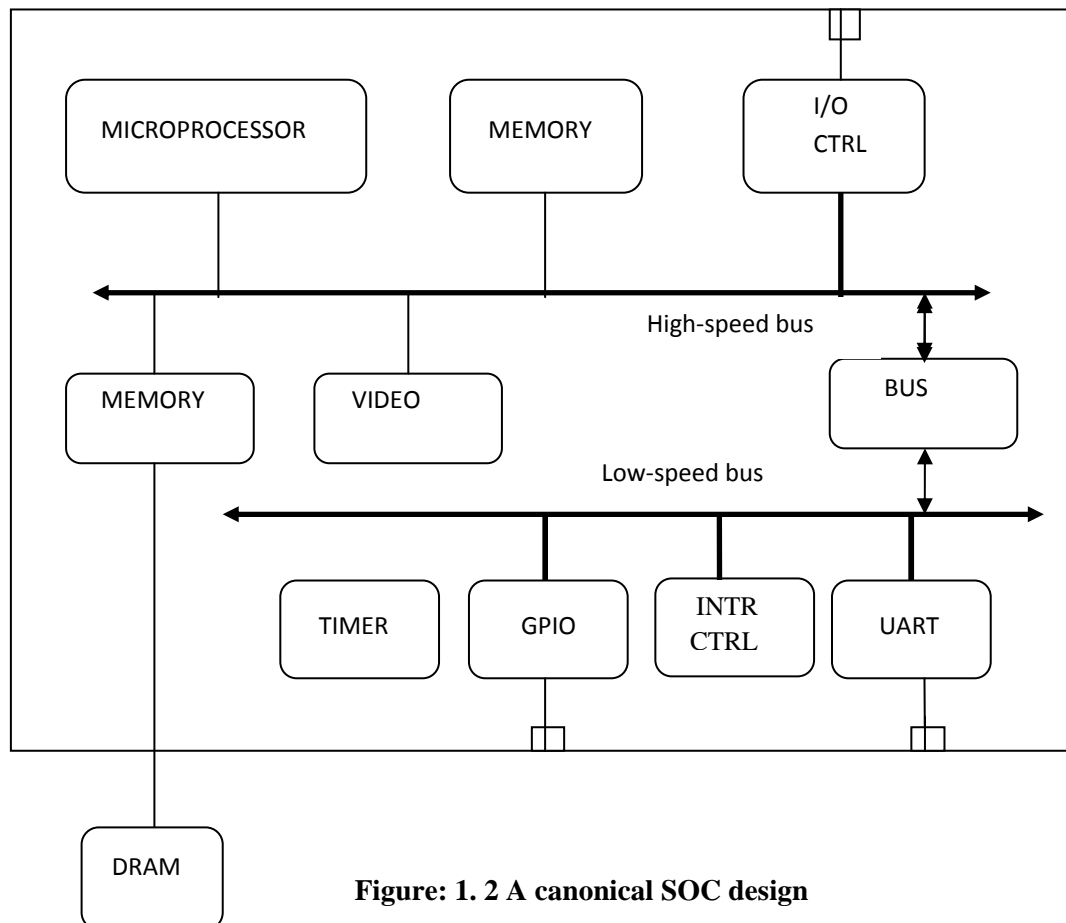


Figure: 1. 2 A canonical SOC design



The above canonical SOC design contains the following blocks.

- A microprocessor may be 8 bit to 64 bit depending on the application.
- A memory module which may be single or multi-level and may include SRAM and DRAM.
- An external memory controller for controlling flash or SRAM.
- A video decoder which may be MPEG or AVI.
- A I/O controller which may include PCI, Ethernet , USB, analog to digital, digital to analog converter.
- A GPIO for general input output for interfacing external devices like LEDs or LCDs or for sampling data.

### 1.4.2 System Design Flow

A two major way of design flows are being used by design engineers in order to meet the challenges of SOC design.

- From a waterfall model to a spiral model
- From a top-down methodology to a combinational of top-down and bottom-up

#### I. Waterfall vs. Spiral

A traditional way of ASIC development, called waterfall model is shown in Figure: 1.3. In a waterfall model [2], the SOC design transits from phase to phase in a step, and never returns to the activities of the previous phase. In this model, the design often tossed “over the wall” from one team to the next with little interaction among them.

The phase of the design process starts with the development of a specification for the ASIC. For complex ASIC the high algorithmic content is developed and given to the design team to develop the RTL for the SOC. A set of verification is done in order to ensure the proper functionality of the SOC design. After the complete verification, the design is delivered to a team of synthesis experts to generate a gate level net list for the hardware design of SOC. The proper functionality of the design is based on the timing between the blocks of the design; a timing verification is performed to verify that the ASIC meets timing.

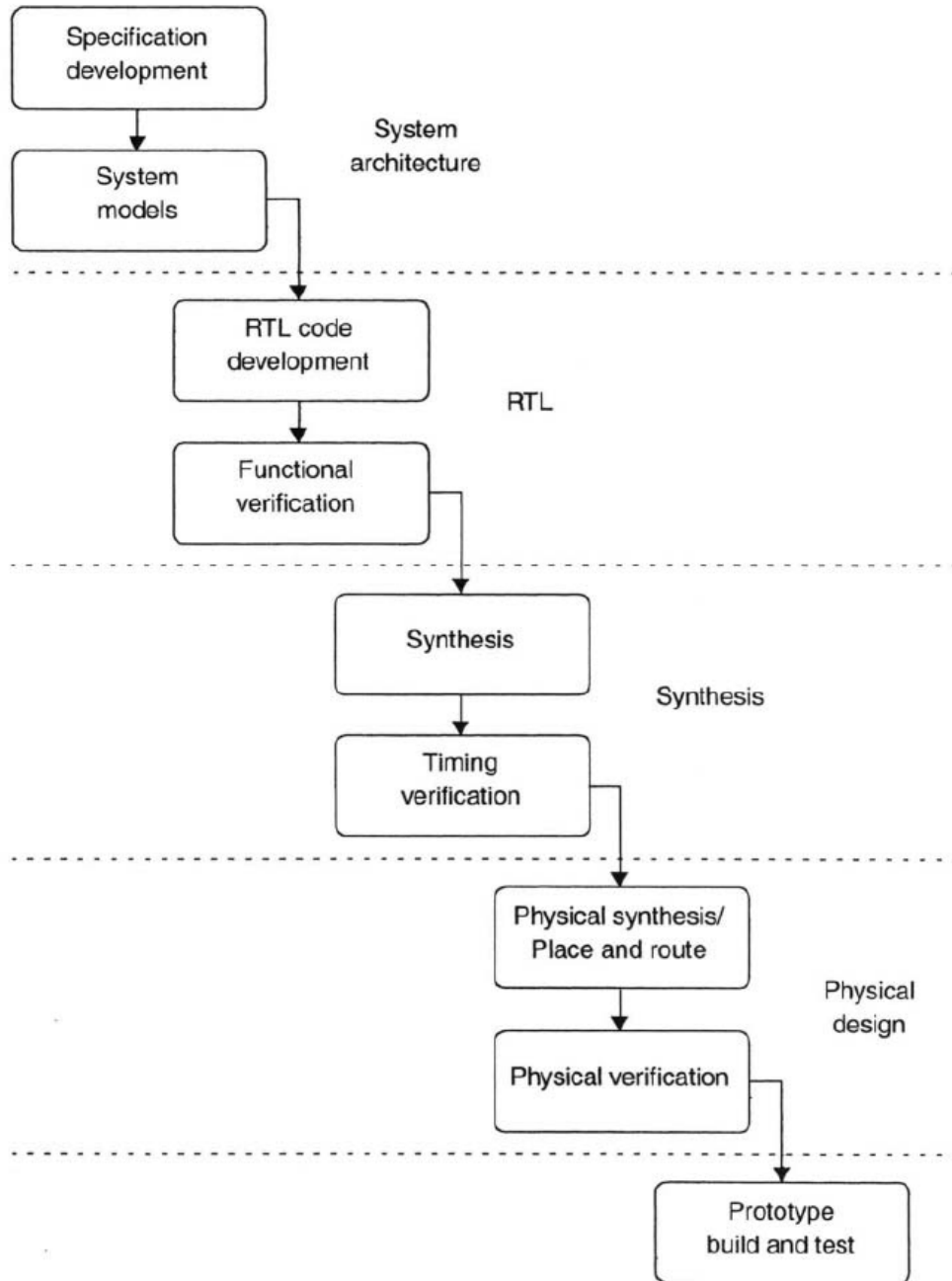


Figure: 1.3 Water fall design process

After timing is performed the design is given to the physical design team, which places and routes the design. Finally, a prototype is built and tested. The prototype is delivered to the software team for software debug. Software development is started shortly after the hardware design is started.

This flow has worked well in designs of up to 100 k gates and down to 0.5  $\mu\text{m}$  [2]. A major demerit of this flow is the improper handoffs from one team to another. For example the RTL design team may have to go back to the system designer and tell him that the algorithm is not implementable, or the synthesis team may have to go back to the RTL team and inform them that the RTL must be modified to meet the timing. As complexity of system increases, geometry shrinks, and time to market pressures continue to escalate, chip designers are turning to a modified flow to produce today's larger SOC designs. Hence design teams are moving from the old waterfall model to the newer spiral development model, where the team works on multiple aspects of the design simultaneously, incrementally improving in each area up to the completion of the design. Figure: 1.4 shows the spiral SOC design flow [2] where designer addresses all aspects of hardware and software design concurrently: functionality, timing, physical design and verification.

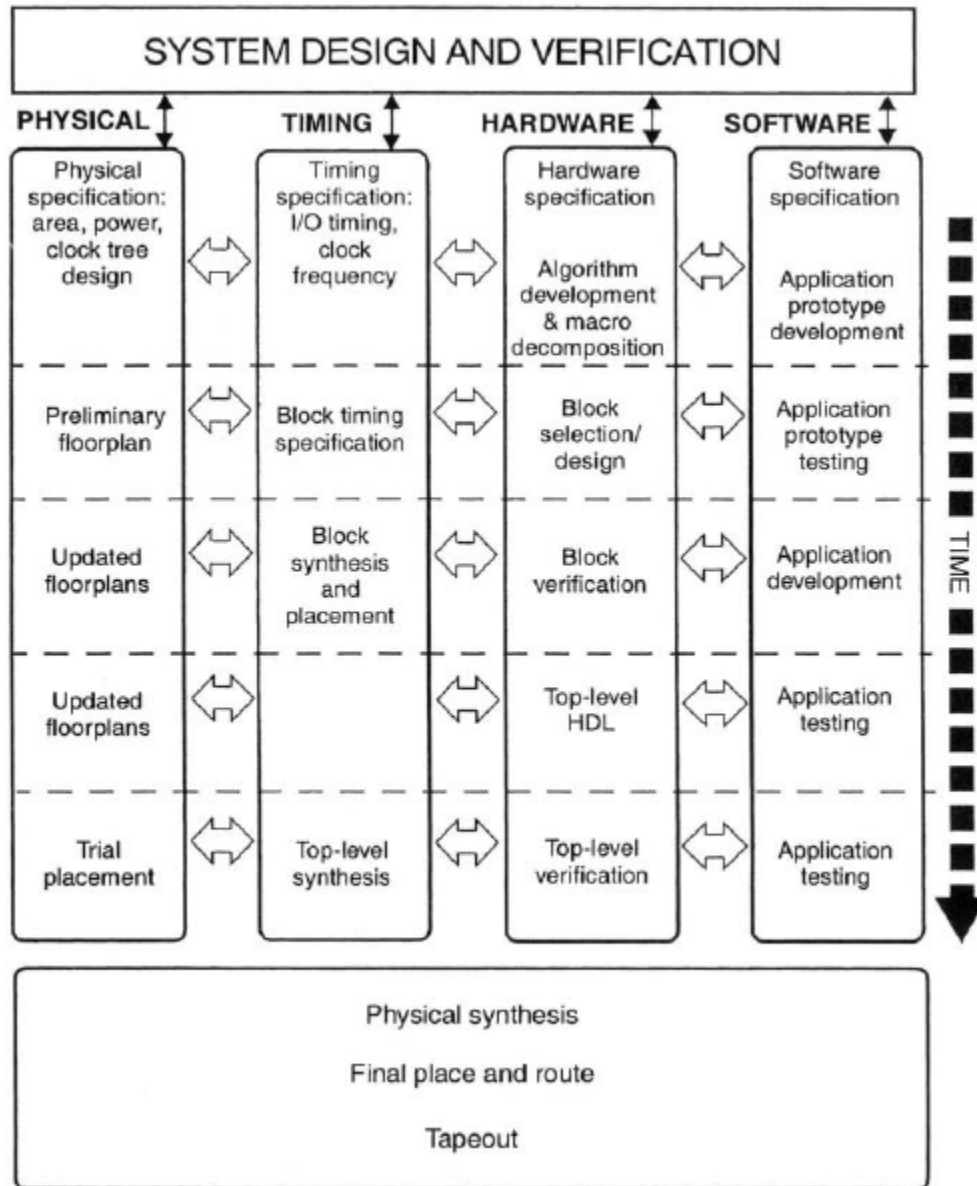
- Concurrent development of hardware and software.
- Parallel verification and synthesis of modules.
- Floor planning and place-and-route included in the synthesis process.
- Modules developed only if a pre-designed hard and soft macro is not available.
- Planned iteration throughout.

## II. Top-down Vs. Bottom up

The top down process begins with specification and decomposition, and ends with integration and verification. These processes steps are describes as follows:-

1. Prepare a complete specification for the system and its subsystem.
2. Refine its algorithm and architecture, including software design and hardware/software co-simulation if necessary.
3. Decompose the architecture into well -defined macros.
4. Design or select macros.
5. Integrate macros into the top level; verify functionality and timing.

6. Deliver the subsystem/system to the next higher level of integration; at the top level, this is tape out.
7. Verify all aspects of the design (functionality, timing, etc.).



**Figure: 1. 4 Spiral Design Flow**

In order to accelerate the design process and to meet the time-to-market pressures, increasingly powerful tools, such as synthesis and simulation tools have been developed. But the top-down methodology is an idealization process, it assumes that the lowest level blocks specified can, in fact, be designed and built. If a block is not feasible to design the

whole specification process has to be repeated which increases the design time again. In order to deal with this situation a mixture of top-down and bottom-up methodologies is being used; where libraries of reusable hard and soft macros are used as a source of pre-verified blocks; and it assures that at least some parts of the design can be designed and fabricated in the target technology in order to meet the desired specification.

### 1.4.3 The System Design Process

#### 1. *Create the system specification*

The design process begins with identifying the objectives of the design; such as system requirements, the required functions, performance, and cost and development time for the system. A set specification is recursively developed, verified and refined until they are detailed enough to allow RTL coding to begin. Specification describes how to manipulate the interfaces of a system to produce the desired behavior. Specifications are to be provided for both hardware and software portions of the design. The following are the specification requirements for the hardware and software portion of the design [2].

*Hardware:*

- functionality, external interfaces to other hardware (pins, buses and how to use them)
- Interface to software (register definitions)
- Timing and performance
- Area and power

*Software:*

- Functionality,
- Timing,
- Performance,
- Interface to hardware, software, structure and kernel.

These specifications are written jointly by engineering and marketing teams, in a natural language, such as English. In order to avoid the ambiguities, incompleteness and errors, companies have started using executable specifications for some or all of the system. An executable specification is an abstract model for the hardware and software being used. It

is written in C, C++ or SystemC or a Hardware verification language (HVL) for high level specifications. At lower levels, hardware is usually described in Verilog or VHDL. As executable specifications are only addressing the functional behavior of a system, so it is necessary to describe critical physical specifications such as timing, clock frequency, area and power requirements.

### ***2. Develop a behavioral model***

After specification is defined an initial high level of design is developed along with a high-level behavioral model for the overall system. This model can be used to test the basic algorithms of the system design and to show that meet the requirements outline in the specification. For example, in an image and video processing design may need to demonstrate that losses in compression/decompression are at or acceptable level. This way of high-level model specification is termed as executable specification. These specifications can be used as the reference for the future versions of the design.

### ***3. Refine and test the behavioral models***

After the behavioral model is defined in order to refine test algorithm a verification environment for the high-level model is developed. This environment provides a mechanism for refining the high-level design, verifying the functionality and performance of the algorithm. This can be used later to verify models for the hardware and software, such as RTL model verified using hardware/software simulation.

For example: - A multimedia or a graphics system may be initially coded in C/C++ with all floating point operations. This allows the system architect to code and debug the basic algorithm quickly. Once the algorithm is determined, a fixed-point version of the model is developed that allows the architect to determine the accuracy level required in each operation to achieve performance goals while minimizing die area.

Finally, a cycle-accurate and bit accurate model is developed, providing a very realistic model for implementation. These multiple models are very useful for hardware/software co-simulation to debug their software.

### ***4. Determine the hardware/software partition***

The hardware/software partition is the division of system functionality between hardware and software. This is a manual process requiring judgment and experience on the part of

the system architects and a good understanding of the cost/performance trade offs for various architectures. A rich library of pre-verified, characterized macros and a rich library of reusable software modules are the key things for identifying the size and performance of various hardware and software functions. Finally, the interface between the hardware and software is defined and the communication protocols between them are also defined.

#### ***5. Specify and develop a hardware architectural model***

Once the hardware requirements are defined, detail hardware architecture is specified. The issues related to this are determining which hardware blocks will be used, and how they will communicate, memory architecture, and bus structure and its bandwidth. Most of the SOC communicates with different blocks over one or more bus, thus the required bandwidth can be application dependent. A substantial amount of application code is run on the architecture to evaluate the bandwidth of the system. Running significant amounts of application code on an RTL design is time consuming. In order to overcome this problem, transaction-level models are developed to model interfaces and bus behavior. This model can run considerably faster than RTL models and gives accurate estimates of performance. SystemC is used to facilitate the design of transaction level modeling. Finally, the hardware architecture is developed, tested and modified until a final architecture meets the system requirements.

#### ***6. Refine and test the architectural model (co-simulation)***

The software development often starts only once the hardware has been built. This serialization may lead to delayed product. The architectural model for the system can be used for hardware/software co-simulation. It provides sufficient accuracy that software can be developed and debugged on it, long in advance of getting actual hardware. Hence having accurate models of the hardware is the key issue in SOC design.

#### ***7. Specify implementation blocks***

After the model is co-simulated hardware specification is provided which is a detailed specification of the performance, functionality, and interfaces for the hardware system and its component blocks. It also specifies a description of the basic functions, the timing,

area and the power requirements, and the physical and software interfaces and the descriptions of the I/O pins and the register map.

## 1.5 System level Design Issues

This section discusses system level design issues such as different types of IP cores, on chip buses, SOC test methodologies and SOC verification.

### 1.5.1 Different Types of IP Cores

#### I. Digital IP

In the previous section Design reuse is elaborated and we observed that well-designed IP is the key to successful SOC design. The block used for SOC design must be designed well unless, the tape out of the system becomes very painful and time-consuming. Hence, well-designed IP core can be integrated with any SOC flow, and produce good results quickly [2]. This section presents an issue related to produce well-designed IP cores. The IP cores are classified into three categories [1]: *Soft, firm and hard*.

##### *Soft IP:*

Soft IP blocks are specified in hardware description languages using RTL or higher level descriptions. These are generally provided by the vendor in form of software code which are process independent and can be synthesized to the gate level. Hence these are more suitable for digital IP core design. These types of cores are sometimes not guaranteed power or timing characteristics, as the implementation and application in different process may produce variation in performance. But these types of IP cores are very much flexible, portable and reusable and prevents the user from introducing any design errors into block.

##### *Hard IP:*

Hard IP blocks have fixed layout and already go through physical design process. This IP is optimized for a given application in a specific process. As the timing characteristics are optimized the performance of the IP is predictable. The only drawback is that, it requires additional effort and cost to produce this IP. These are also



limited to specific application but as this IPs are tested on Silicon the vendors gives more assurance about its accuracy and correctness.

***Firm IP:***

Firm IP are provided as parameterized circuit description so that designers can optimize core for their specific design needs. Hence firm IPs are more predictable. These are more flexible and portable than soft and hard IP.

Most of the digital processor blocks are being designed with hard IP in order to achieve the performance goals. Memory cells are designed by transistor level and memory arrays are tiled from these cells using a compiler [RMM]. Recently soft IP blocks preferred as hand off level [1]. The typical soft IPs available is interface blocks (USB, UART, and PCI), encryption blocks (DES, AES), multimedia blocks (JPEG, MPEG 2/4), and networking blocks (ATM, Ethernet and Micro Controllers [1]).

## II. AMS IP

Another important IP which is gaining interest is Analog mixed signal IP. The typical AMS components include operational amplifiers, analog to digital converters (ADCs), digital to analog converters (DACs), phase locked loops (PLL), and radio frequency (RF) modules etc. This IPs is designed using Hard IP and target to one application in a specific fabrication technology.

### 1.5.2 System Interconnect and On Chip-Buses

In earlier days every chip designer had unique bus designed for optimum performance for their own design project. This made difficult to reuse blocks from other projects to their own designs. Hence, there was need of standard bus, which allows reusable blocks developed with a single interface to be used for a variety of applications. ARM [11] uses AMBA as system interconnects solution for their system design. CoreConnect is being by IBM. The comparisons of three types of bus architecture are presented in the Chapter-2 of the thesis.

### 1.5.3 SOC Test Methodologies

Another important aspect of SOC integration is the development of a test methodology for post manufacturing tests. Testing of SOC designs has many similarities

with the traditional system on Board (SOB) designs. Cores in SOC are the components of an SOC where as in printed circuit boards ICs are the components of SOB. In SOB, IC design manufacturing and testing are performed by the IC provider and the system integrator has to only design the board level designing using these ICs. In SOC, the core providers supplies only the description of cores and the system integrator is responsible to design any blocks called User Defined Logic (UDL), and integrates these predesigned cores.

As the system is in logic level the system integrator cannot perform post manufacturing test. Hence the integrator can only test the core logic wires between cores and expects a set of test patterns with high fault coverage from the core provider. Another key difference between the SOB and SOC is that unlike SOB the physical input output of the cores are not accessible by the user in SOC. The test access to the embedded cores is the responsibility of the system integrator. Hence additional logic and wiring, mechanisms are required which leads to the development of core test access architecture [1].

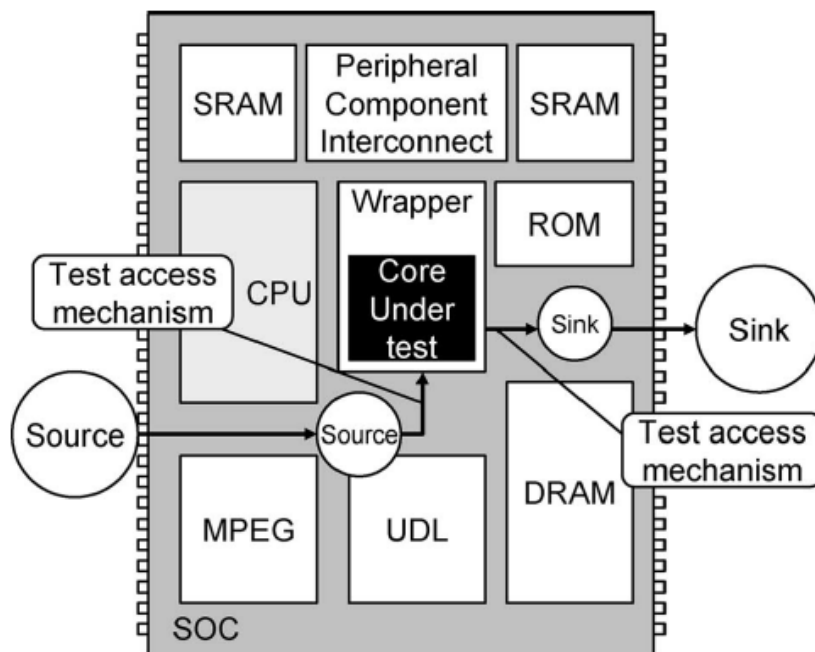
### **I. IP core level test**

The testing of an IP core consists of an internal DFT Structures Design for Test (DFT) structure and a required set of test patterns to be applied and captured on the core periphery. The test pattern includes *the data and protocol patterns*. The data pattern contains actual stimulus and response values. The protocol pattern specifies how to apply and capture the test data. As the system integrator has very limited knowledge about the structural content of the core, the core internal test should be carried at by the core provider. Hence the core provider should provide the internal DFT hardware structure of the core, the stimulus patterns of the core and the validation of these stimulus patterns. The core provider must determine the internal core requirement of the core without knowing the target process, application and the desired test coverage level. BIST is another solution that can be used by core provider for core level testing.

## II. SOC level test

Figure: 1.5 shows a conceptual architecture for testing-embedded core based SOC. This architecture consists of

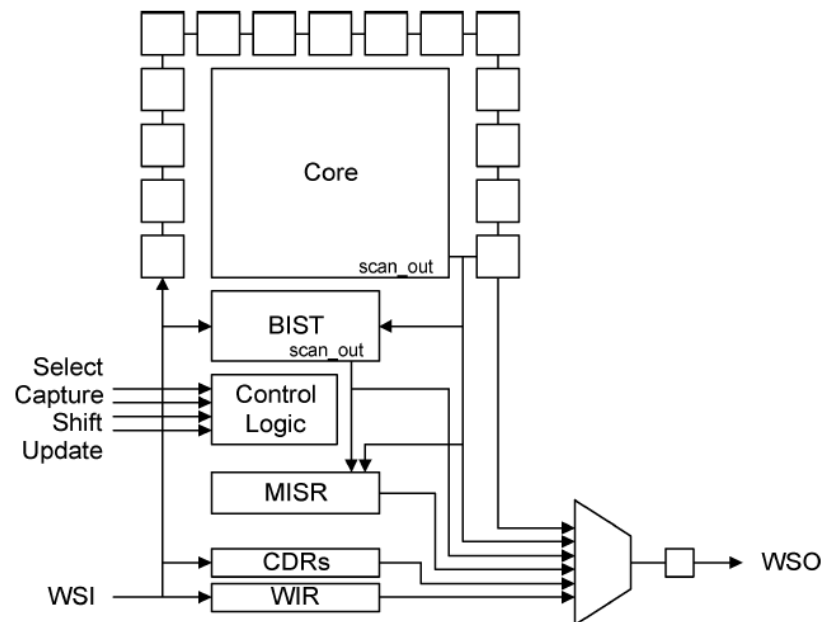
1. Test pattern source and sink: the test pattern source is responsible for generating the core stimuli. Test sink is used to receive the test responses.
2. Test access mechanism (TAM): the on-chip test pattern transportation is performed by test access mechanism. It is useful in transferring the test pattern source from the source to the core under test or for transferring the test responses from core under test to a test pattern sink.
3. Core test wrapper: it forms the interface between the embedded core and its environment, by connecting the embedded core to the rest of the IC and to the TAM.



**Figure: 1.5 Core based SOC Test Architecture**

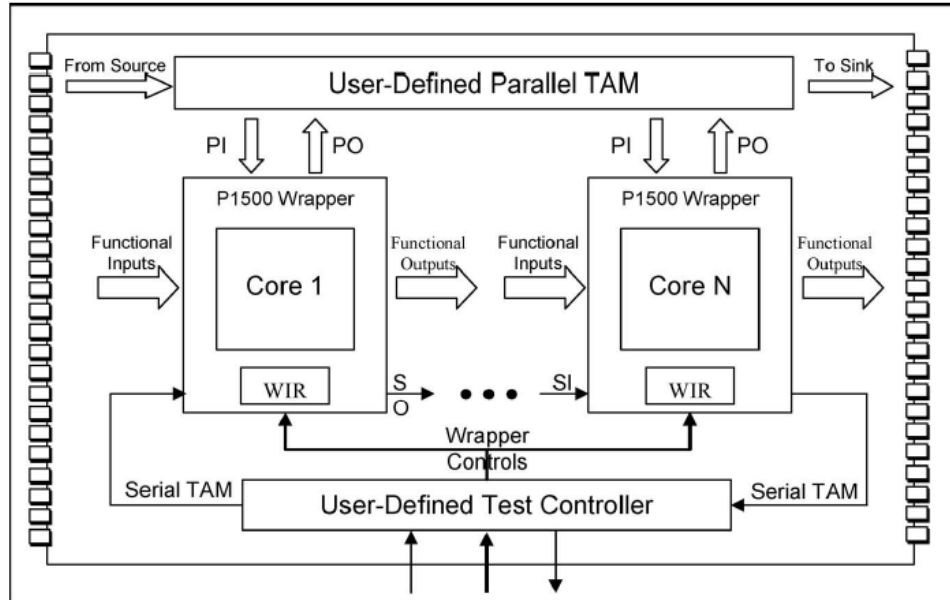
A new standard IEEE-1500 was developed to facilitate SOC testing for both the core provider and the system integrator. The purpose of this is to provide a uniform interface between the core and the chip-level test access mechanism; it uses parallel test port instead of the test access port (TAP) controller. Figure: 1.6 shows the block diagram

of a P1500 wrapper which consists of four control inputs and one pair of serial data input and output. Serial wrapper scan input (WSI) is used to transport wrapper instruction and test data. Instructions are shifted serially into the wrapper instruction register (WIR) and various enable signals are generated from the control logic based on the context of the WIR and the four control inputs. CDRs are used to capture the test results. The ring of flip flops around the core form the boundary data register (BDR) that isolates the core's functional interface from the other blocks during testing. While performing full-scan test the test vector is serially shifted in through WSI and scan output serially shifted out through to the wrapper scan output (WSO) [1].



**Figure: 1. 6 Block Diagram of P1500 Wrapper for BIST DFT Core**

Figure: 1.7 shows the integration of the cores with P1500 Standard. Each core is encapsulated with P1500 wrapper and user defined test controller signals enabled by external sources is used to provide control signals to the wrapper. A user-defined parallel TAM is used to transport test data to/from individual IP cores.



**Figure: 1. 7 Integration of Cores using P1500 wrapper**

### 1.5.4 SOC Verification

As the design complexity is increasing the verification the complete SOC is becoming bottleneck of system designers. As the ITRS [13] has noted while design sizes have grown exponentially over time in accordance with Moore's law, verification complexity has been growing double exponentially. This is due to the fact that the number of states that must, be verified is exponential in the size of design. In industrial practice, two methods are used to solve the verification bottleneck: *verification information are encapsulated within IP cores to make the verification effort reusable, and use of standard IP cores to reduce the bugs during integration.* The main stream verification utilizes the dynamic methods such as simulation and emulation. Hence the encapsulation consists of supplying of simulation test benches along with the IP cores. Assertion based verification strategy helps in reducing the verification problem. In this methodology, the design core and interfaces specified with the correct behavior. This gives rise to standardizing languages for more complex assertions such, PSL or SVA [1] later.

On the other hand several companies are developed standardized bus protocols for on chip communication such as AMBA [11], CoreConnect [12] and WISHBONE [4].

Adopting a standard interconnect not only eliminates the common errors occurring during the design of an interconnection protocol, but also reduces the incorrect interfacing of cores and interconnect. The above described methods help in reducing the verification problems. But as the designed complexity increases the dynamic verification methods suffers from poor verification coverage. Poor coverage increases the undetected bugs in IP cores are undermine the goal of reusing IP cores without needing to completely re-verify them.

Hence the formal verification methodology is used which minimizes the probability of bugs in a design. More research activities focusing this area of verification. The key research areas are compositional model checking. The specifications that are verified and the assumption under which they are verified are documented and can be exploited during integration verification. Again the methodology advancement in dynamic verification helps in growing formal verification approach. Formal verification is being used in many industry applications such as RTL gate-level equivalence checking and microprocessor verification. Finally despite all the research advances now and in future, it is impossible that the verification challenge can be solved without help from designs. Leading companies involve verification experts early in the design process to steer the design toward better verifiability [1].

## **1.6 Motivation**

SOC design requires a standard bus interface for IP cores to communicate with each other. There exist many other bus interfaces, but AMBA [11], CoreConnect [12] and WISHBONE [4] are well known and well used SOC bus architectures. All three bus architectures are open bus architectures, which require no fees or royalties to use them. WISHBONE offers advantage compared to AMBA and CoreConnect. All designer using WISHBONE bus interface are allowed to upload their design in Open Core site where there exists many IP cores that support WISHBONE bus interface and they are all free to use. So depending upon the design specification the designer can select the IP cores from the site and glue them to the WISHBONE bus architecture to design the final SOC. Comparing the architecture of these three buses, it is observed that all are supported by multiplexer interconnections. WISHBONE supports variable interconnection and variable time

specification. It can be coded using any hardware description language like VHDL and Verilog®, and it takes the shapes of simple logic gates supported by most of the FPGA and ASIC devices. WISHBONE also supports Single and Block Read/Write cycles, Read-Modify-Write (RMW) transfer. In respect to all of the above issues WISHBONE supports almost all features also supported by AMBA and CoreConnect. It also offers advantage of using predesigned IP cores available freely Open Core site for the portable and reliable SOC design. Keeping in view of the above, in this dissertation we adopt WISHBONE for SOC design and explore the Open Core based SOC design platform.

## 1.7 Work Presented in the Thesis

The major contributions of this thesis are:

- The possibility of using an existing bus interface for faster and low cost SoC design is evaluated. The design, verification, FPGA implementation of WISHBONE interconnection architectures in terms of size and speed for SoC design is evaluated.
- A set of wishbone compatible cores such as 32-bit RISC CPU, on chip memory, universal asynchronous receiver and transmitter (UART), Parallel Input Output (PIO) and System controller (SYS) are collected from Open Core and integrated to develop a portable low cost SoC design.
- The integration issues are discussed and the synthesis results in terms of size and speed are presented. A test bench is developed in order to verify the CPU instruction with the final integrated architecture.
- Finally, FPGA implementation of SoC architecture has been done using VIRTEX-II Pro FPGA and the functionality of the system is verified through porting the application software on the SoC architecture.

## 1.8 Thesis Outline

The layout of this thesis compiled is as follows:

**Chapter 1:** The first chapter presents introduction to SOC design. This chapter also discusses SOC design process and system level issues such as design of reusable IP core,

on chip bus interface and strategies for synthesis, verification and testing. A brief overview of the thesis outline is presented here.

**Chapter 2:** The second chapter describes the concept of Open Hardware. The Open Core based SOC design platform is illustrated. The design reuse using Wishbone bus specification is also presented in this chapter.

**Chapter 3:** In this chapter Design and verification of a point-to-point interconnection and shared bus interconnection using DMA MASTER and memory SLAVE core is presented. The bench marking of the interconnections in terms of size and speed is evaluated by using two FPGA technologies.

**Chapter 4:** This chapter presents a description of design methodology to implement proposed SOC Architecture in FPGA using Wishbone bus interface. The design specifications of the IP cores are described here.

**Chapter 5:** SOC integration issues and verification results, synthesis and FPGA implementation of the SOC architecture is presented in this chapter.

**Chapter 6:** This chapter demonstrates the validation of SOC architecture with porting application software developed in GNU C compiler and debugger.

**Chapter 7:** Finally, a conclusion is drawn in this last chapter. This chapter also lists the future research scopes from the studies undertaken.

## 1.9 Conclusions

The concept of SOC design through design reuse is discussed, and the design flow and design process steps are described. The various issues related to system level design are addressed and observed that

- Design Reuse through well design IP cores is the key factor behind reliable time to market SOC design.
- A standard interface bus must be adopted to get reduced integration efforts.
- The design of test circuits must be done properly in during the SOC integration to avoid post manufacturing physical error.
- A proper verification methodology must be adopted to validate the final functionality of the SOC.



# Chapter 2

## Open Core Based SOC Design Platform

- Platform Based SOC Design
- Open Core Based SOC Design Platform
- The Objective behind WISHBONE
- WISHBONE Basics
- WISHBONE Interface Specification
- Wishbone Interconnections
- WISHBONE Bus Cycle
- Data Organization and Customized Tag
- WISHBONE SOC Bus Comparison with AMBA and CoreConnect
- Conclusions

SOC design increases the density of transistor in a chip. The increased density of transistor in turn increases the complexity of the system. The SOC design methodology offers definite benefits; however there are certain challenges like larger design space, higher design and prototype costs, high level of debugging methodology, power management, and longer design and prototyping cycle time. Apart from these challenges, the design again needs an expertise in both hardware and software levels for proper hardware and software co-design. Another important aspect of SOC integration is the development of a proper test methodology for post manufacturing test. All these integration issues makes the design time consuming and also expensive.

To deal with this inherent integration problems and reduction in design cycle time, many methods for SOC design are proposed by research and industry community. There are several methods for SOC design, however in this thesis we limit our discussion for two methods of SOC design. These are *Platform based SOC design* and *Open Core SOC design methodology*. This chapter also explains about the features of Open Core on chip bus interface WISHBONE which is the key factor in Open core SOC design methodology. Finally, different bus interfaces available for SOC design have been compared.

## 2.1 Platform Based SOC Design

In Platform based design (PBD), new designs could be quickly created from the original platform over many design derivatives. More specifically a platform is an abstraction level that covers a number of refinements to a lower level resulting in improvement of the design productivity. An SOC platform consists of hardware IP, software IP, programmable IP, standardized bus structures and communication networks, computer-aided design (CAD) flows for hardware/software design, verification and implementation, system validation tools, design derivative creation tools and dedicated hardware for system prototyping [1]. PBD is a design methodology which starts at system level and high productivity is achieved by using predictable, pre-verified blocks that uses standard interfaces.

The two major areas in PBD methodology are (a) *block authoring* and (b) *system-chip integration* [15]. Block authoring uses a methodology which creates block that

interfaces easily with multiple target designs. Two design concepts used in block authoring are interfacing standardization and virtual system design.

In interfacing standardization, both internal and external design teams can do block authoring, as long as they are using the same design methodology and the same interface specifications. The interface standard used can be product or application specific.

In virtual system design, the designer has to focus about the power profile, clocking schemes, internal clock distribution, and testing schemes of the design. Also block interfaces (with a single bus or multiple bus) types, and the type of block such as soft, hard or firm are also decided during virtual system design.

System chip integration focuses on designing and verifying the system architecture and the interfaces between the blocks. Integration process starts with partitioning the system around the pre-existing block level functions and identifying the new or differentiating function needed. These partitioning are done at the system level, along with performance analysis, hardware /software design trade-offs, and functional verification.

The benefits of PBD are as follows:

- Design uses diverse and specialized functions from multiple sources. Hence planned design reuse yields very high productivity.
- Hierarchical routing and timing reduce design focus.
- Interface based design promotes and multiple reuse for blocks allows amortization of development cost and more optimal block design.

The challenges of PBD include:

- Planned reuse requires proper design planning and accurate future product plans.
- Significant software portions require extensive hardware/software co-verification.
- Platform migration to new process technology requires re-characterization of hard, soft IPs and platform architecture.
- Requires organizational change to support separate block authoring and system chip integration.

Hence, PBD can be treated as a convergence design where previously separated functions are integrated. The pre-existing blocks can be accurately estimated and the

design variability limited to the new blocks and the interface architecture. It requires organizational support to create a PBD.

## 2.2 Open Core Based SOC Design Platform

On the other hand, a new concept that is gaining interest is the Open Core SOC design methodology which publishes all necessary information about the hardware [3]. This is termed as *open hardware*. All the information regarding the hardware is disclosed for free, according to the term of GPL/LGPL license. Open Core [4] group has provided many pre-synthesized and pre-verified hardware core for the designer. These cores are well documented with design specifications, RTL codes, and simulation test benches and therefore can be re-used for different applications. Making a design compatible with an on-chip bus interface is one way to produce re-usable design. Different IP cores developed independently can be tied together and tested by standardizing the IP core interfaces. Many re-usable digital designs available in the Open Core site are compatible with a standard on-chip interface called WISHBONE [5] bus interface. More than 800 projects are available in open core site. Some of them are Open RISC1200 processor, VGA controller, USB 2.0, memory controller, UART, MAC, PCI and many DSP functionality cores. The designer has to collect the IP cores from the site and integrate it into the design to complete the SOC design. All these cores are available at no cost and are reusable. Hence it helps in producing low cost, portable, reliable, time-to-market SOC design. The EDA tools used to develop open hardware are also open. Hence in Open Core SOC design methodology openness of resources is a key factor to develop design reuse and improve the productivity of SOC designs.

## 2.3 The Objective behind WISHBONE

The WISHBONE System-on-Chip (SOC) Interconnection is a method for connecting IP cores together to form integrated circuits. Open core SOC design methodology utilizes WISHBONE bus interface to foster design reuse by alleviating system-on-chip integration problems. With use of this standardize bus interface it is much easier to connect the cores, and therefore much easier to create a custom System-on-Chip. This way of SOC design improves the portability and reliability of the system, and results in faster time-to-market for the end user. The objective behind WISHBONE is to create a

portable interface that supports both FPGA and ASIC that is independent of the semiconductor technology and WISHBONE interfaces should be independent of logic signaling levels. Another important reason is to create a flexible interconnection scheme that is independent of the type of IP core delivery (Hard, Soft IP) method. The next reasons are to have a standard interface that can be written using any hardware description language such as VHDL and VERILOG®. It supports a variety of bus transfer cycle in which the data transaction is independent of the application specific functions of the IP cores. It also supports different types of interconnection architectures with theoretically infinite range of operating frequency [5]. The final objective of WISHBONE bus is that it is absolutely free to use by developers without paying any fee for the cores available.

## 2.4 WISHBONE Basics

WISHBONE utilizes “Master” and “Slave” architectures which are connected to each other through an interface called “Intercon”. Master is an IP core that initiates the data transaction to the SLAVE IP core.

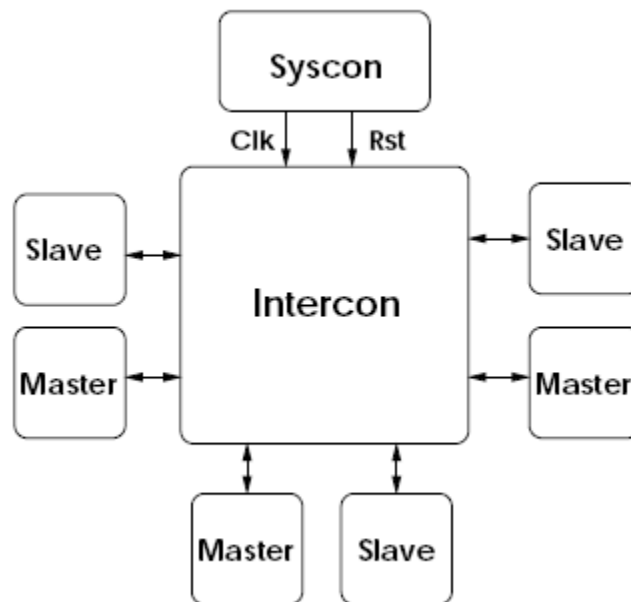


Figure: 2. 1 WISHBONE Intercon system

Master starts transaction providing an address and control signal to Slave. Slave in turn responds to the data transaction with the Master with the specified address range.

The Intercon is the medium consists of wires and logics which help in data transfer between Master and Slave. The Intercon also requires a “SYSCON” module which generates WISHBONE reset and clock signal for the proper functioning of the system. Figure: 2.1 show the WISHBONE Intercon system which consists of Masters and Slaves and SYSCON modules. WISHBONE Intercon can be designed to operate over an infinite frequency range. This is called as *variable time specification*. The speed of the operation is only limited by the technology of the integrated circuits. The interconnection can be described using hardware description languages like VHDL and Verilog®, and the system integrator can modify the interconnection according to the requirement of the design. Hence WISHBONE interface is different from traditional microcomputer buses such as PCI, VME bus and ISA bus.

## 2.5 WISHBONE Interface Specification

WISHBONE Interface specification specifies the signaling method used by Master and Slave interface and the SYSCON module. It also specifies the way to create a proper documentation for the WISHBONE Compatible IP cores which is the main driving factor for design reuse.

### 2.5.1 Documentation for IP Cores

As specified above each WISHBONE Compatible IP cores must be supplied with a WISHBONE datasheet, which describes the interface of the cores. This datasheet helps in understanding the operation of the cores, and the user can reuse these cores to integrate with other cores to produce System on a Chip. The WISHBONE datasheet must include the following information:

- The revision level of the WISHBONE specification after which it is designed.
- If the IP designed is a Master or Slave IP core.
- The signal names used in the design must be defined. If any signal name different than that defined in the specification, must have a cross reference to the original signal of the specification.
- If a Master supports a retry and error signal, then it must specify how they react in response to the signals. If a Slave supports retry and error signal, then it must specify under which conditions the signal must be generated.

- The design supporting tag signals must specify the name, TAG TYPE and operation of the tag.
- The port size must be 8-bit, 16-bit, 32-bit or 64-bit.
- The maximum operand size used must be 8-bit, 16-bit, 32-bit or 64-bit.
- The data transfer ordering such as LITTLE ENDIAN or BIG ENDIAN must be specified.
- Any constraints on the clock signal [CLK\_I] must be specified in terms of clock frequency, application specific timing constraints, use of gated clocks or use of variable clock generators.

### 2.5.2 WISHBONE Interface Signal

WISHBONE interface signals and bus cycles are design in a reusable manner, so that the WISHBONE Master and Slave interfaces can be connected together using several interconnection methods. These signals are classified into three categories, *Master signals*, *Slave signals*, and *signals common to both Masters and Slaves*. These entire interface signals must be active high logic.

The signal definitions must follow these requirements:

- The signal must allow Master and Slave to use variable interconnections.
- The signals must support all the basic types of bus cycle.
- A handshaking mechanism must be used for either the Master or the participating Slave interface to adjust the data transfer rate.
- Every interface must support acknowledgement signal but the retry and error acknowledgement signals are optional.
- Address and data bus widths can be altered to fit different applications like 8-bit, 16-bit, 32-bit and 64-bit data buses.
- All the signals should be either output or input. The signals may be bidirectional, if the target device supports it.

The Tables: 2.1, 2.2 and 2.3 below show the descriptions of these three types of signals. The optional requirement of the signal is also specified in the table.

<b>Signal</b>	<b>Name</b>	<b>Description</b>	<b>Optional</b>
ACK_I	Acknowledge input	When asserted, indicates the normal termination of a bus cycle.	No
ADR_O()	Address output	Used to pass binary address	No
CYC_O	Cycle output	When asserted shows a valid bus cycle is in progress	No
<b>Signal</b>	<b>Name</b>	<b>Description</b>	<b>Optional</b>
SEL_O()	Select output	Indicates where valid data is expected	Yes
STB_O	Strobe output	Indicates a valid data transfer	No
WE_O	Write enable output	If asserted transfer cycle is write else read cycle	No
ERR_I	Error input	Indicates an abnormal cycle termination	Yes
LOCK_O	Lock output	When asserted , indicates current bus cycle is uninterruptible	Yes
RTY_I	Retry input	Interface is not ready to accept or send data, cycle should be retried	Yes
TGA_O	Address Tag Type output	Contains information regarding address line	Yes
TGC_O()	Cycle Tag Type	Contains information about the bus cycle , and discriminates single, Block or RMW cycle	Yes

Table: 2. 1 Master Signals

<b>Signal</b>	<b>Name</b>	<b>Description</b>	<b>Optional</b>
ACK_O	Acknowledge output	When asserted, indicates the normal termination of a bus cycle.	No
ADR_I()	Address input	Used to pass binary address	No
CYC_I	Cycle input	When asserted shows a valid bus cycle is in progress	No
SEL_I()	Select input	Indicates where valid data is expected	Yes
STB_I	Strobe input	Indicates that Slave is selected, when asserted Slave responds to	No



Signal	Name	Description	Optional
		other WISHBONE signals	
WE_I	Write enable input	If asserted transfer cycle is write else read cycle	Yes
ERR_O	Error output	Indicates abnormal cycle termination	Yes
LOCK_I	Lock input	When asserted , indicates current bus cycle is uninterruptible	Yes
RTY_O	Retry output	Interface is not ready to accept or send data, cycle should be retried	Yes
TGA_I	Address Tag Type input	Contains information regarding address line	Yes
TGC_I()	Cycle Tag Type input	Contains information about the bus cycle , and discriminates single, Block or RMW cycle	Yes

**Table: 2. 2 Slave Signal**

Signal	Name	Description	Optional
CLK_I	Clock input	System clock input	No
RST_I	Reset input	System reset input	No
DAT_O()	Data output	To pass binary data for sending	No
DAT_I()	Data input	To pass binary data for receiving	No
TGD_I()	Data Tag Type input	Contains information about data input array	
TGD_O()	Data Tag Type output	Contains information about data output array	

**Table: 2. 3 Signals Common to both Masters and Slaves**

Figure: 2.2 show the point-to-point interconnection of Master and Slave interfaces with respective signals.

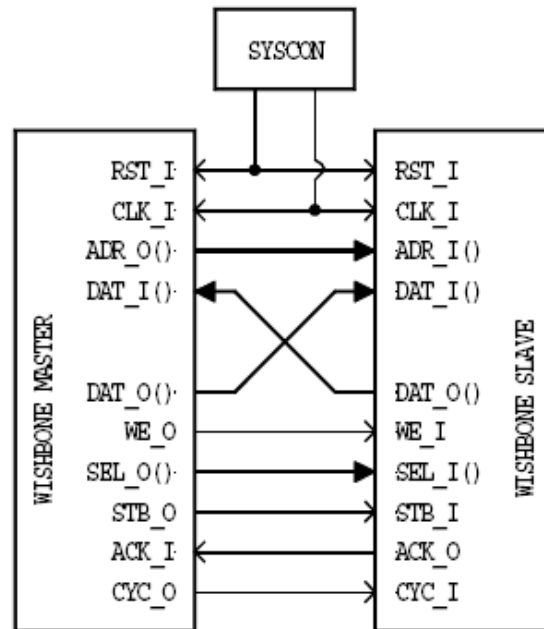


Figure: 2. 2 Point to point interconnection with WISHBONE interface signals

## 2.6. Wishbone Interconnections

WISHBONE interface supports variable interconnection. It does not put any constraint on the type of interconnection the Master/Slave interface should use for communicating with each other as long as the WISHBONE specification signals and cycles are followed. Master and Slave interface may use four types of interconnections such as, *Point to point, Dataflow, Shared bus and crossbar Switch interconnection* [5].

### 2.6.1 Point-to-Point Interconnection

Point to point is the simplest way of connecting two IP Cores to each other where a single Master interface is connected to a single Slave interface. For example, a microprocessor as Master interface can be connected to a serial input output port Slave interface. The data transaction is controlled by handshaking signals.

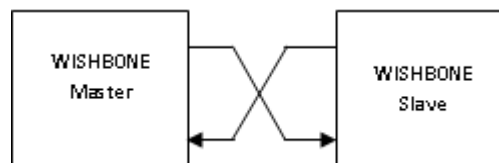


Figure: 2. 3 (a) Point-to-Point Interconnection

## 2.6.2 Data Flow Interconnection

The dataflow interconnection processes the data in a sequential manner. Each IP core contains both a Master and a Slave interface. An IP core appears as a Master to the next IP core and also appear as a Slave to the core prior to it. This type of interconnection speed is faster as it uses the concept of parallelism. The data transaction is also controlled by handshaking signals. Figure 2.3 (a) and (b) shows point-to-point and data flow interconnection diagrams.

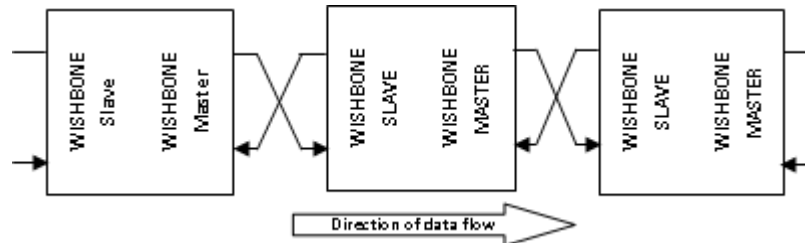


Figure: 2. 3 (b) Data flow Interconnection

## 2.6.3 Share Bus Interconnection

Shared bus interconnection allows multiple Masters to connect with multiple Slaves over a single shared bus. Only one Master can access the bus at a time. Master starts the bus cycle to Slave, in turn Slave participates in bus transactions with the Master. The traffic is controlled by an arbiter who determines the access of Master to the shared bus. Other Masters have to wait until one Master completes its operations. This interconnection requires fewer gates and routing resources than Crossbar Switch interconnection.

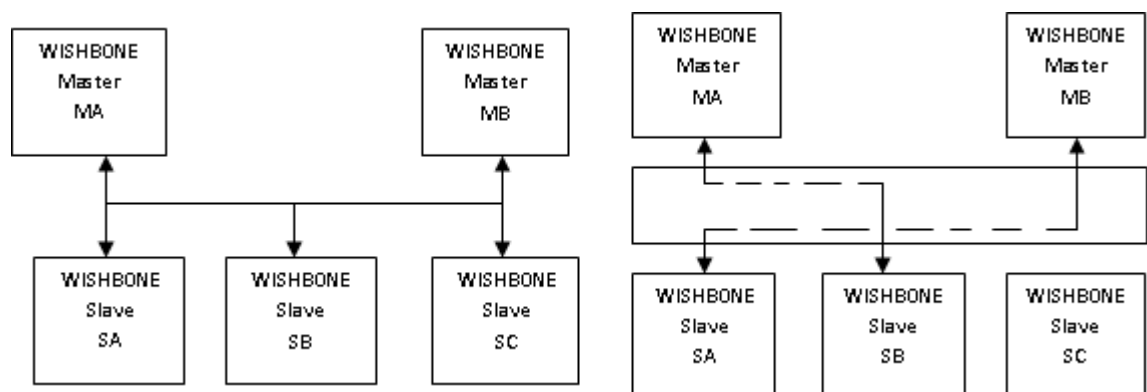


Figure: 2. 4 (a) Shared bus interconnection

(b) Crossbar switch interconnection

Figure: 2.4(a) shows a shared bus interconnection scheme using multiple Masters and Slaves.

### 2.6.4 Cross Bar Switch Interconnection

Unlike shared bus interconnection where a Master has to wait for the access of bus depending on the availability of bus, a crossbar switch interconnection allows multiple Masters to use the same interconnection as long as two Masters are not accessing the same Slave at a time. Hence the overall speed of this is higher than the shared bus interconnection. An arbiter determines when each Master(s) may gain access to the indicated Slave(s). Figure 2.4(b) shows how Masters MA and MB can get access to Slaves SB and SA at the same time. This suffers from using more logic and interconnection resources for forming the interconnection.

## 2.7 WISHBONE Bus Cycle

Three types of bus cycle are supported by WISHBONE interface. These include: *Single Read/Write Cycle*, *Block Read/Write Cycle*, and *Read modify write (RMW)* [5]. All the bus cycles in Wishbone interface follows a handshaking protocol between the master and slave interfaces to complete a successful data transfer.

### 2.7.1 Handshaking Protocol

Figure 2.5 shows the timing diagram of handshaking protocol used during data transfer in a cycle. The whole transfer is classified in four parts. These are *1: Operation is requested*, *2: Slave is ready*, *3: Operation is over* and *4: Ready for a new operation*. MASTER asserts strobe output indicating that the data is ready to be transferred. Strobe output remains asserted until the Slave asserts terminating signal acknowledge output which indicates the Slave is ready to participate in data transfer with Master. At every rising edge of clock signal the terminating signal is sampled and if it is asserted, then strobe signal is negated showing the completion of the operation. In response slave negates it's acknowledge signal which indicates it is ready for a new operation with master. This handshaking protocol is responsible for controlling the rate at which data is transferred between both Master and Slave interfaces.

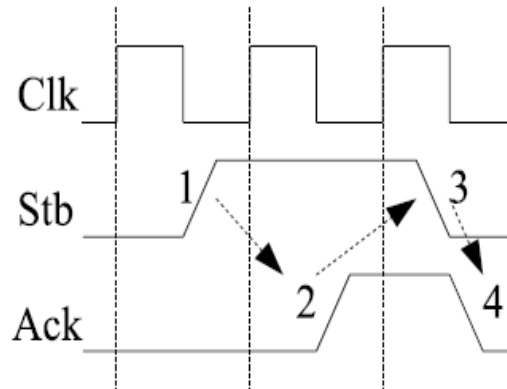


Figure: 2.5 Handshaking protocol

### 2.7.2 Single Read/ Write Cycle

Single Read/ Write cycle is used to transfer a single data operand between Master and Slave interface. For a Master to start a single read operation, Master presents a valid address in its address output port and negates the write enable signal to indicate read operation to be started.

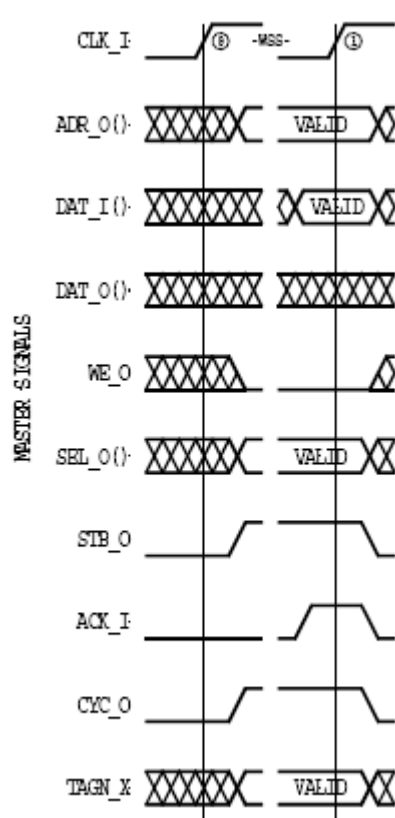


Figure: 2.6 (a) Single Read Cycle

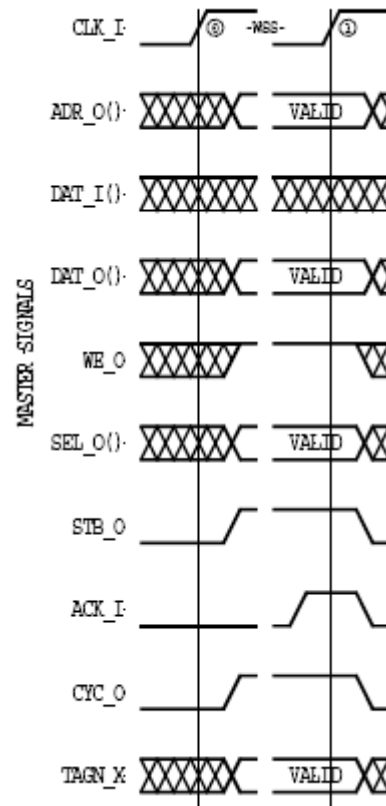


Figure: 2.6 (b) Single write cycle

Master also presents a valid bank select to indicate where it expects the data. Then Master asserts the cycle output showing the starting of the cycle and asserts the strobe output indicating that the transfer is ready to start. In response Slave presents valid data on the data output and asserts the acknowledgement signals to indicate the presence of valid data. Master monitors and latches the data in next clock pulse at its data input and negates the strobe and cycle output to indicate the end of the cycle. In response Slave negates acknowledgement showing ready for a new operation. Slave may insert wait states before asserting acknowledgement allowing it to throttle the cycle speed. Figure: 2.6 (a) and (b) shows the timing diagrams of a single read and write cycle respectively. The operation in the single write cycle is almost similar except that the Master asserts the write enable signal and places the data on its output and the Slave asserts the acknowledgement output when it latches the data.

### 2.7.3 Block Read/ Write Cycle

The block transfer cycle is used to perform multiple data transfer between MASTER and SLAVE.

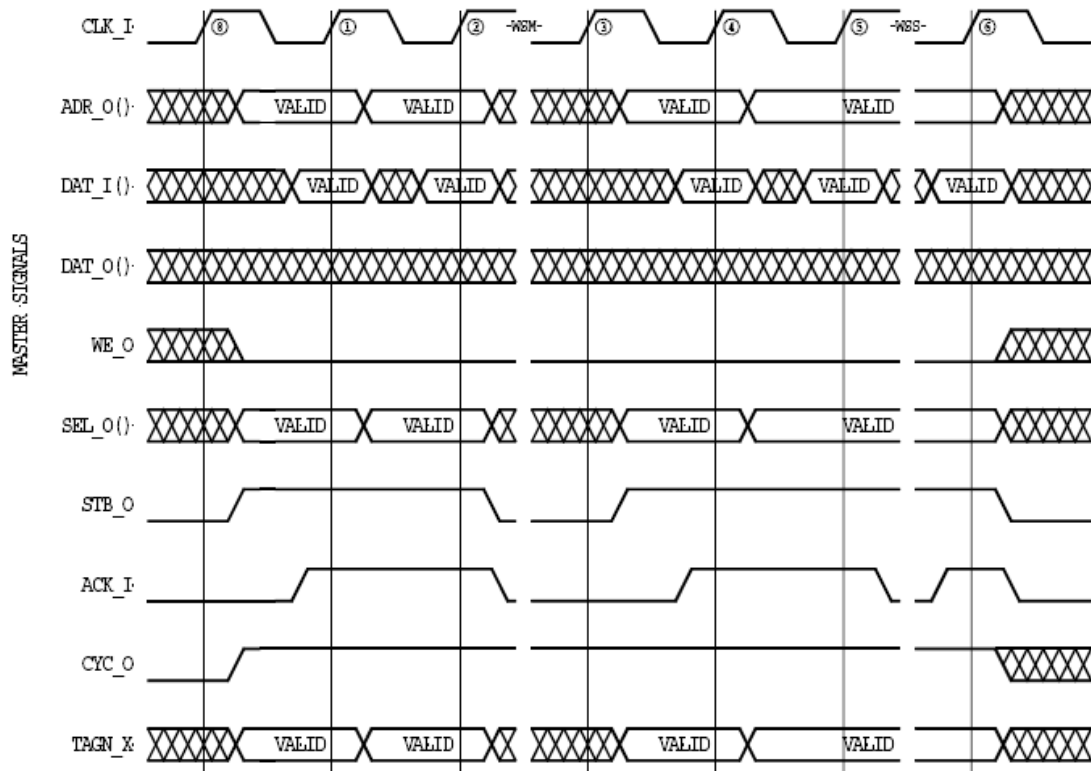


Figure: 2.7 (a) Block Read cycle

In block data transfers the operation is similar to the single read and write cycle with cycle output high for the entire period of data transfer. The cycle output negates after the completion of data transfer. This type of data transfer is useful when multiple Masters are used in an interconnection. The local bus handshaking protocol is maintained during each data transfer in a complete cycle. Wait state can be put by Master interface by pulling down the strobe and Slave interface by pulling down the acknowledgement signals to low. Figure: 2.7 (a) and (b) illustrates the timing diagram of block read and write cycles respectively.

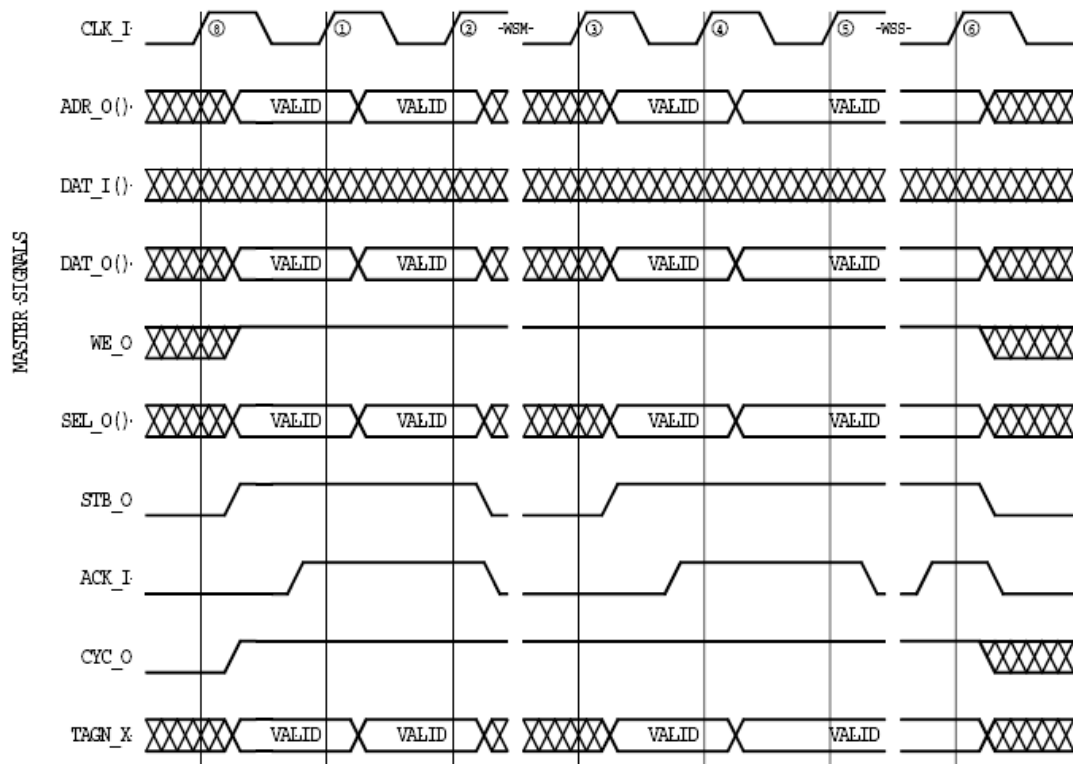
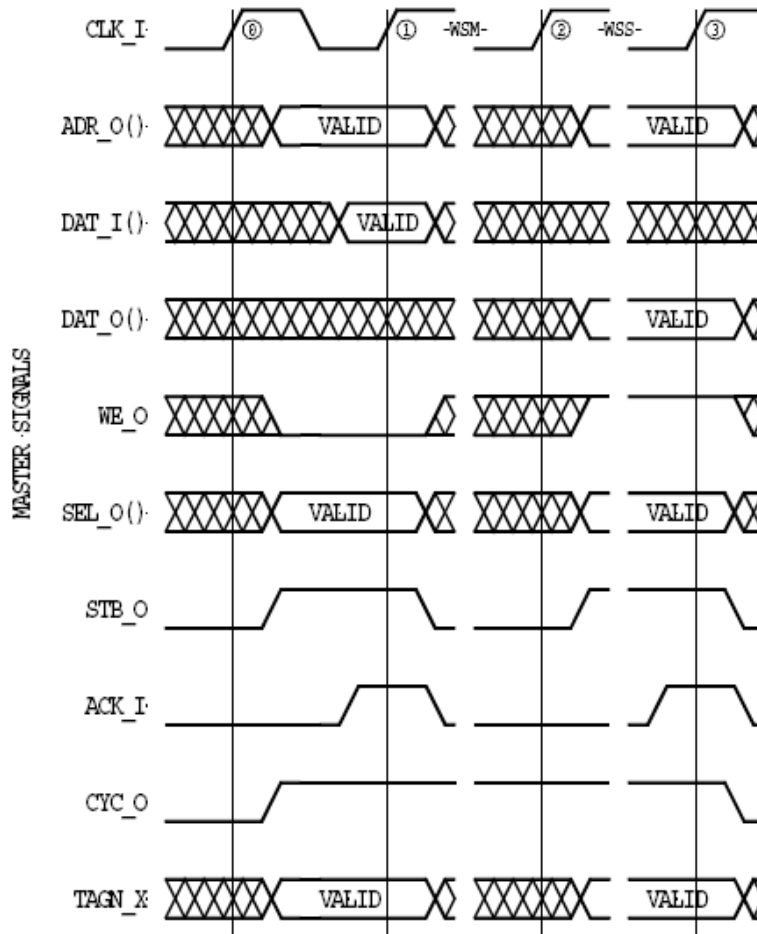


Figure: 2.7 (b) Block Write cycle

#### 2.7.4 Read-Modify-Write (RMW) Cycle

The read-modify-write cycle is used for multiprocessor and multitasking system is also known as indivisible cycle. It uses a semaphore to share common resources between multiple software processes. This type of bus cycle finds application in disk controllers, serial ports and memory. The read and write data to memory location is accomplished in a single bus cycle.



**Figure: 2. 8 Read-Modified-Write Cycle**

The read portion of the cycle is termed as the read phase, and the write portion is termed as the write phase. In case of multiprocessor system to prevent sharing of the same memory at a time a semaphore bit is used, which acts as a traffic cop between processors. If the bit is set then that particular Slave interface is busy, if it is cleared, then it is available for use. When a processor initiates a bus cycle with a memory it first checks and stores the state of the semaphore bit, and then sets the bit by writing back to memory in a single RMW cycle. Once this operation is completed and the state of the bit read during the first phase of RMW cycle, is clear the processor goes ahead using the Slave memory. Other processors attempting to use the memory read a high semaphore and prevent the access of memory. If this operation would have done with single read/write cycle, multiple Masters may access the same memory at the same time which



may lead to system crash. A special instruction such as test-and-set (TAS) and compare-and-set (CAS) are used by processors to impose RMW bus cycle operation. Figure: 2.8 show the timing diagram of RMW cycle.

## 2.8 Data Organization and Customized Tag

WISHBONE interface supports two ways of ordering of data during data transfer. These are BIG ENDIAN and LITTLE ENDIAN. In the first type the most significant byte of the operand placed at the higher address and in the second type, the most significant byte of an operand placed at the lower address.

The advantage of WISHBONE interface over traditional computer buses is that WISHBONE can be customized easily. WISHBONE interconnections are programmable in FPGA and ASIC by using VHDL and Verilog® languages and wide variety of routing tools. Although it allows changes in interconnection; still there may be a chance of interface incompatibility. This problem can be avoided by using *tagged architecture*. There are three categories of TAG TYPE available. They are *address tag*, *cycle tag* and *a set of data tag* [5]. Custom tags can be added to WISHBONE interface signals with the TAG TYPE available. The tag indicates the exact time of the signal response.

## 2.9 WISHBONE SOC Bus Comparison with AMBA and CoreConnect

SOC design requires a standard bus interface for IP cores to communicate with each other. There exist many other bus interfaces, but AMBA, CoreConnect and WISHBONE are well known and well used SOC bus architectures, therefore here the comparison is restricted to these buses. All three bus architectures are open bus architectures, which require no fees or royalties to use them. AMBA and CoreConnect require registration to get a free license to use. WISHBONE on the other hand doesn't require any kind of registration. The WISHBONE specification is almost free to copy and distribute. SOC design using AMBA and CoreConnect requires the designer to design their own library of IP cores or to buy IP cores from other companies. WISHBONE offers advantage compared to AMBA and CoreConnect. All designer using WISHBONE bus interface are allowed to upload their design in Open Core site where there exists many IP cores that support WISHBONE bus interface and they are all free to use. So depending upon the design specification the designer can select the IP cores from the site and glue them to the WISHBONE bus architecture to design the final SOC.

Comparing the architecture of these three buses, both AMBA and CoreConnect support two types of bus interface structure, one for high speed cores, such as processor, DMA and memory and other for low speed peripheral cores like UART, keypad etc. AMBA uses ASB/AHB and CoreConnect use PLB for high speed cores. For low speed cores AMBA uses APB and CoreConnect uses PLB. These bus structures have to be connected to each other through bridges. On other hand in WISHBONE only two ordinary bus interfaces connected through a bridge for different speed applications. AMBA and CoreConnect support hierarchical bus system. However, WISHBONE does not supports hierarchical bus interconnection, but allows various other possible interconnections, such as point-to-point, shared bus, crossbar switch interconnection, etc [5].

All the three support multiplexer based interconnection [16]. AMBA and CoreConnect are hierarchical buses. WISHBONE does not support hierarchical bus interconnection, but allows various other possible interconnections, such as point-to-point, data flow, shared bus and crossbar switch interconnection.

<b>Open Source</b>			
<b>Features</b>	<b>WISHBONE</b>	<b>AMBA</b>	<b>CoreConnect</b>
Open Architecture	Yes	Yes	Yes
Registration	No	Yes	Yes
<b>Bus Width [bit]</b>			
<b>Features</b>	<b>WISHBONE</b>	<b>AMBA</b>	<b>CoreConnect</b>
Maximum data bus width	64-bit	1024-bit	128-bit
Maximum address bus width	64-bit	32-bit	32-bit
<b>Architecture</b>			
<b>Features</b>	<b>WISHBONE</b>	<b>AMBA</b>	<b>CoreConnect</b>
Multiplexed	Yes	Yes	Yes
Hierarchical	No	Yes	Yes
Pipelined	No	Yes	Yes
<b>Data Transfer and Operating Frequency</b>			
Split Transaction	No	Yes	Yes
RMW transfer	Yes	No	No
Handshaking and Burst	Yes	Yes	Yes
Operating frequency	User defined	User defined	Depends on PLB width

**Table: 2. 4 Comparison of WISHBONE, AMBA and CoreConnect**

AMBA and CoreConnect both support split transfer in which a Slave has the possibility to release the bus to other Masters requesting it and having a higher priority than the Master using it. However WISHBONE supports Read-Modify-Write (RMW) transfer. In a multiprocessor system in order to avoid two or more Masters gaining access to the same Slave the Master has to use a RMW cycle.

RMW cycle gives a Master the opportunity to do both a read and a write operation before any other Master may use the bus and thereby avoiding a system crash. The operating frequency of AMBA and WISHBONE are user defined but the CoreConnect operating frequency is decided by the data width of PLB [17].

In respect to all of the above issues WISHBONE supports almost all features also supported by AMBA and CoreConnect. It also offers advantage of using predesigned IP cores available freely in Open Core site for the portable and reliable SOC design. Keeping view this features we adopt the WISHBONE interface for our SOC design. A summary of all the features of these three buses are given in Table 2.4.

## **2.10 Conclusions**

As design complexity increases, many SOC design methodologies have been proposed by research and industry community [3]. Some of them are still in development phase. Platform based SOC design is an emerging technology that utilizes previously design platform of abstraction level to form SOC design. But it requires a library of platform which can only possible in industry environment. On the other hand Open Core design offers SOC design using design reuse with a standard bus interface. WISHBONE bus interface made By Silicore [18] Corporation is a solution to the necessity of a standard bus interface. Open core utilizes WISHBONE interface for design reuse and help in plug and play integration of freely available IP cores that leads to low cost, reliable, time-to-market SOC design. The features of WISHBONE specification such as documentation, signal naming, types of interconnections and bus cycles has been discussed. Finally a comparison of WISHBONE bus with other two industry standard bus interface AMBA and CoreConnect has been done.

The brief summary of Wishbone bus interface with compared to other standards in industry are given below:

- Standard interfaces are available freely and can be used for SOC integration in industry as well as laboratory environment without any additional cost.
- It supports single Read/Write; block Read/Write bus cycles. It also supports RMW cycle as compared to split transaction of AMBA and CoreConnect to share same memory being used in multiprocessor SOC environment.
- The interconnection scheme supports variable interconnection and variable time specification. That means it can be changed by the system integrator and can be operated at any frequency which is limited to the technology of the target device.
- The edge of Wishbone interconnection over other microcomputer buses like PCI, VME bus is that it can be coded using any hardware description language like VHDL and Verilog®, and it takes the shapes of simple logic gates supported by most of the FPGA and ASIC devices.

# Chapter 3

## DESIGN AND VERIFICATION OF WISHBONE INTERCONNECTIONS

- **Design of WISHBONE Compatible Slave IP Core**
- **Point-to-Point Interconnection**
- **Shared Bus Interconnection**
- **Conclusions**

After the WISHBONE interface features have been discussed, the next step is to create a WISHBONE compatible Slave core. For this purpose a 16-bit Slave output port core has been taken and the issues related to make it WISHBONE compatible are specified. The corresponding simulation results of the core using Xilinx ISE simulator is provided. This chapter also demonstrates the design and verification of two types of bus interconnections such as point to point and shared bus interconnections. The various related issues to create the interconnection are also presented here. A bench marking of these two portable systems has been done to determine the maximum speed and minimum size in two types of FPGAs. The system consists of 32-bit DMA with Master interface which transfers data to and from 32-bit MEMORY with Slave interface. The verification results using Xilinx [20] ISE simulator and ChipScope Pro results are provided to validate the functionality of the system.

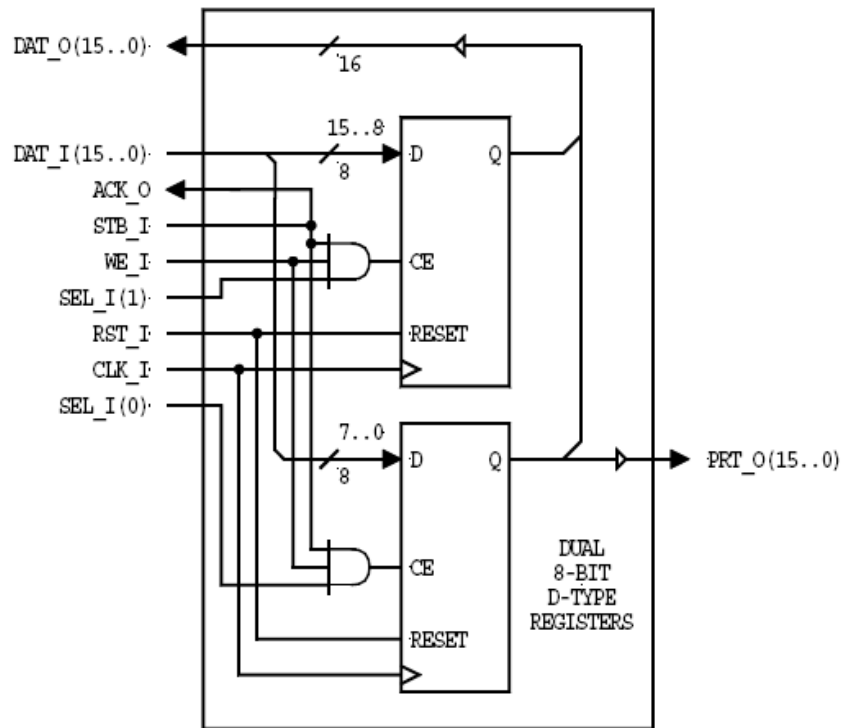
### **3.1 Design of WISHBONE Compatible Slave IP Core**

This section describes how to make a WISHBONE Compatible Slave IP core, so that user designed IP cores can be used in integration process for designing SOC. The idea behind this section is to demonstrate how WISHBONE interfaces work in conjunction with logic primitives available on FPGA and ASIC devices. It also demonstrates that a very little logic is needed to implement WISHBONE interface.

#### **3.1.1 16-Bit Slave Output Port Design with 8-Bit Granularity**

Figure: 3.1 shows a simple 16-bit WISHBONE Slave output port with 8-bit granularity, which means that data can be transferred 8 or 16-bits at a time. The issues related to making this core WISHBONE compatible are listed below:

1. To perform the write operation on Slave the data presented in the data input of Slave DATI (15:0) is latched in synchronous with the rising edge of clock signal CLK\_I when strobe, select signal and write enable are asserted. The data input port to Slave consists of 16-bit data of 8-bit granularity. This means that the 16-bit register can be accessed with either 8 or 16-bit bus cycles.



**Figure: 3. 1 Block diagram of 16-Bit Slave Output Port**

2. Granularity is chosen by selecting the high or low byte of data with select lines SEL\_I (1:0). When SEL\_I (0) is asserted the low byte is accessed, when SEL\_I (1) is asserted the high byte is accessed. When both the byte is asserted then 16-bit word is accessed.
3. To monitor the output port by a Master, the output data lines are routed back to the data output port DAT\_O (7:0). The 'AND' prevents any erroneous data being latched in to the register during read cycle.
4. STB\_I operates like a chip select signal, indicates the Slave interface will be selected if STB\_I is asserted. The select signals SEL\_I are used to determine which data is placed by the Master or Slave during read/ write cycles. An address decoder is used to generate the strobe signal, but select signal is provided to Slave devices.

As shown in figure: 3.1 the entire interface is implemented with standard 8-bit Xilinx and 'AND' gate. It shows that a very little logic overhead is required to interface a

core with WISHBONE bus. This gives rise to a highly portable system design that works with standard, synchronous and combinatorial logic primitives available in most of the FPGA and ASIC devices.

### 3.1.2 Simulation Results

The simulation result of the 16-bit output port done in Xilinx ISE simulator is given in Figure: 3.2. Initially DAT\_I is 16'h5F27. As strobe, WE\_I, STB\_I are high and SEL\_I (1) and SEL\_I (0) are asserted the high byte of data is written to qh [7:0] and low byte of data is written to ql [7:0]. The corresponding value is also routed to the data output i.e., 16'h5F27. If any of the signal is negated the output latch the previous value.

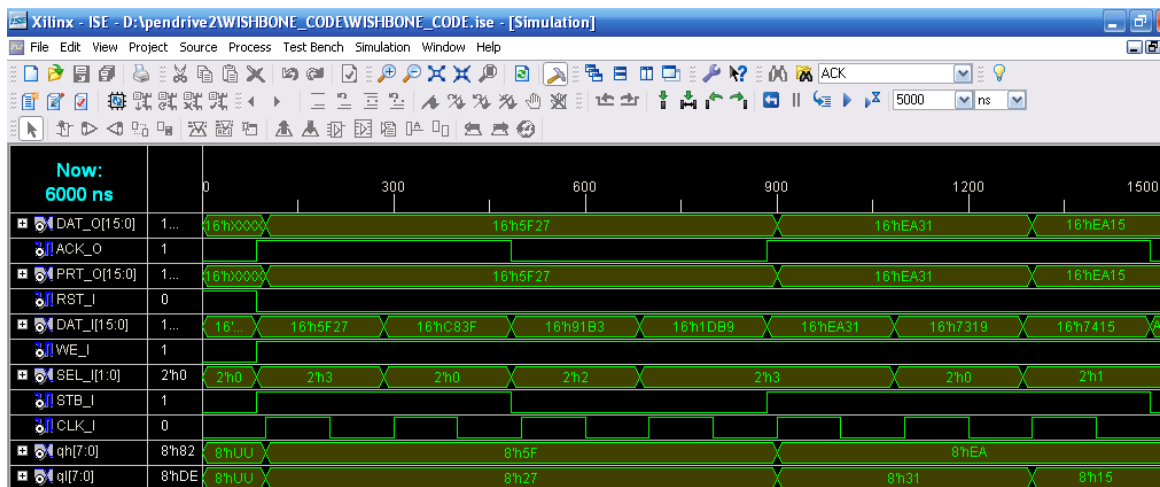


Figure: 3. 2 Simulation result of 16-bit output port with 8-bit granularity

## 3.2 Point-to-Point Interconnection

Figure: 3.3 show a point-to-point interconnection that includes SYSCON, DMA and MEMORY Cores. These cores are available in the WISHBONE public domain library for VHDL.

The descriptions of these cores including specifications and timing diagrams are given below.



### 3.2.1 Core specification and internal architecture

#### I. DMA

This is a simple 32-bit DMA unit with a WISHBONE Master interface. Two methods of data transfers are supported such as, *single read/write cycles and block read/write cycles*. The type of cycle is selected by a non-WISHBONE signal input DMODE.

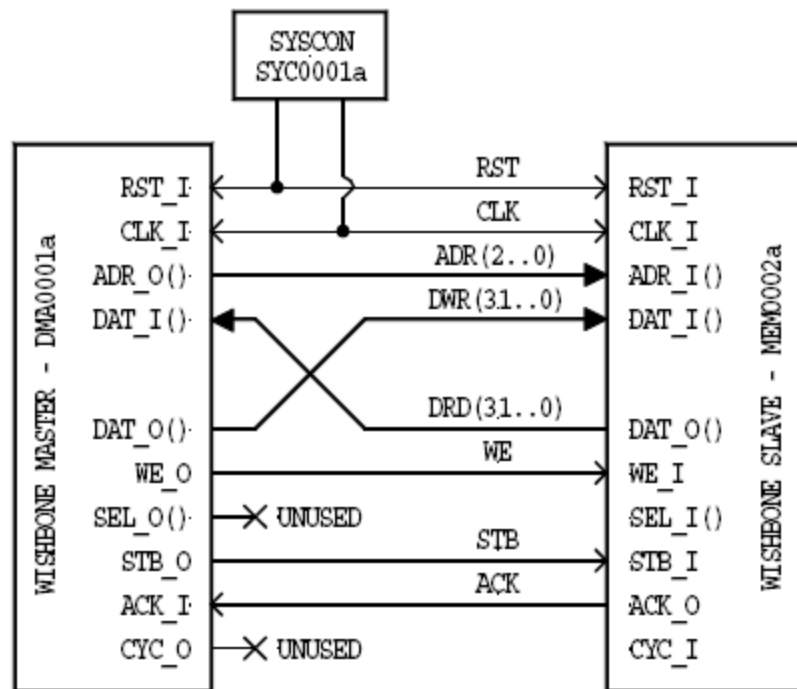


Figure: 3. 3 Point-to-point interconnection

Figure 3.4 shows the block diagram of the DMA unit which consists of a mode control, control state machine, input data register, output data register, address register and address counter. When reset signal is high, the DMA resets its control state machine and all related registers and counters and the initial address IA and initial data ID states are latched. This allows system integrator to enter the destination address and initial write data values to DMA. Mode control takes the input from DMODE signal and generates an input to the control state machine which is responsible to generate the data transfer cycles, strobe and cycle signal output. If DMODE input is negated, the DMA generates single read/write cycles, if it is asserted the DMA generates block read/write cycles.

An Address register latches the initial value of address. Input and output data registers are used to latch the input and output data. Address counter is used to generate 5-bit of binary address. The highest two address bits generated by the DMA are latched in response to a reset. This allows each DMA to target a unique Slave. The lower three address bits are generated by a counter that counts from 0x0 to 0x7, and rolls over from 0x7 to 0x0. The DMA increments its address after each bus cycle is completed.

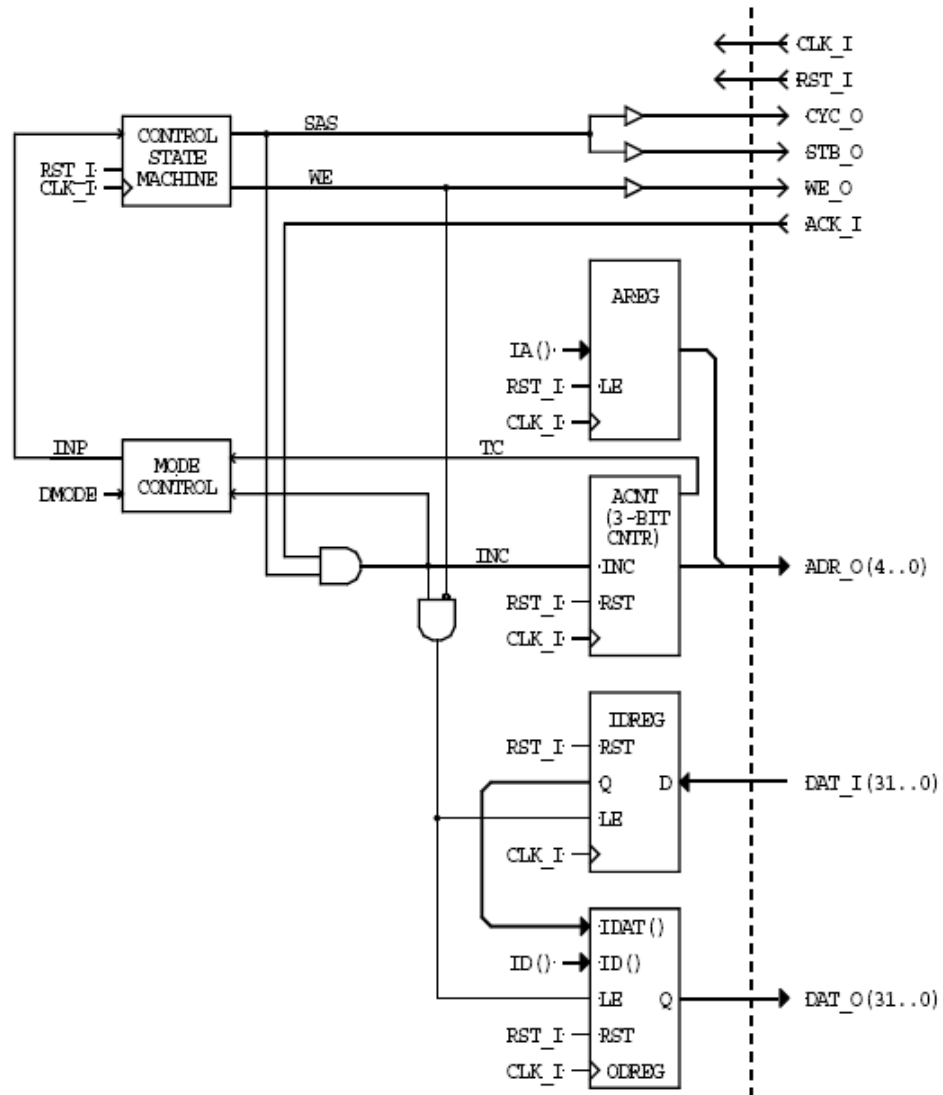
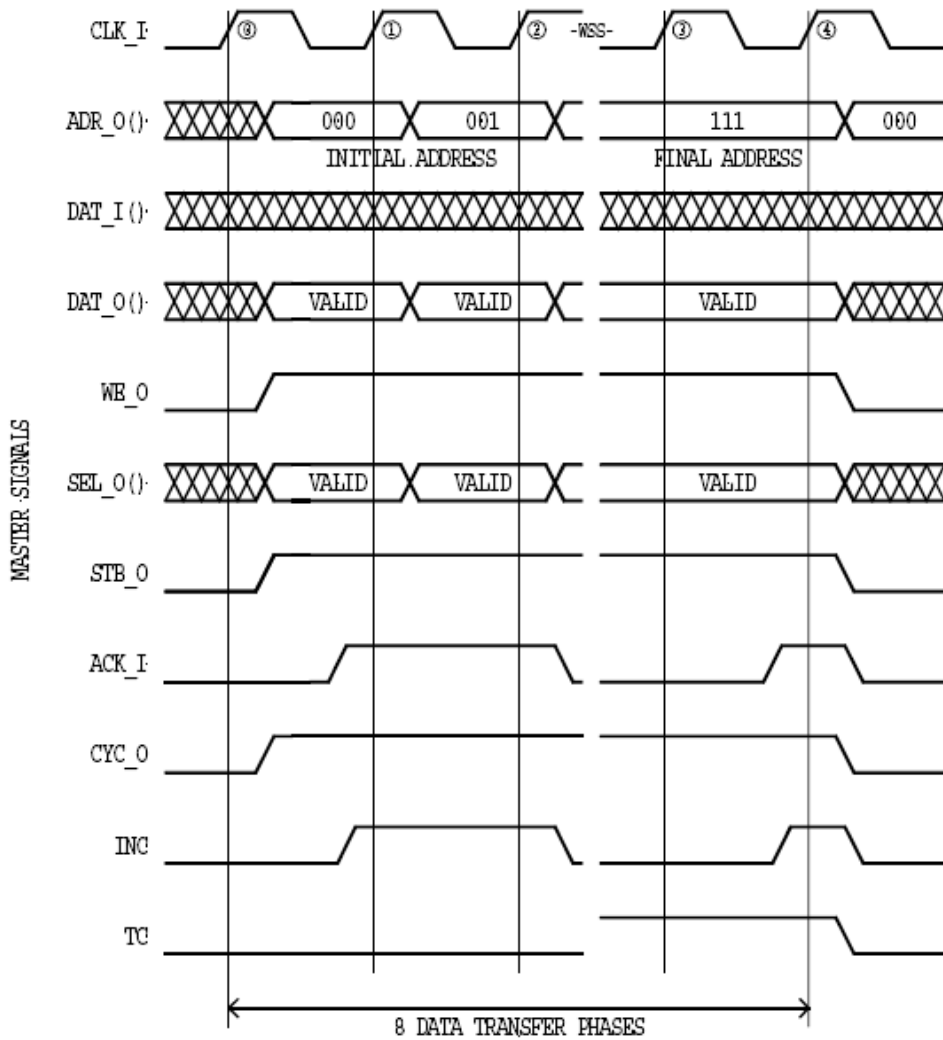


Figure: 3. 4 Block diagram of DMA

Figure: 3.5 and 3.6 show the timing diagrams for the block write and block read respectively. In single read/write cycles the DMA initiates a single write cycle in the rising edge of clock after reset is negated. After the write cycle is completed, the DMA initiates a single read cycle. The operation of write / read cycles can be repeated indefinitely.



**Figure: 3. 5 Block write cycle.**

In block read/write mode, the DMA initiates a block write cycle with eight phases, and then DMA generates a similar kind of block read cycle.

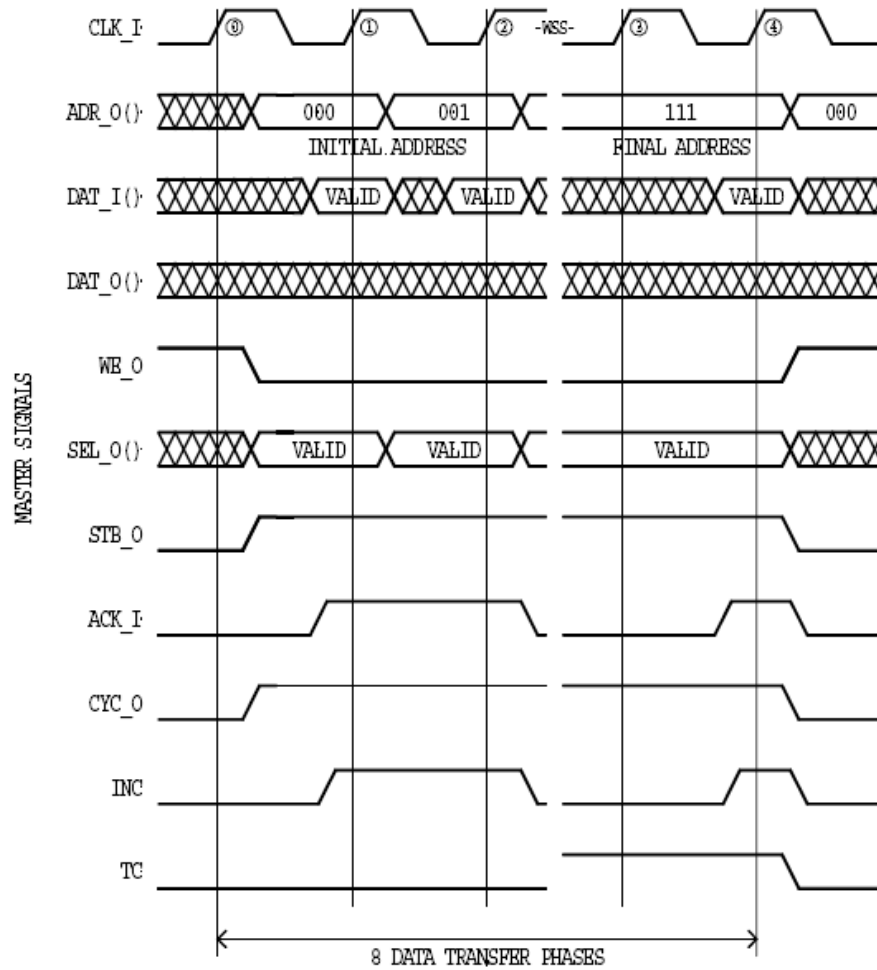


Figure: 3. 6 Block read cycle

## II. MEMORY

This is a simple, 8x32-bit size memory module with WISHBONE Slave interface designed for Xilinx [20] FPGA. Figure 3.7 shows the block diagram of the memory module which consists of a wrapper that interfaces the Xilinx ram to a WISHBONE Slave interface. Xilinx Core Generator tool is used to create the ram element. Xilinx Core Generator is a parametric core generator that generates optimized core for Xilinx FPGA. Xilinx provides reconfigurable IP cores which can be parameterized to create high performance design with reduction in design time. The figure also shows that, the overhead glue logic needed by the wrapper to interface ram with Slave interface is very

small and limited to only a single ‘AND’ gate. The ram is generated from Xilinx distributed ram.

The ram is generated from Xilinx distributed ram. Xilinx provides two ways of generation of ram. These are *distributed ram and block ram*. Distributed ram utilizes the FPGA look up tables (LUTs) to be configured as ram where as block ram uses dedicated memory on FPGA. The ram module generated is FASM compatible synchronous RAM. It supports single Read/Write, block Read/Write and RMW cycles.

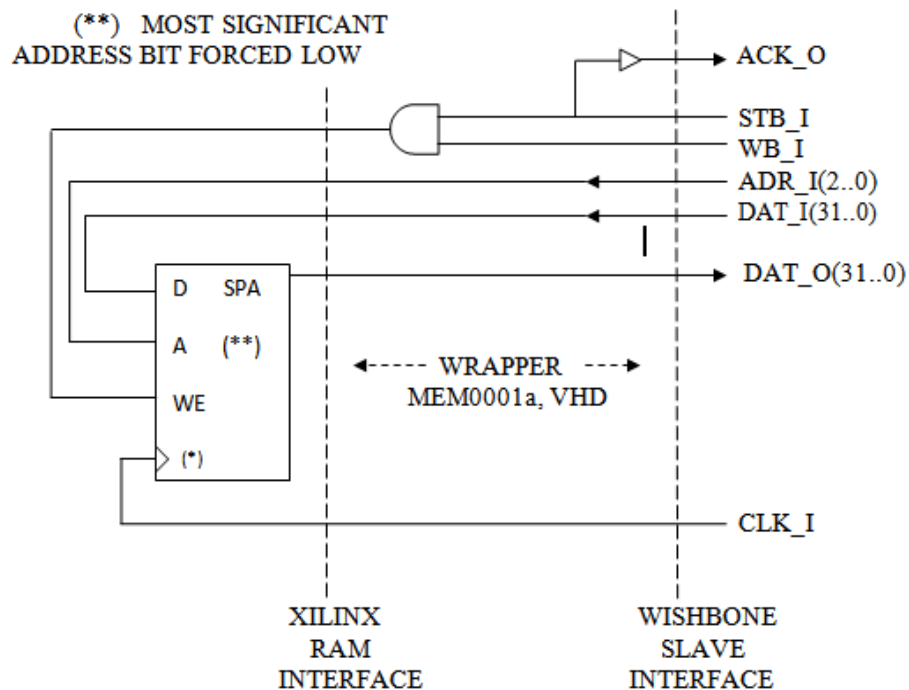
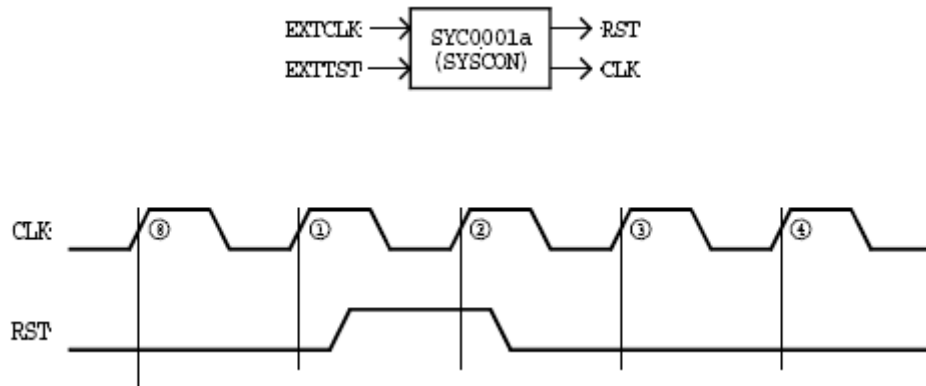


Figure: 3. 7 Block diagram of memory module

### III. SYSCON

SYSCON also called as system controller is used to generate WISHBONE compatible clock and reset signals for the system. The block diagram and timing diagram is shown in figure: 3.8. The clock output is fed directly from an external clock signal called EXTCLK. The reset generator produces a single reset signal RST in accordance with the WISHBONE reset timing. In order to operate properly, the flop-flops generated from reset state machine must power-up to the ‘zero’ state. An external input signal EXTTST is used to force the circuit into the power-up zero state. This helps in initializing

the flip-flops output to zero states, which generally initialize itself to a state immediately after FPGA configuration.



**Figure: 3. 8 Block diagram and timing diagram of SYSCON**

### 3.2.2 Interconnection Architecture

Figure: 3.3 show a point to point interconnection. The steps include to configure this interconnection architecture are following.

- As the name indicates, it is a direct connection of the cores with each other; hence the input, output ports of the modules require common signals for interconnection. A set of common signals have been created for the input and outputs such as reset, clock, address, data input; data output, write enable, strobe and acknowledge output.
- The corresponding signals are connected to the corresponding module's inputs outputs to form the interconnection. As an example acknowledge input of Master and acknowledge of output are connected to the acknowledge signal. This architecture has been written in structural modeling with DMA, MEMORY and SYSCON as the component of the structural model.

### 3.2.3 Verification Results

A test bench is written and verification of the point-to-point interconnection has done using Xilinx ISE simulator [20] to observe the functional behavior of the system. A simulation result of 5000 ns was taken and the result has been produced in two parts as shown in the Figure: 3.9 and 3.10. The value of 'dmode = 1', indicates the Master is performing a block read/write cycle. The system is first performing an eight phase of

block write cycle and then an eight phase of block read cycle. The data given in DMA for writing into the memory is 'id=32'h01234567'. Initially the write signal is high indicates the data is being written to data output bus 'edwr'.

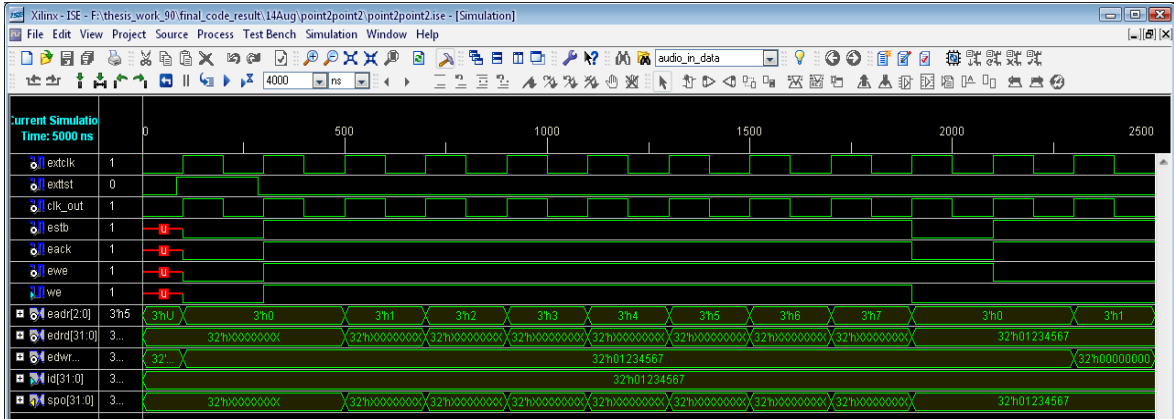


Figure: 3. 9 Simulation result for a clock period of 2500 ns

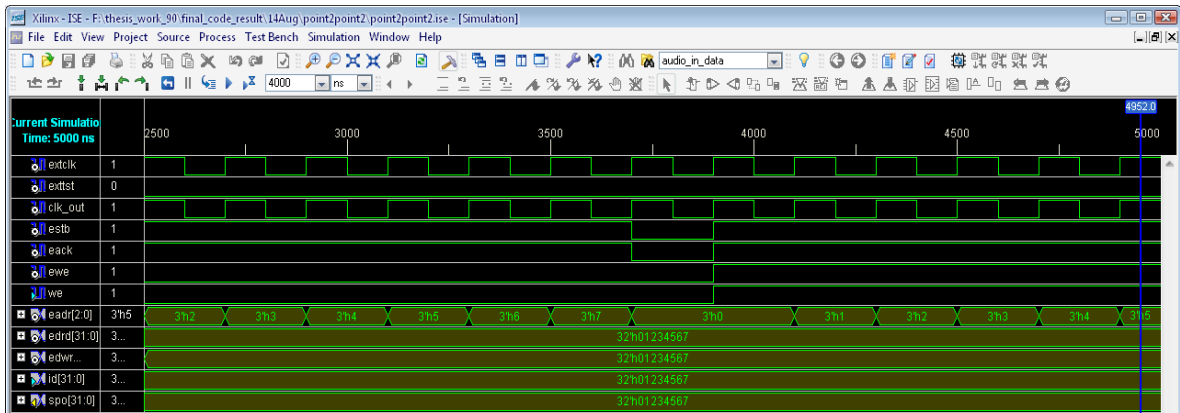


Figure: 3. 10 Simulation results for a clock period of 5000 ns

During this time data read by the Master is unknown. After some clock pulse the same data is read by DMA from the memory. So the final value of data DMA reads and writes in data buses is 32'h01234567.

### 3.2.4 Synthesis Results

The synthesis of the system is done using Xilinx Synthesis Tools. The RTL schematic is shown in figure: 3.11 and device utilization summary in Spartan3e and Virtex-II Pro FPGA are given in Table 3.1 and 3.2.

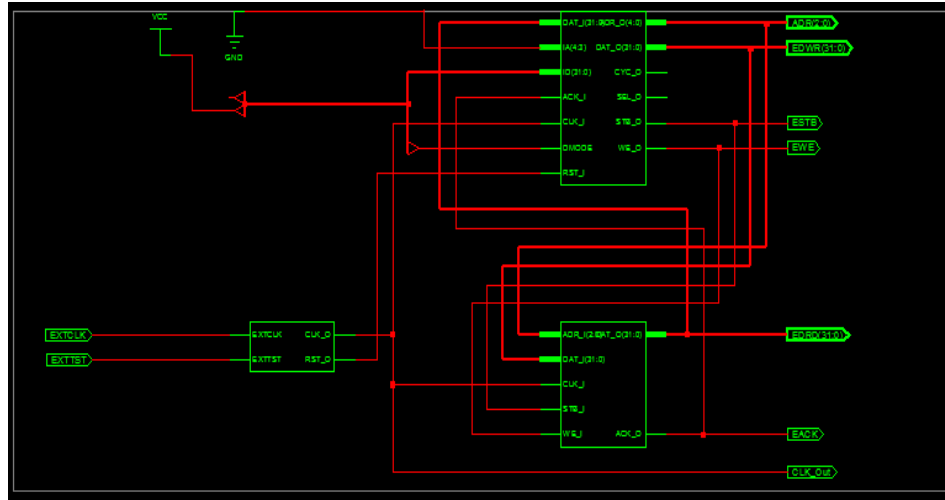


Figure: 3. 11 RTL schematic of interconnection

<b>Design Information</b>			
<b>Target Device:</b>		<b>xc3s500e-4fg320 (Spartan3e)</b>	
<b>Device Utilization Summary</b>			
<b>Logic Utilization</b>	<b>used</b>	<b>available</b>	<b>utilization</b>
Number of Slices	40	4656	0%
Number of Slice Flip Flops	69	9312	0%
Number of 4 input LUTs	15	9312	0%
Number of bonded IOBs	73	232	31%
Number of GCLKs	3	24	4%

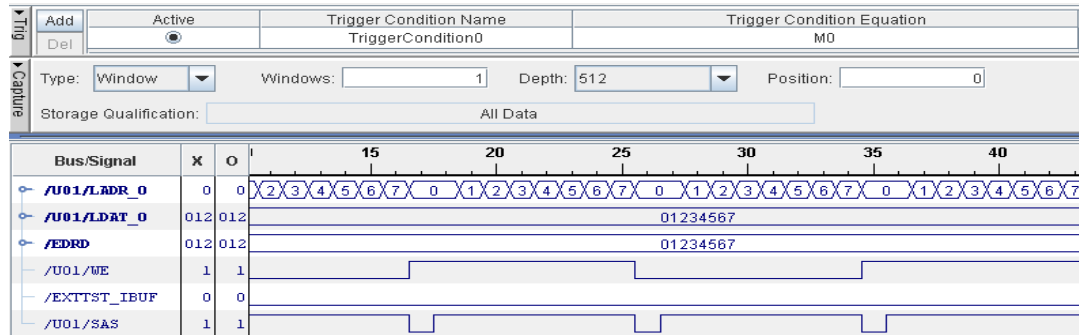
Table: 3. 1 Device utilization summary for Spartan3e.



<b>Design Information</b>			
<b>Target Device:</b> xc2vp30-7ff896(Virtex-II Pro)			
<b>Device Utilization Summary</b>			
<b>Logic Utilization</b>	<b>used</b>	<b>available</b>	<b>utilization</b>
Number of Slices	40	13,696	0%
Number of Slice Flip Flops	69	27,392	0%
Number of 4 input LUTs	15	27392	0%
Number of bonded IOBs	73	556	13%
Number of GCLKs	3	16	6%

**Table: 3. 2 Device utilization summary for Virtex-II Pro**

### 3.2.5 ChipScope Pro Result



**Figure: 3. 12 ChipScope Pro results of real time signals of interconnection**

All the pins of the FPGAs are generally surface mounted, so for real time debugging of the design, the signals of the design has to be routed to input and output of the design which increases the pin count of the design. ChipScope Pro [20] tool inserts logic analyzer, bus analyzer, and virtual I/O low-profile software cores directly into the design, allowing the designer to view any internal signal or node, including embedded hard or soft processors. Signals are captured at or near operating system speed and brought out through the programming interface, freeing up pins for the design. Captured signals can then be analyzed through the included ChipScope Pro Logic Analyzer.

Figure: 3.12 shows the real time debugging of internal signals through Xilinx ChipScope Pro tool. EDRD and LDAT\_0 are the data read and data write bus signals which shows that the DMA is reading and writing 32'h01234567 to and from the memory module. SAS and WE are the strobe and write enable signals of the system. The figure also demonstrates that the system is performing eight phases of write cycle and then eight phases of read cycles successfully.

### 3.2.6 Benchmarking Results

For benchmarking purpose synthesis results from two types of Xilinx FPGAs have been taken such as, Spartan-3e and Virtex-II Pro and compared. Here benchmarking indicates determining the maximum speed with the minimum area occupied by the interconnection in two types of FPGA technology. The tables shows 40 no.s of slices are required to form the interconnection in both the two types of FPGAs. The maximum speed of the interconnection in Spartan3e and Virtex-II Pro are 248.675 MHz and 450.113 MHz respectively.

<b>Table 3.2</b>			
32 bit Point-to-Point interconnection benchmark results			
MFG & Type	Part Number	Size	Max Speed
Xilinx Spartan3e	XC3S500e-4fg320	40 slices	248.675 MHz
Xilinx Virtex-II Pro	Xc2vp30 -7ff896	40 slices	450.113 MHz

**Table: 3. 3 32-bit Point-to-Point interconnection benchmark results**

### 3.3. Shared Bus Interconnection

This section describes the SOC design using shared bus interconnection. A 32-bit shared bus system is created which consists of four Masters and four Slaves. The modules used in point-to-point interconnection such as DMA, MEMORY and SYSCON has been used to form the interconnection and to explore the various integration issues related to shared bus interconnection. SOC design using shared bus interconnection is more complex than the point-to-point interconnection scheme. It imposes some of the

design complexities to the system integrator during SOC integration. System integrator has to perform some task before the final SOC integration.

These tasks include:

1. The type of bus topology i.e., multiplexed and non-multiplexed bus.
2. The type of interconnection logic i.e., three-state and multiplexor based interconnection logic.
3. Arbiters are required to grant bus access to the Master. The integrator has to decide which type of arbiter should be chosen depending on the application.
4. An address map should be created, so that Master can access the Slave through its binary address value using variable address decoding.
5. Creating the topology for interconnection.

All these issues are discussed and final benchmarking of the system in terms of minimum size and maximum speed has been presented in this section.

### **3.3.1. Bus topology**

The important thing in designing a system is to how to move the data around the system. The data may be a binary address value or a simple data value.

Hence buses are used to move the data around a system. There may be a chance that two different buses are required for data and address transfer or in a single bus data and address may be multiplexed to reduce the number of interconnections.

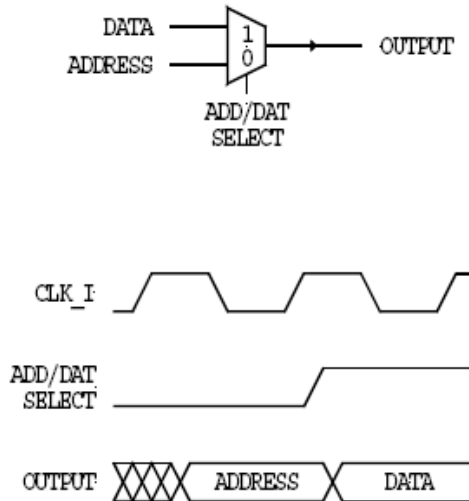
Two types of bus topology exists

- I. Multiplexed, bus topology and
- II. Non-multiplexed bus topology.

In multiplexed bus different types of data are routed over the same bus signals. Hence the number of interconnections require in multiplexed bus topology are less. Figure: 3.13 show a multiplexed bus where 32 bit address and 32 bit data are being presented in the same bus; this reduces the number of signals in interconnection from 64 to 32.

This bus topology is used in semiconductor industry to reduce the number of pins on a chip. The major disadvantages of the multiplexed bus topology are that it requires two clock pulses to move the data and address information in a system. Hence where speed is concerned a non-multiplexed synchronous bus is used to move the data and address information in a single clock cycle. It requires more interconnection logic as data

and address has to move in different buses. To benchmark the shared bus interconnection, a non-multiplexed synchronous bus system is employed for a high speed performance.



**Figure: 3.13 Multiplexed address/ data bus**

### 3.3.2. Interconnection logic

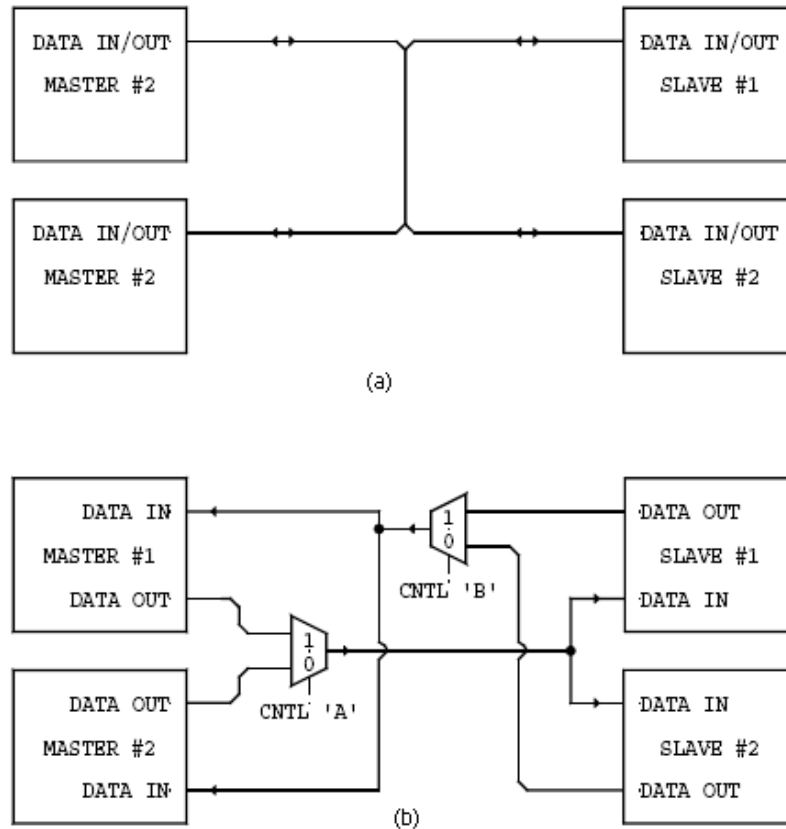
In shared bus interconnection multiple Masters connected with multiple Slaves. Any Master can access any Slave depending upon the availability of bus. The next issue in shared bus interconnection is to select a proper logic path to employ this large connection between all the Masters and Slaves. Hence all these Masters and Slaves must be routed properly to form the interconnection.

WISHBONE interconnection uses two types of logic to move data around a SOC

- I. Three state or tri-state buffer logic, and
- II. Multiplexor logic.

The use of Tri-state buffer as an interconnection logic reduces the number of pins in an interface. In Master-Slave architecture when a Master is allowed to use a bus, the Master turns its buffers 'on' to access the bus, while other Masters turns its buffer off. The Slave also reacts similarly. The Slave participating with Master bus transaction turns its output buffers 'on' to start the cycle.

Figure: 3.14 show three-state bus interconnection which uses three-state logic to interconnect two Masters with two Slave modules. However, this suffers from two major draw backs. First is buffer has inherent times delays for turning it on and off. Hence this is slower than direct connection. Second, tri-state buffer are not available in many FPGAs and ASIC devices.



**Figure: 3. 14 (a) Three-state Interconnection. (b) Multiplexor logic Interconnection**

A set of multiplexor logic interconnections shown in Figure: 3.10 are used to interconnect two Masters with two Slave modules. The advantage is that unlike tri-state buffer multiplexor logic are supported by all the FPGA and ASIC devices. The disadvantage of this approach is that they require large number of logic gates and routed interconnects than that of three-state logic. However, multiplexor logic interconnection is easier to route in FPGA and ASIC devices than that of three-state logic interconnection.

The reason for this are

1. Tri-state logic locations are fixed in many FPGA devices. Hence the interconnection using tri-state buffers force the router software to organize the

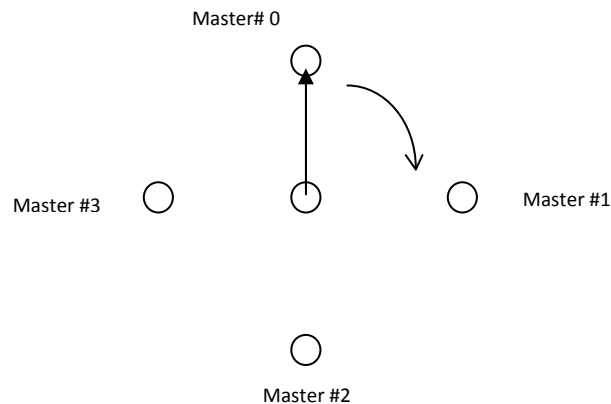
SOC around these fixed locations, which creates a poorly optimized circuit with slow speed.

2. Pre-defined, external input/output pin locations are easier to achieve with multiplexor logic interconnection in FPGA devices.

For benchmarking purpose a multiplexor logic for interconnection has been used so that the design can support many FPGA and ASIC devices.

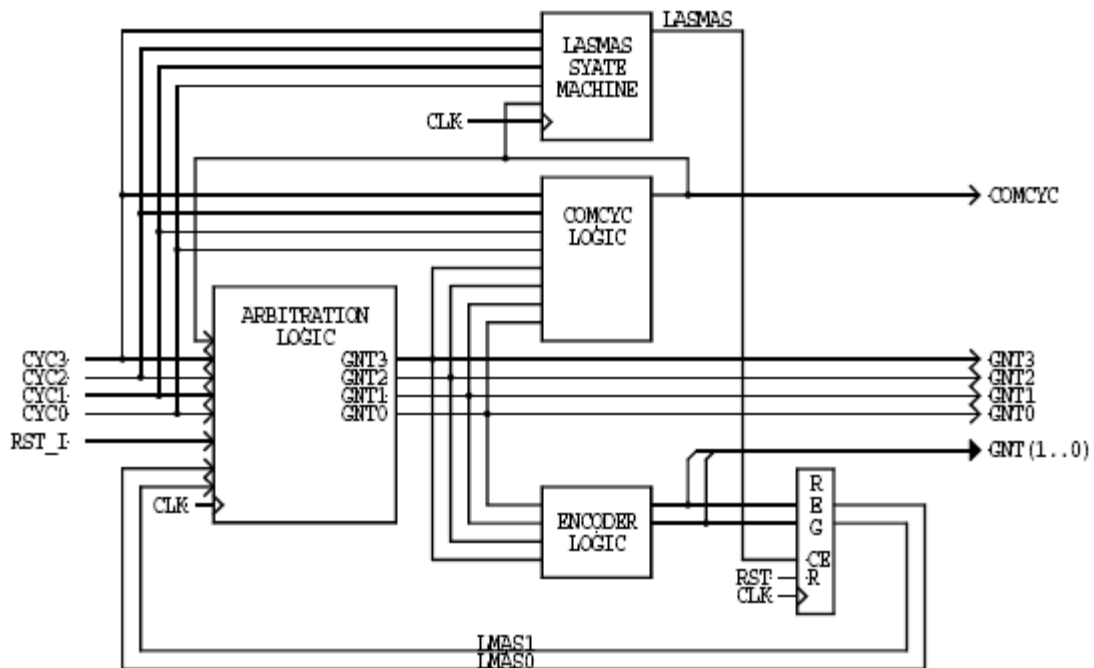
### 3.3.3. Arbiter Topology

An arbiter is used in shared bus interconnection to grant the access of the bus to a Master. Arbiter (ARB) is a four level, round-robin arbiter. Round-robin grants the access to bus on a rotating basis like a rotary switch as shown in figure: 3.15. As shown in the figure if Master0 is requesting for a bus access the arbiter grant access to it. After Master0 request is over, the arbiter is turned to the next position and grants the access to Master1. If Master1 is not making a bus request, the arbiter skips that level and continues to the next one. Thus all the Masters in round-robin arbiter are granted the bus on an equal basis. Round-robin arbiter finds application in data acquisition systems where collected data are placed into shared memory.



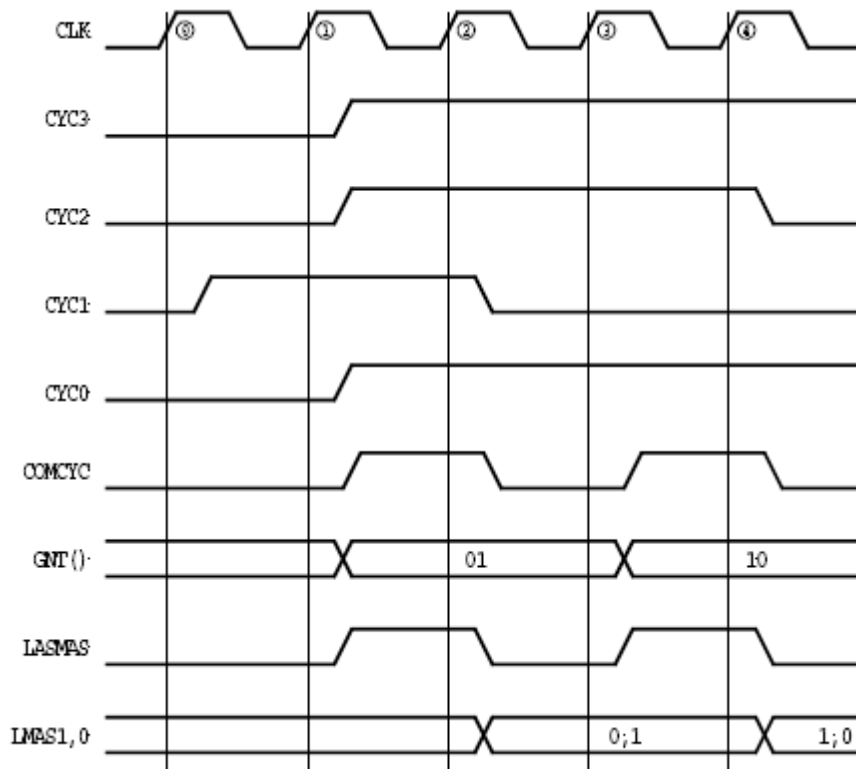
**Figure: 3. 15 Round-robin arbiter working as a rotary switch**

Figure: 3.16 shows the block diagram of an arbiter, consists of arbitration logic, COMCYC logic, encoder logic, LASMAS logic and register blocks. CYC0-CYC3 represents the bus requests made by the four Masters. When the Master wants the access of the shared bus it asserts the corresponding CYC signal and depending upon the availability of the bus the arbiter asserts the corresponding GNT0-GNT3. This is the operation of arbitration logic. COMCYC logic takes input from CYC0-CYC3 and generates signals COMCYC which shows the status of the bus. COMCYC is high indicates Master has requested the bus and has been granted the bus by the arbiter. Encoder logic encoded the (GNT3-GNT0) to GNT (1..0). GNT (1..0) with COMCYC is used in an interconnection to indicate which Master has been granted the bus.



**Figure: 3.16 Block diagram of round robin arbiter**

The Master level to be granted is determined by the previous level Master; hence round-robin arbiter keeps track of the previous level Master. It uses a register to catch the state of the grant signal GNT (1..0). The output of LASMAS state machine decides when the register will latch the grant level. The timing diagram of arbiter bus arbitration is shown in Figure: 3.17.



**Figure: 3. 17 Timing diagram of arbiter**

After the positive edge of clock pulse Master on level1 asserts its bus request on CYC1. At the next edge of clock pulse i.e., edge1 the arbiter asserts the grant signals GNT (1..0) and the COMCYC signal. This indicates that a valid arbitration is started and the arbitration level is latched in next clock pulse i.e., edge2 in signal LASMAS. This helps in arbiter to decide in the next level which Master will get the bus access.

When Master1 is done with its bus cycle, the level1 Master negates CYC1 after edge2 of clock pulse. As a response COMCYC is negated to indicate the initiation of arbitration. As shown in the figure at clock edge3 three Masters are requesting the bus at a time. But round-robin arbiter grants the bus to the second level of Master1 i.e., Master2 because Master2 is next to the Master1 in the round-robin. For benchmarking purpose of the shared bus interconnection a round-robin arbiter is chosen.



### 3.3.4. Partial address decoding and address map

Every Slave in an interconnection is defined by a specific binary address. In order to access the Slave the Master has to decode the corresponding address. Two types of methods are used to decode the address in a system. These are,

- I. Full address decoding, and
- II. Partial address decoding.

Most of the standard microcomputer buses like PCI and VME bus use full address decoding. In this type decoding of full address of the bus is utilized to access a Slave. i.e., if a 32it address is used, then each Slave will be assigned with all thirty two address bits. In partial decoding a range of the address is assigned as a decoding address of the Slave module. In other way, if the Slave has four registers, then WISHBONE interface utilizes only to address bits for decoding the Slave. Standard microcomputer buses the interconnection method cannot be changed, so it uses a full address for decoding, whereas WISHBONE supports variable interconnection and allows partial decoding method.

The partial decoding method has the following advantages:

- As part of an address is in use, the size of the decoder is minimized and it allows high speed decoders and speeds up the interface.
- It requires less redundant decoding logic or gates.
- It supports variable sizing. i.e., in WISHBONE the address path can be of any size between 0 and 64-bits.
- It supports variable interconnection scheme.

As WISHBONE is using partial decoding technique, the integrator has flexibility in defining the address map of the system. However, partial decoding technique suffers from a disadvantage that the SOC integrator has to define address decoder logic for each IP core, which increases the effort of integrating cores into the SOC. Table: 3.4 shows the address map used in designing the shared bus interconnection.

Table 3.3 Address map used by Interconnection			
DMA Master	Memory SLAVE	Address	Cycles
Master0	Slave0	0x00 – 0x07	Block Read/Write
Master1	Slave1	0x08 – 0x0F	Block Read/write
Master2	Slave2	0x10 – 0x17	Block Read/Write
Master3	Slave3	0x18 – 0x1F	Block Read/Write

Table: 3. 4 Address map used by Interconnection

### 3.3.5. Interconnection topology

A shared bus interconnection is created for benchmarking purpose with a multiplexor interconnections and non-multiplexed address and data buses. Figure: 3.18 shows the block diagram of general share bus interconnection for n number of Master and Slaves. For system design four DMA Master and four Memory Slave modules. A SYSCON module is used to provide the system with clock and reset signal. An arbiter module is taken to grant the access of the bus to Masters.

The steps for creating this interconnection architecture are as follows:

- 1) A top module file is created where four DMAs, four memory modules are instantiated as components in a structural model. The output of the DMA such as ADR\_O, DAT\_O, SEL\_O, WE\_O, STB\_O, is routed to five multiplexors respectively. The outputs of the multiplexors form the corresponding bus to carry the data from the DMAs. This is how multiplexor logic interconnection has been created. Similar bus interconnection is created for data input DAT\_I.
- 2) An address comparator is used to decode the address values so that Master can access the corresponding Slaves from the decoded address.

The operation of interconnection is described below:

- 1) After the initial system reset, one or more Masters request the interconnection or bus by asserting their cycle output signal CYC\_O. Arbiter grants the bus to one of the

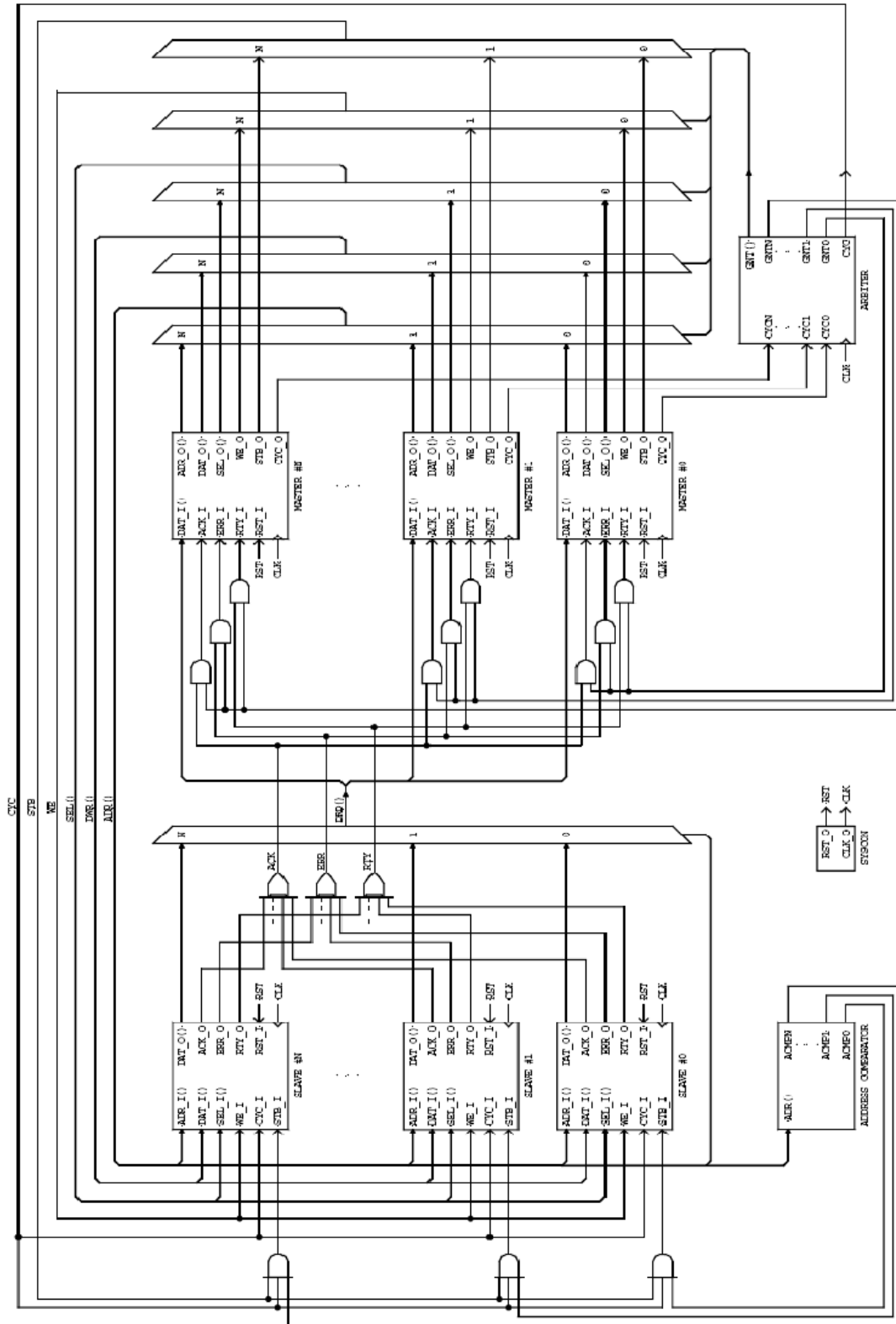


Figure: 3. 18 Block Diagram of a Generalised Shared bus Interconnection

- 2) Masters requesting for bus, after one clock edge from the assertion of corresponding cycle out signal. It does so by asserting grant lines GNT0-GNT3 and GNT (1..0) and the corresponding Master owns the complete control of the bus.
- 3) Once the bus is granted, the Master routes the output signals such as address, data output, write enable and strobe out on to the shared bus via multiplexor. The shared bus output signals are routed to the inputs of the Slave interfaces. The grant lines are also used to enable the terminating signals like acknowledge in of the Master that acquire the bus. As an example if Master0 get the access of the bus, then the output signal mentioned ADR, WE, and DATO are routed to the shared bus and shared bus output to the Slave signals and the grant is also used to enable the acknowledge in of Master0.
- 4) The common address bus takes the value from the Master address line and is decoded by an address comparator. The address decoder splits the address into four parts and the decoded output selects the Slave by its strobe input. The Slave responds to the bus cycle of the Master when its strobe input is asserted.
- 5) Once the Slave is selected by its address map, it participates in the bus transactions with the Master and as a response it asserts the terminating signals such as, acknowledge out. These signals are routed to the corresponding Master. If a Master initiates a single read cycle, then Slave places data on its data out bus. These data are routed to the corresponding Master via multiplexor interconnection logic through appropriate selection of address lines.
- 6) When the Master receives an assertion in terminating signals, it terminates its bus cycle by negating strobe output. If the Master is in the middle of block cycle then it will complete its whole phase of block transfer and after completion of block cycle or single read/write cycle, it terminates the cycle by negating its cycle output signal and informs arbiter to start re-arbitration.

### 3.3.6. Verification Results

The simulation result shows that initially arbiter grants request to Master. As write signal ‘ewe’ is high, DMA starts writing data from the address 5’h08. It continues 8 phases of write operation and write 32’hA5A5A5A1 in the data write output bus ‘edwr’. Then it makes its cycle output ‘ecyc’ low indicating arbiter to re-arbitrate. The Master grants the access to the next Master in the round-robin i.e., Master2. Master2 performs 8 phases of write signal and write 32’hA5A5A5A2 to the ‘edwr’ bus. After Master2 leaves the bus Master3 gains the access of bus and perform a block write operation as defined in the design and writes 32’hA5A5A5A3 to output bus. Finally, Master0 is in the loop to get the access of the bus and to write data value 32’hA5A5A5A0 to ‘edwr’ bus.

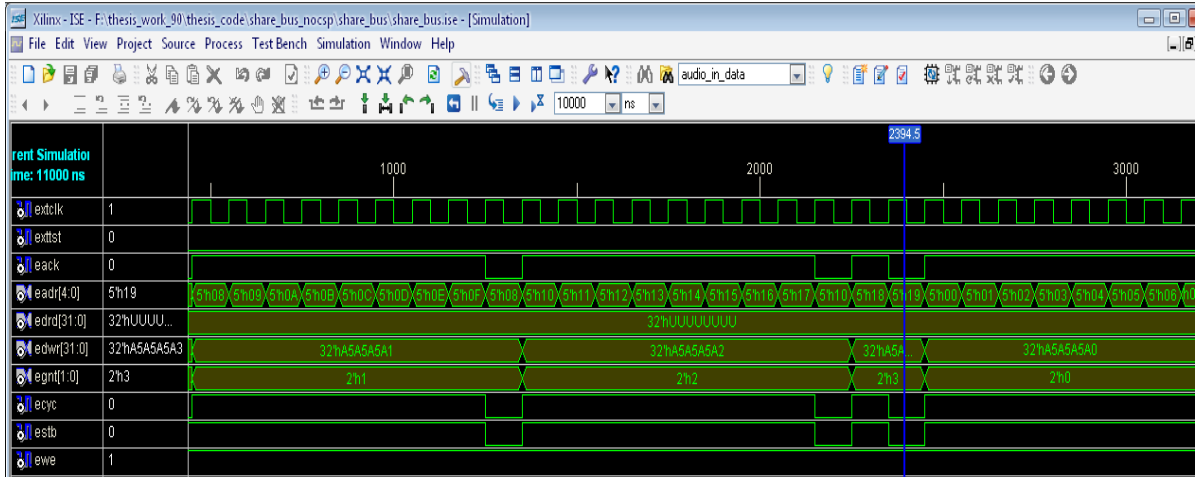
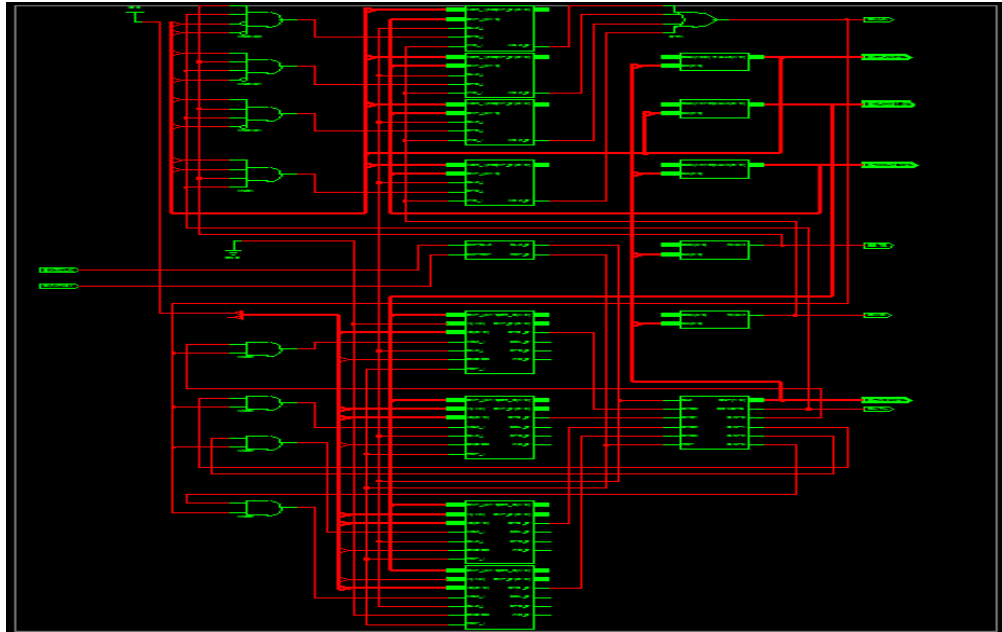


Figure: 3. 19 Simulation result for a clock period of 4000 ns

The simulation is taken in Xilinx ISE simulator for a period of 4000 ns where it is observed that the interconnection functions accurately. It is also clearly visible that all the Slaves are accessed by their corresponding address values defined in the address map.

### 3.3.7. Synthesis Results

Figure: 3.20 shows the RTL schematic generated after synthesis of the design using Xilinx Synthesis Tools. The schematic comprises four DMAs, four memories, SYSCON and an arbiter to form the interconnection. Table: 3.5 and 3.6 show the device utilization of the interconnection design in Spartan-3e and Virtex-II Pro board.



**Figure: 3. 20 RTL schematics of shared bus interconnection**

<b>Design Information</b>			
<b>Target Device:</b>		<b>xc3s500e-4fg320(Spartan3e)</b>	
<b>Device Utilization Summary</b>			
<b>Logic Utilization</b>	<b>used</b>	<b>available</b>	<b>utilization</b>
Number of Slices	292	4656	6%
Number of Slice Flip Flops	416	9312	4%
Number of 4 input LUTs	459	9312	4%
Number of bonded IOBs	77	232	33%
Number of GCLKs	1	24	4%

**Table: 3. 5 Device utilization summary of interconnection Spartan3e**

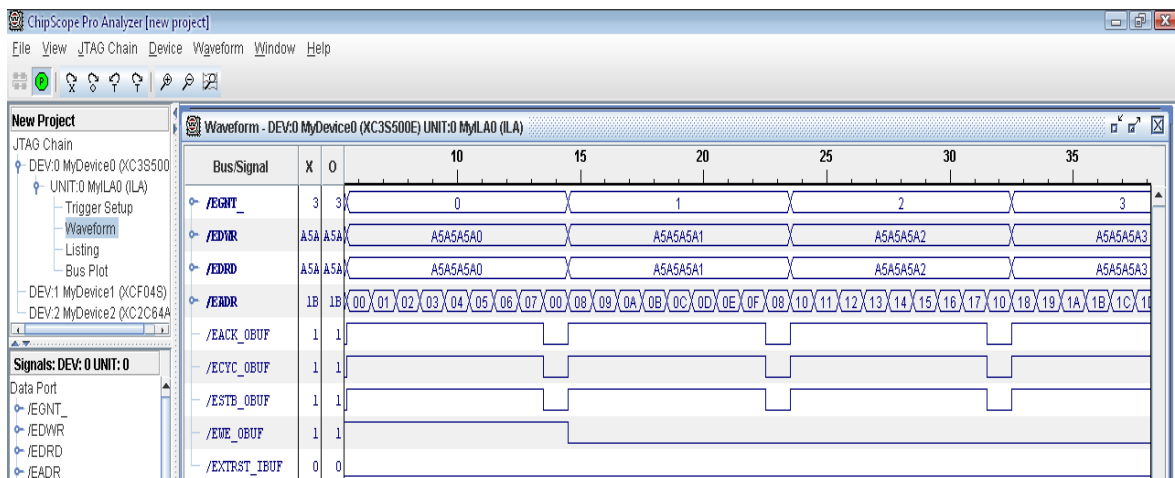
From the Table: 3.5 and 3.6 it is observed that the shared bus interconnection is consuming very less device available in the two types of FPGAs.

<b>Design Information</b>			
<b>Target Device: xc2vp30-7ff896 (Virtex-II Pro)</b>			
<b>Device Utilization Summary</b>			
<b>Logic Utilization</b>	<b>used</b>	<b>available</b>	<b>utilization</b>
Number of Slices	295	13,696	2%
Number of Slice Flip Flops	416	27,392	1%
Number of 4 input LUTs	472	27392	1%
Number of bonded IOBs	77	556	13%
Number of GCLKs	1	16	6%

**Table: 3. 6 Device utilization summary in Virtex-II Pro**

### 3.3.8. ChipScope Pro Result

The real time debugging signal in ChipScope Pro is given in Figure: 3. 21. The figure shows Master0 request for the bus by asserting **ECYC\_OBUF** signal. Arbiter first grants the access of bus to Master0. Master0 generates eight phases of block write and read signals and read and writes to and from memory.



**Figure: 3. 21 ChipScope Pro results of real time signals of interconnection**

The value of data is 32'hA5A5A5A0. Then arbiter grants the access to Master1 and so on. The arbiter grant signal is **EGNT**. The data read and write by Master1, Master2 and Master3 are 32'hA5A5A5A1, 32'hA5A5A5A2, and 32'hA5A5A5A3 respectively. Figure: 3.19 also shows that all the WISHBONE signals are following the timing diagram as discussed in chapet-2. The corresponding acknowledge, cycle, strobe and write signals are EACK\_0BUF, ECYC\_0BUF, ESTB\_0BUF and EWE\_0BUF.

### 3.3.9. Benchmarking Results

Table 3.7			
32 bit Shared bus interconnection benchmark results			
MFG & Type	Part Number	Size	Max Speed
Xilinx Spartan3e	XC3S500e-4fg320	292 slices	118.312 MHz
Xilinx Virtex II Pro	Xc2vp30 -7ff896	295 slices	219.896 MHz

Table: 3. 7. 32-bit shared bus interconnection benchmark results

The benchmarking of the shared bus interconnection system is done in Xilinx Spartan-3e and Virtex-II Pro FPGA. The design utilizes 292 slices in Spartan-3e and 295 slices in Virtex-II Pro to form the interconnection, which are almost same values. The max sped of the design in Spartan-3e is 118.312 MHz and that in Virtex-II Pro is 219.896 MHz.



### 3.4. Conclusions

Two types of interconnection topology have been created and its related design issues are discussed. Initially a Slave core of 16-bit output of 8-bit granularity has taken and the issues related to making it WISHBONE compatible has been discussed. A 32-bit point-to-point and shared bus interconnection are designed and related issues are discussed. The verification of the design is done using XILINX ISE simulator. Finally, by using ChipScope Pro provided by Xilinx the proper functionality of the designed systems are observed

The following conclusions are made from the above discussion:

- WISHBONE interface requires a very little logic overhead to implement the entire interface. This gives rise to a highly portable system design that works with standard, synchronous and combinatorial logic primitives available in most of the FPGA and ASIC devices.
- The benchmarking results show that it also utilizes a very less logic to form the interconnection. The minimum size requires for implementing point-to-point interconnection is approximately 40 slices and for shared bus interconnection is 292 slices. Both the interconnection supports an operating frequency of more than 100 MHz. It is also observed that the maximum operating frequency of the design depends on the target device technology. For high speed FPGA like Virtex-II Pro the frequency is higher than the low speed FPGA Spartan3e. Hence, it supports variable timing specification.

Low cost, portable and time to market SOC can be designed successfully using WISHBONE bus interface.

# Chapter 4

## **SOC Architecture and Design Methodology**

- **Proposed SOC Design Methodology**
- **Hardware Gateway of SOC Architecture**
- **Descriptions of IP Cores**
- **Conclusions**

After complete verification and benchmarking of two Wishbone bus interconnections, this chapter illustrates the methodology for a portable SOC design for laboratory applications. For this purpose a suitable SOC architecture has been taken and the IP cores are collected from the Open Core site. Finally, these cores are integrated to form the SOC. The cores specifications, internal architecture, CPU bus cycles are explained in this chapter.

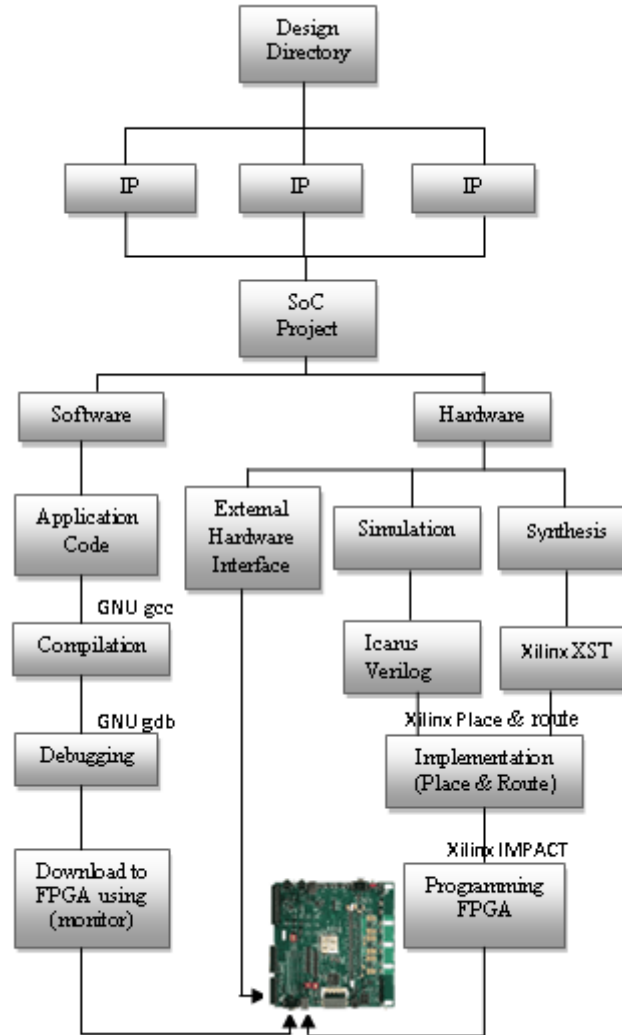
## **4.1 Proposed SoC Design Methodology**

This section presents a description of design methodology adopted to implement a SoC using Wishbone bus interface for laboratory applications. The complete design methodology shown in Figure: 4.1 are consists of hardware design flow and software design flow. These flows are described individually in the next section. The hardware design flow is started with a collection of a set of IP cores and integrating them for a chosen application, then arriving at the simulation step for verification of the entire SOC design. Synthesis and implementation is done afterwards for ensuring the proper hardware mapping & routing of SOC in FPGA. An application required to run in the SOC hardware is being done by the software design flow. This can run in parallel with the hardware design platform. Finally, the hardware model and software applications are implemented in the real hardware. A complete verification and monitor checking is being done for ensuring proper functionality of the system.

### **4.1.1 Hardware Design Flow**

The SOC design steps begins with a collection of Open Core Project Aquarius [23] aiming initially for an implementation of simple SOC architecture consisting of a 32-bit RISC processor (SuperH-2 compatible) and a set of peripherals for data transmission with PC. The first step is to configure and adoption of the processor model and the selection of any additional peripherals needed for the design. A set of IP cores of 32-bit RISC CPU Aquarius [ ], parallel input output (PIO), memory, system controller and UART, were collected in a project directory and kept back for the future applications. After the selection of IP cores and integrating same to desired SOC architecture, different steps of the hardware design can be achieved in parallel, such as external hardware interfacing, simulation and synthesis of the design. Aquarius developer provides a test

bench with the project. A set of test bench have been developed in order to simulate the hardware model. Icarus Verilog [19] tool is used to run this test bench to check the results obtained are accurate to our application.



**Figure: 4. 1 Design Methodology**

A gate level net list is generated from a set of given RTL code for modeling the SOC architecture into hardware. This is achieved by the synthesis step. Xilinx-Synthesis-Tool [20] is used to compile the RTL behavior of SOC to generate a gate level net list for the FPGA. Finally, implementation step is done where the gate level net list generated in the previous step is used by Xilinx [20] place and route tools to do mapping, placing & routing for target FPGA. A bit-stream file is generated to program the FPGA with the

hardware model obtained in the complete flow. The additional hardware needed for the application is developed and connected with the FPGA.

### 4.1.2 Software Design Flow

Software design flow usually runs in parallel to the hardware design flow. This section explains the design flow for software applications and the tools provided for designer to choose for the work.

The simulator of Verilog-HDL codes and the compiler/assembler of the application code development run on the UNIX environment. Cygwin [21] is selected as the preferred environment for this purpose. To simulate verification program and to develop the application program, the SuperH-2 [22] assembler and compiler are necessary. GNU tool chain is preferred which can be used by the designer for software development. The other steps involve compilation, debugging and implementation of the software on the hardware. The project in Open Core provided with simple and useful resources for logic verification and application code development. Application codes are developed in C and compiled with GCC compiler. Debugging the application is an important step in the software development flow, to validate the results obtained with the program in the SOC. This is done by GNU GDB [24] debugger. Finally, by using monitor program the code is downloaded to SOC model dumped in the FPGA.

## 4.2 Hardware Gateway of SoC Architecture

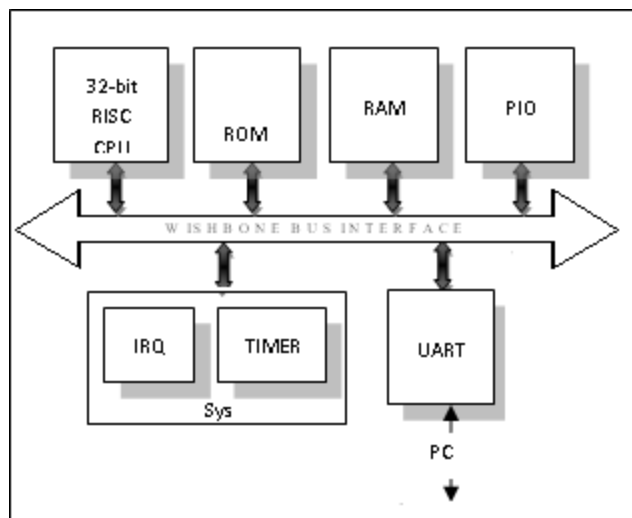


Figure: 4. 2 Hardware gateway of SOC architecture

The SOC architecture for laboratory application is shown in Figure: 4.2. This architecture utilizes processor and peripherals from the Aquarius [23] project designed by Thorn Aitch published in Open Core [4] under GPL license. The architecture consists of a 32-bit SuperH-2 [22] compatible CPU MASTER, a memory unit (RAM and ROM unit), a universal asynchronous receiver transmitter, a system controller and a parallel input output. The cores are connected to each other through WISHBONE interface with a point-to-point interconnection scheme. The next section describes about the detail specifications and structures of IP cores used for building this SOC architecture.

## 4.3 Descriptions of IP Cores

### 4.3.1 CPU

#### I. Specification

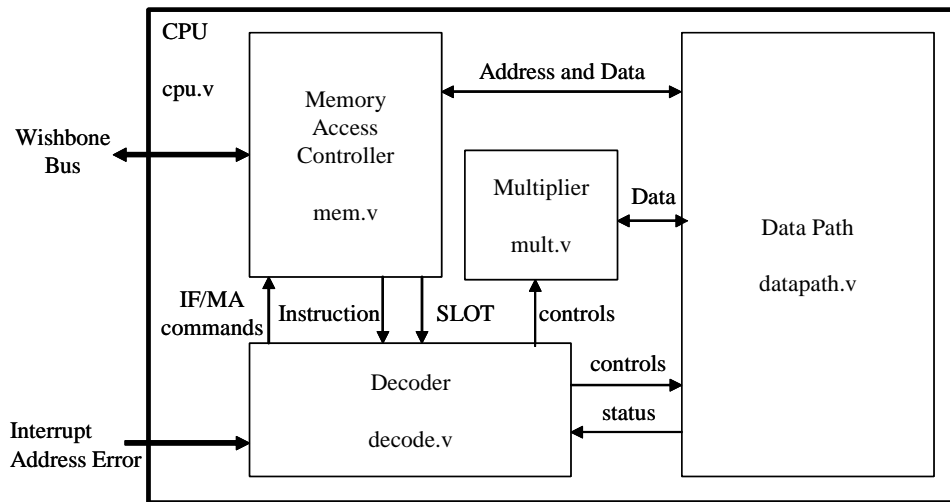
- 32-bit 5-stage pipelined CPU
- Instruction set is compatible with SuperH-2 [22 ]. (Renesas /Toshiba make)
- Instruction set supporting Power-on-reset, IRQ, NMI, address and DMA error.
- Bus interface is compatible with Wishbone.
- Sixteen 32-bit general purpose registers (R0-R16), SR, GBR, VBR, PR, PC.
- 32-bit x 16-bit multiplier and accumulator for DSP functionality.
- Low power sleep mode.

#### II. Structure of CPU

Figure: 4.3 shows the block diagram of the top modules of Aquarius CPU having Wishbone compliant bus signal. The CPU is a RISC processor based on superH-2 [22] Instruction set architecture. This synthesizable core written in Verilog and can be implemented in FPGA. This is published under GPL license in Open Core site [4]. The SuperH-2 is a 5-stage pipelined architecture with sixteen 32-bit general purpose registers. It can handle interrupt requests like non-maskable interrupt (NMI) and interrupt request (IRQ). In a lower hierarchy it comprises a memory access controller, a data path unit, a multiply unit and a decoder unit [23].

The memory access controller sends fetched instruction bit field to the decoder unit, in turn decoder unit decodes the instruction bit fields and throws many control signals for execution and data read/write access towards data path unit, multiplication unit and memory access controller. As Aquarius CPU uses a non-Harvard bus, the simultaneous instruction fetch and read/write access may create bus contention. Memory access controller handles such bus contention and informs to decoder unit. Memory access controller sense the Wishbone ACK signal and generates processor's bus cycle boundary signal termed as SLOT.

The data path unit supports sixteen general purpose registers (R0-R15), Status Registers (SR), Global Base Registers (GBR), Vector Base Register (VBR), Procedure Register (PR), and Program Counter (PC). It also provides necessary operation resources, ALU, divider, comparator, and shifter, temporary register, busses, and interfaces to/from multiply and memory access controller unit.



**Figure: 4. 3 Block diagram of CPU**

The decoder unit acts as a CPU controller and plays important role for the instruction ID stage. It issues command to memory access controller to fetch instruction and receive the instructions and decodes the instruction field and allows operations Ex, MA and WB stages toward data path, multiplication unit and memory access controller. These operations are processed with its pipeline at each slot edge until reaching to the target stage of the instruction. The decoder unit is also designed to handle pipeline stalling conditions, single and multi-cycle instructions with interrupt and address error.

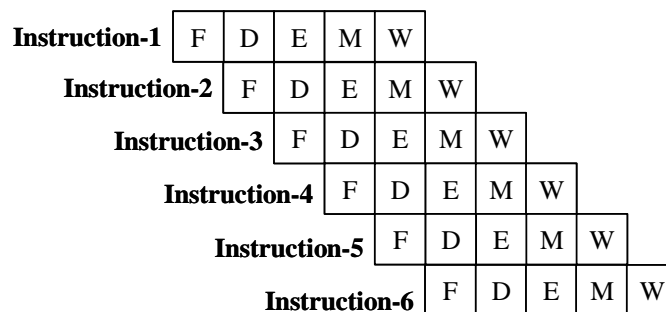
Multiply unit consists of 32-bit x 16-bit multiplier and its control circuits. It also has the multiply and accumulate registers (MACH/MACL) which hold the final results of the multiplier. A 16 bit x 16 bit multiply operation is executed in one clock cycle and a 32 bit x 32 bit multiply operation is done in two clock cycle. The CPU input output signals are given in Table: 4.1.

Class	Signal Name	Direction	Meaning	Notes
System Signals	CLK RST	Input Input	System clock Power On Reset	
Wishbone Bus Signals	CYC_O STB_O ACK_I ADR_O[31:0] DAT_I[31:0] DAT_O[31:0] WE_O SEL_O[3:0] TAG0_I (IF_WIDTH)	Output Output Input Output Input Output Output Output Input	Cycle Output Strobe Output Device Acknowledge Address Output Read Data Write Data Write Enable Byte Lane Select Fetch Width	
Hardware Event (interrupt)	EVENT_REQ_I[2:0] EVENT_INFO_I[11:0] EVENT_ACK_O	Input Input Output	Event Request Event Information Event Acknowledge	
SLEEP	SLP	Output	Sleep Pulse	

**Table: 4. 1 Input Output Signals of CPU**

### Pipeline stage

All the instructions in the CPU are executed in pipeline stages as shown in the Figure: 4.4. The CPU supports five stages of pipelining. These are *instruction fetch*, *decode*, and *execute memory access and write back* [23].



**Figure: 4. 4 Pipeline stages of CPU**



**1) IF : Instruction fetch (F)**

In this stage CPU fetches instruction code from memory. Depending upon the bus width, the IF stage fetch the number of instructions. The instruction length is 16 bit. So in a 32-bit bus width, IF stage fetches 2 instructions.

**2) ID: Decode(D)**

The ID stage controls the whole CPU operation by decoding fetched instructions. The ID stage issues many control signals to perform Ex, MA and WB operations towards data path, and memory access controller units. If multiplication operation is required, it activates the multiplication unit. The signals shift to each stage in pipeline and activates the corresponding each stage. ID also issues IF stage for next instruction and IF forward new instruction to the corresponding ID stages. It also control the operation during hardware event exceptions.

**3) EX: Execute**

After getting control from the ID stage, the EX stage performs register-register operation or calculate address for next MA stage. This is done by data path unit. Executions of multiplication commands are handled by multiplier unit.

**4) MA: Memory Access**

If memory access gets control signal by ID stage, then the MA reads/writes data to/from memory. Due to non-Harvard bus used in the CPU, the MA has the highest priority than IF stage to avoid bus contention.

**5) WB: Write Back**

If WB is invoked by ID stage, then WB writes back the memory read data to the registers (R0-R16).

**Pipeline stages of instructions**

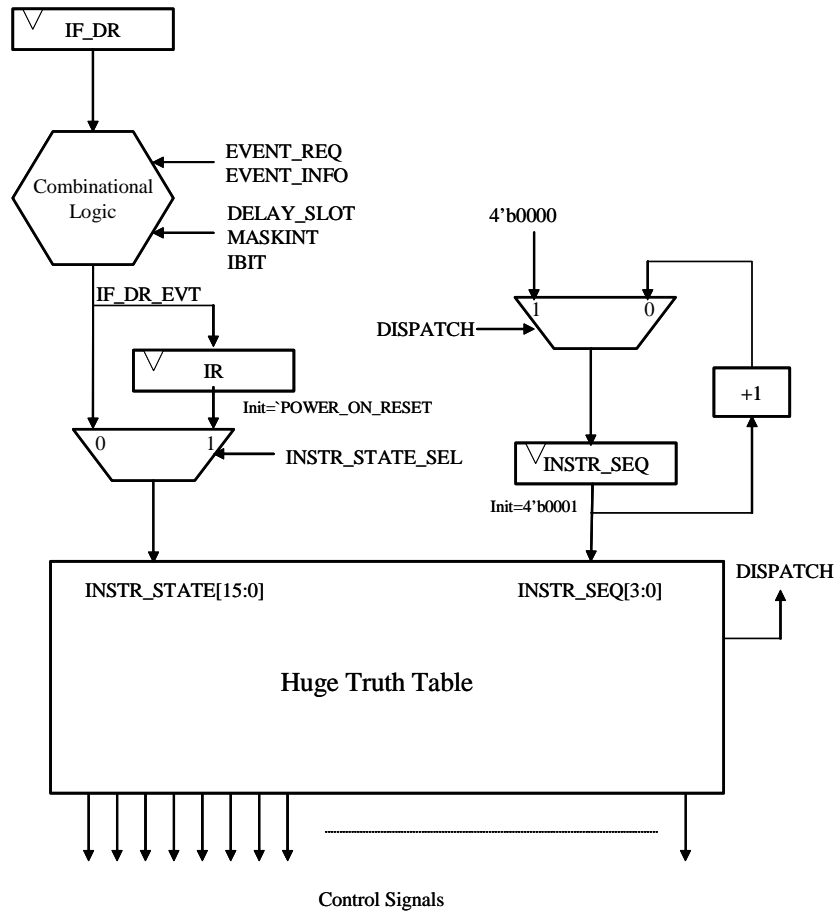
Figure: 4.5 shows the pipelining stages of some typical instructions. It shows all instructions do not always need 5 stages for execution. The register-register operation requires 3 stages; IF, ID and EX. All the operation register read, write, ALU operation, executed in EX stage. The instruction for storing into memory requires 4 stages; IF, ID,



During the last sequence of power on reset, the IF stages of first and second instructions are issued by the last two decode stages in the exception sequence. Similarly the IF stages of all followed instructions are issued and the corresponding ID stage get next instruction from IF stage and keeps the process continuing.

**Decoder Unit**

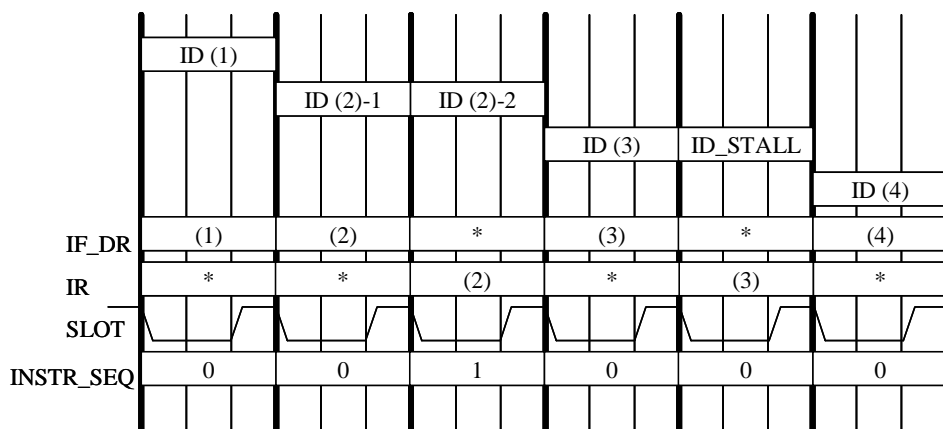
Figure: 4.7 show the structure of decoder unit. It consists of a huge truth table that takes input from INSTR\_STATE and INTR\_SEQ and generates all control signals for other blocks of CPU. The INSTR\_STATE contains the instruction code that is processed in the decoder to generate control signals. The initial reset of the INSTR\_STATE is get to power on reset (16'hf700). The INSTR\_STATE [15:0] basically get the data from the fetched instruction code IF\_DR. But if any interrupt or hardware exception event is detected, the INSTR\_STATE is replaced by IR\_DR\_EVT signal created by corresponding exception code EVENT\_REQ [2:0] and EVENT\_INFO [11:0].



**Figure: 4.7 Block Diagram of Decoder Unit**

DELAY\_SLOT, MASKINT, IBIT are the controls for masking interrupt or hardware exception. The decoder requests for instructions, memory controller updates IF\_DR irrespective of instruction sequence and latch the values of IF\_DR in IR register, if CPU needs to handle multiple-cycles instructions such as memory waits and pipeline stalls. The default value of INSTR\_SEQ at power on reset is 4'b0001 else it gets a value of 4'b000, the multi cycle instruction increments INSTR\_SEQ to perform multiple pipeline operations. IF\_DR\_EVT and INSTR\_SEQ resets to zero.

Figure: 4.8 show the basic operation of ID stage. At system reset INSTR\_SEQ is zero, when IF\_DR get an instruction ID (1) stage creates the control signal by using the truth table and corresponding control signals sent to the other units of CPU. Then IF\_DR is updated by second instruction ID (2) which is a multi-cycle instruction. Hence INSTR\_SEQ becomes '1', the ID (2) stage will be completed in multiple cycle and during this IF\_DR is latched in IR. After decoding of each instruction slot asserted to indicate the completion of pipeline bus cycle. The third instruction creates conflict and ID (3) stalls and no operation is done in this stage. Finally the fourth instruction is decoded as shown in Figure: 4.8.

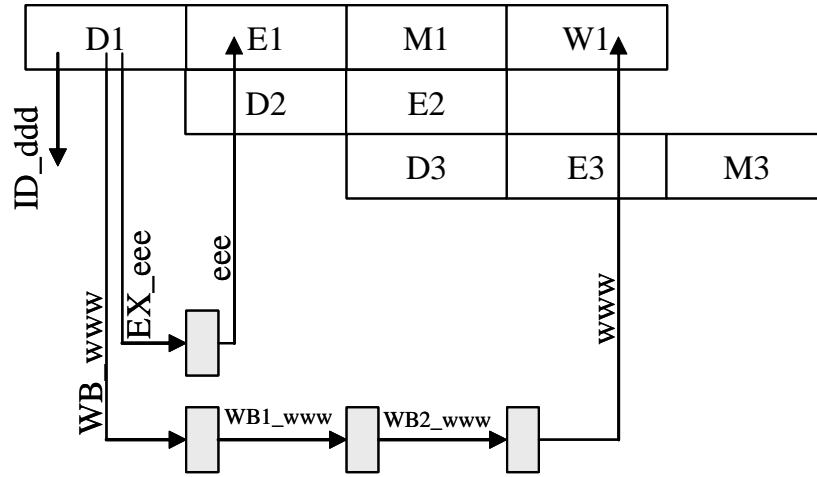


**Figure: 4. 8 Basic Operation of ID Stage**

### Control Signal Shifting

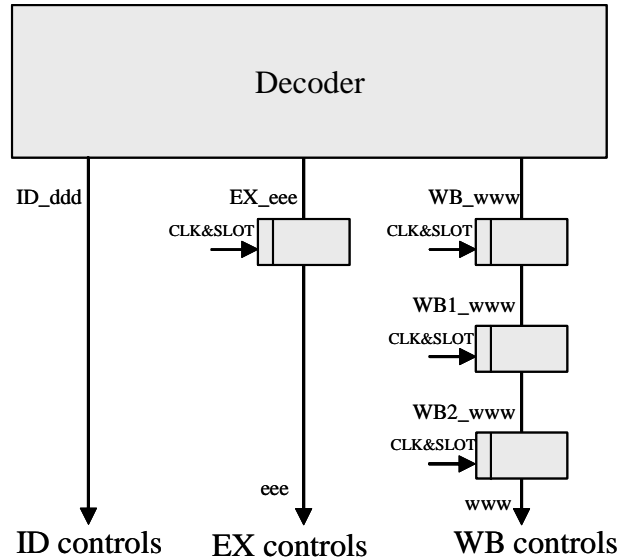
The decoder unit generates many control signals by huge truth table to control other blocks of the CPU. These signals control the operation of ID stage, EX, MA and WB

stage. In order to perform corresponding operation the signal should be shifted to EX, MA or WB stage.



**Figure: 4. 9 Shifting of Control Signal**

Figure: 4.9 shows the shifting of control signals and Figure: 4.10 shows the circuits for shifting operation to be performed in HDL level by using flip flops. With synchronous to clock pulse and slot edge the decoder generated EX signals updated to EX stage. EX stage decides the MA controls by issuing MA signals and deciding the address of memory and data to be written in the MA stage. For WB operation 3 stages of flip flops are used.



**Figure: 4. 10 Circuit diagram for Shifting Operation**

### Pipeline Stall

The pipeline stalling can happen due to following reason:

- Wait states on Instruction fetch (IF) or Data access(MA),
- Conflict IF and MA
- Multiplication contention and
- Register contention.

Memory access is synchronized to all pipeline slots. If there is no memory access or memory access without wait state then SLOT=1, indicates the pipeline do not stall. However, if there is memory access with wait states then SLOT=0 and pipeline stalls. This can be controlled by clock gating the SLOT signal. Simultaneous access of IF and MA may create conflicts and make the pipeline stalls. Memory access controller informs pipeline stalling to decoder by a signal IF\_STALL. Similarly multiplication may create pipeline stall, and MAC\_STALL signal is used to inform decoder about the stalling.

Some memory load instruction may use same register for loading data. As an example MOV.L@R0, R1 and ADD R1, R2 both creates control signals to write back to R1 simultaneously. This type of conflicts indicated to decoder by REG\_CONF signal. Decoder uses the circuit given in Figure: 4.11 to identify the register conflict. Hence, R1 conflicts and ID stage of ADD creates stall operation.

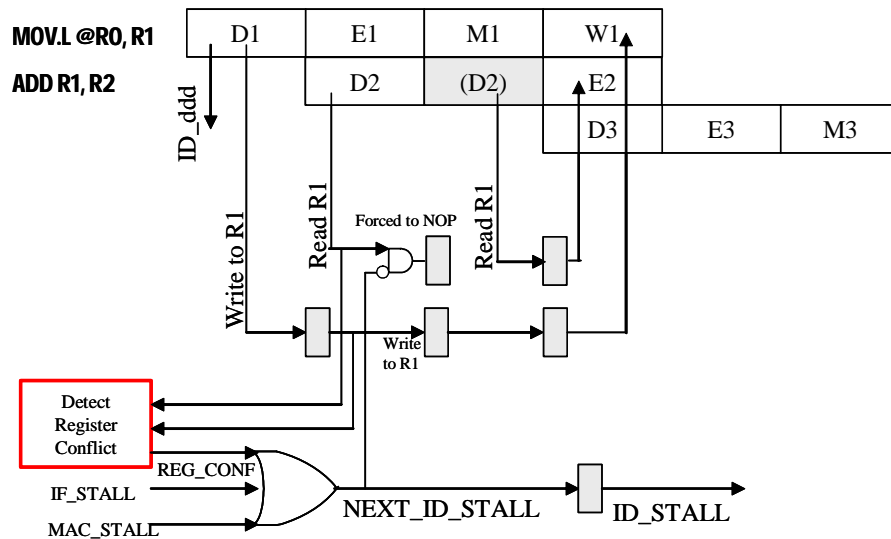


Figure: 4. 11 Circuit of Detecting Register Conflict

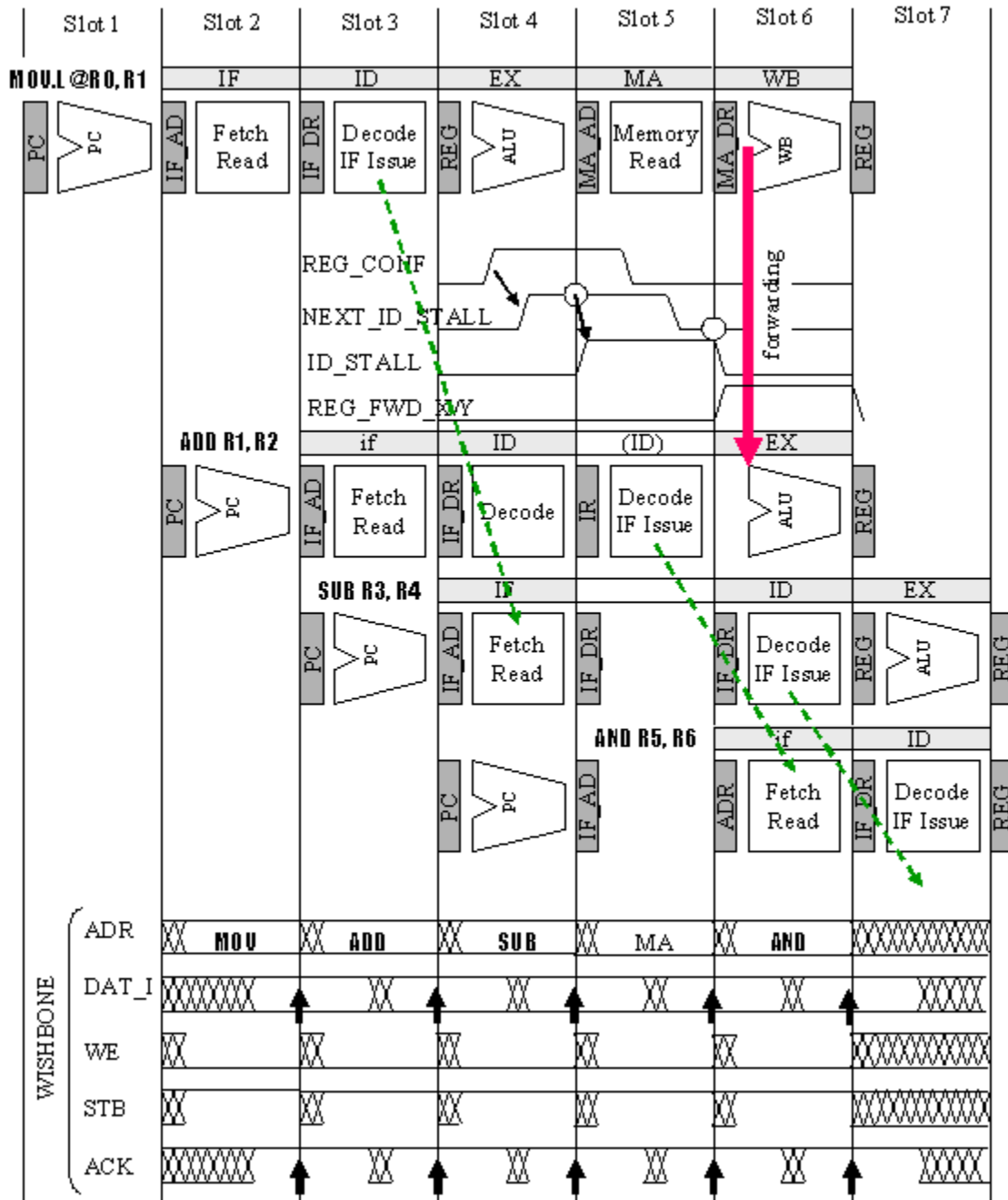


Figure: 4. 12 Pipeline Control during Memory Load Contention

In Figure 4.12 IF\_STALL, MAC\_STALL and REG\_CONF are OR with each other to create the NEXT\_ID\_STALL. NEXT\_ID\_STALL high indicates the ID continues by at least next slot. When NEXT\_ID\_STALL becomes '1', it forces the ID stage to NOP, means no execution of instruction will be done in this ID stage. NEXT\_ID\_STALL is '1' indicates ID STALL will be '1' in the next slot.

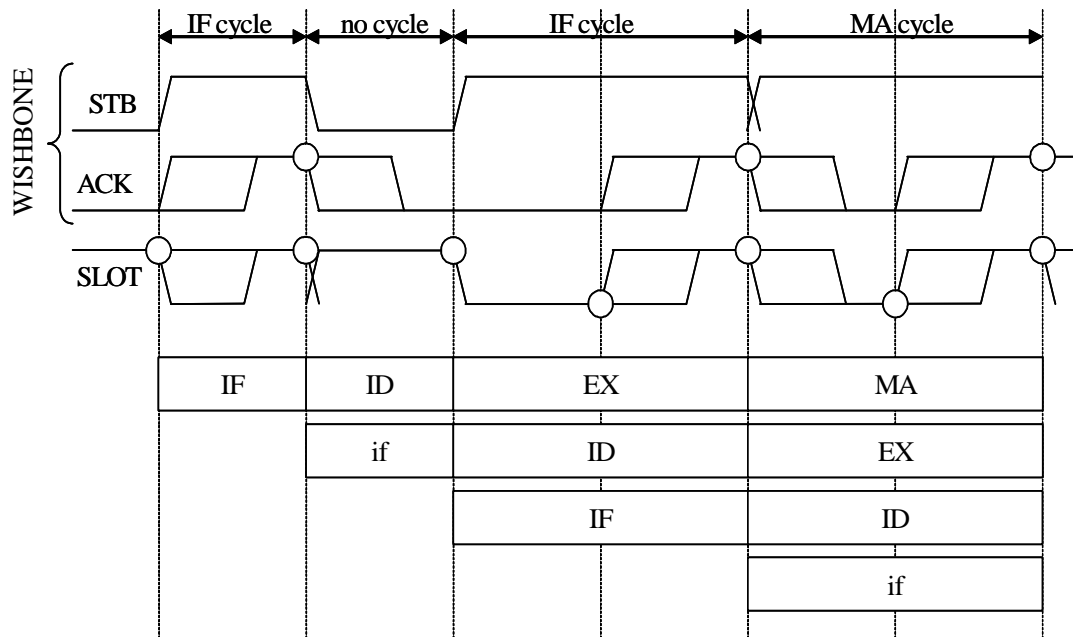
If any of these signals are asserted then the ID stalls. The pipeline control during memory load contention is shown in figure 4.11. In the slot4 there is a register contention due to MOV and ADD instructions which makes REG\_CONF high. It makes NEXT\_ID\_STALL high and in next slot ID\_STALL becomes high. The ID at slot4 is stalled and continued in slot5. The slot6 forwards write back data of MOV.L to EX stage of ADD. This is called Register forwarding. The corresponding Wishbone bus transaction is also shown in the Figure: 4.12.

**Memory Access Controller Unit**

Memory Access Controller sends the fetched instructions to the decoder for decoding operations. This operations is performed by Instruction Fetch cycle (IF) and memory access cycle (MA). The CPU bus cycle width is decided by SLOT signal which is generated by the Memory Access Cycle. These bus cycle operations are described in this section.

**Wishbone ACK and CPU's SLOT**

SLOT signal created in memory access control unit follows the Wishbone's ACK signal and indicates the pipeline slot edges.



**Figure: 4.13 Wishbone ACK and CPU's SLOT**



To control the pipeline stall from MA cycle all the flip flop in the CPU are gated with SLOT signal. Figure 4.13 shows the wave form of the SLOT is similar to the ACK, except that the SLOT is asserted if no memory access cycle is encountered. During memory accessed operation the SLOT signal wave form follows to ACK signal.

### **Instruction Fetch Cycle**

The decoder unit requests instruction fetch to the memory access control unit by issuing IF\_ISSUE signal. The instruction fetch starts in the next slot after assertion of IF\_ISSUE. During this time the IF\_AD [31:0] and IF\_JP should be valid state. The address value of the fetched instruction is given by IF\_AD[31:0].

Figure 4.14 shows the waveform of an instruction fetch cycle. Initially when IF\_ISSUE is asserted, the IF\_AD contains the address of second instruction IF(2). At the next slot the instruction fetch starts and the value is latched to IF\_DR. WISHBONE Signal initiates a single read cycle reflects the data transfer by asserting the STB signal. ADR contains the address of IF(2). DAT\_I read the IF(2) value and latch this value in IF\_DR of decoder for decoding. The ACK shows the termination of this cycle.

If instruction fetch is created by jump or branch instruction, the fetch should access the memory even if the internal fetch buffer is valid. Hence jumping operation should inform such state to memory access control unit by asserting IF\_JP and IF\_ISSUE at a time. IF\_DR [15:0] is valid at the next slot of corresponding IF cycle. The second assertion in IF\_ISSUE in the Figure: 4.14 reflect the same situation. Due to branch instruction IF\_DR gets IF(3) after second IF cycle is completed.

### **Memory Access Cycle**

Similar to instruction fetch, MA starts at next slot of MA\_ISSUE becomes high. Some attribute information such as access size MA\_SZ [1:0], access direction MA\_RW, address MA\_AD [31:0] and if write access, write data MA\_WD [31:0] should be valid when MA\_ISSUE is high.

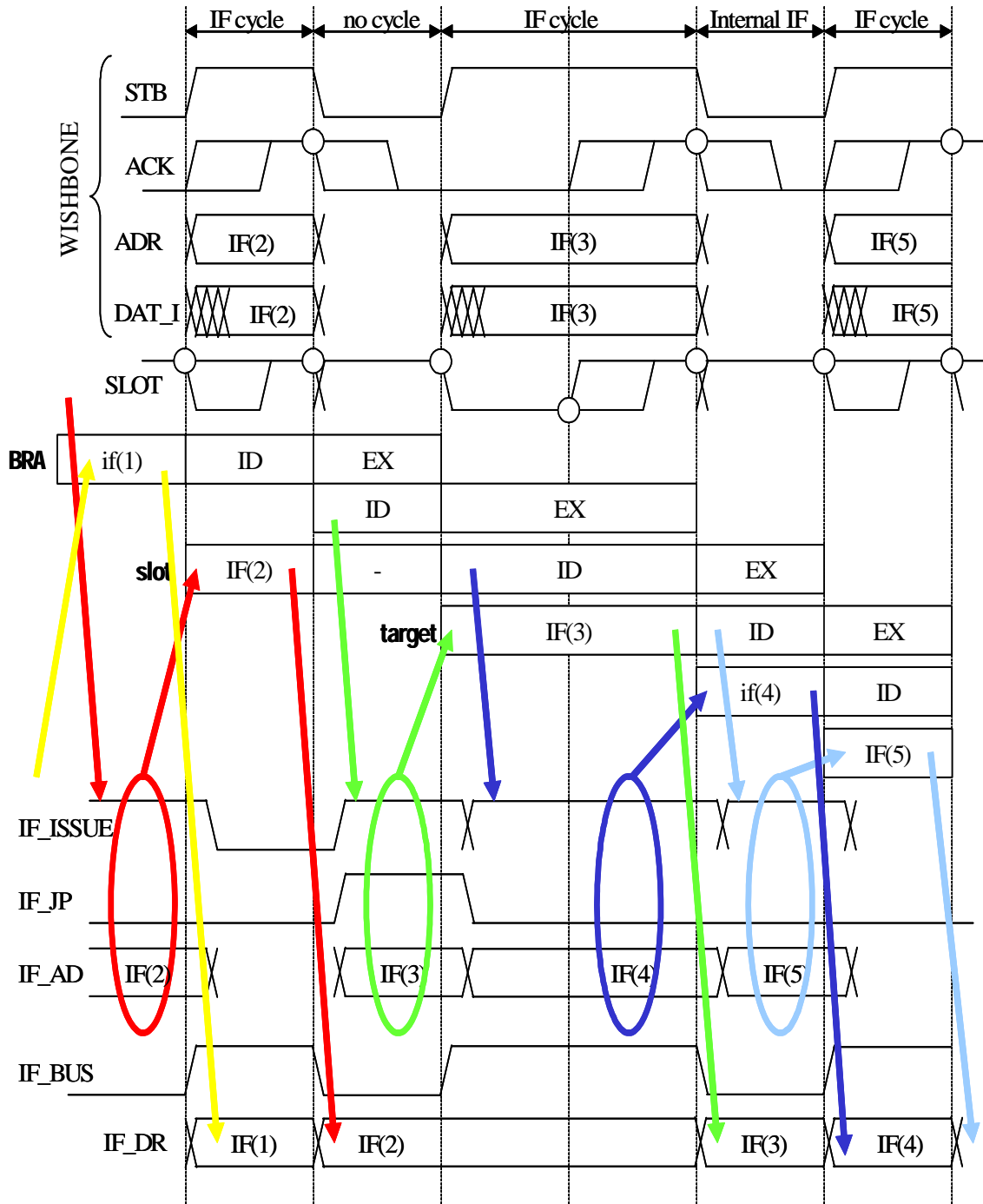


Figure: 4. 14 Instruction Fetch Cycle

Figure: 4.15 shows the memory access cycle where during EX stage MA is invoked due to assertion in MA\_ISSUE to complete the load instruction n. During this time the attribute information MA\_SZ, MA\_AD are valid. The EX stage calculate the address of memory access, places it in ADR, and invokes the memory access as shown in DATI Wishbone signals.

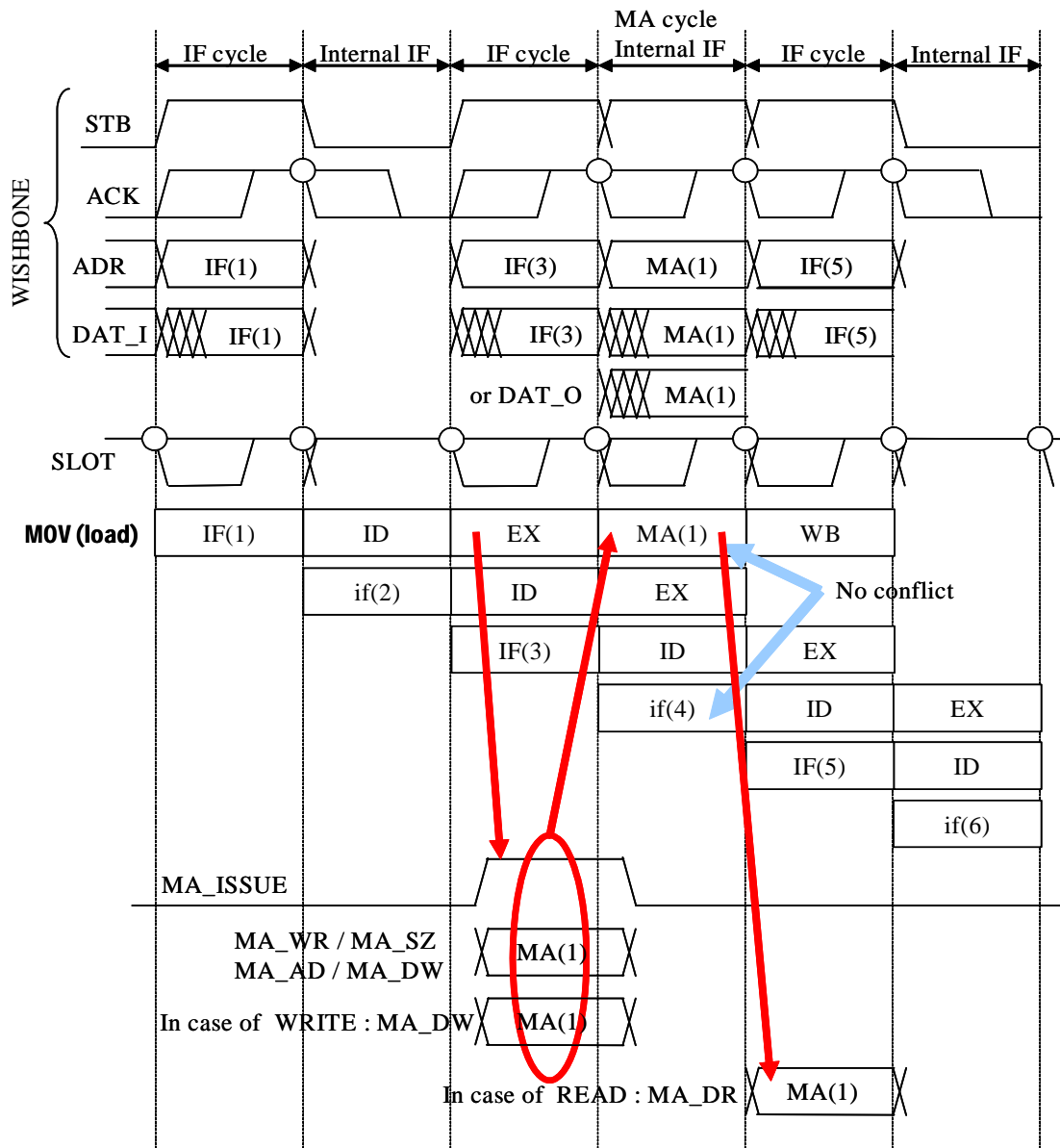
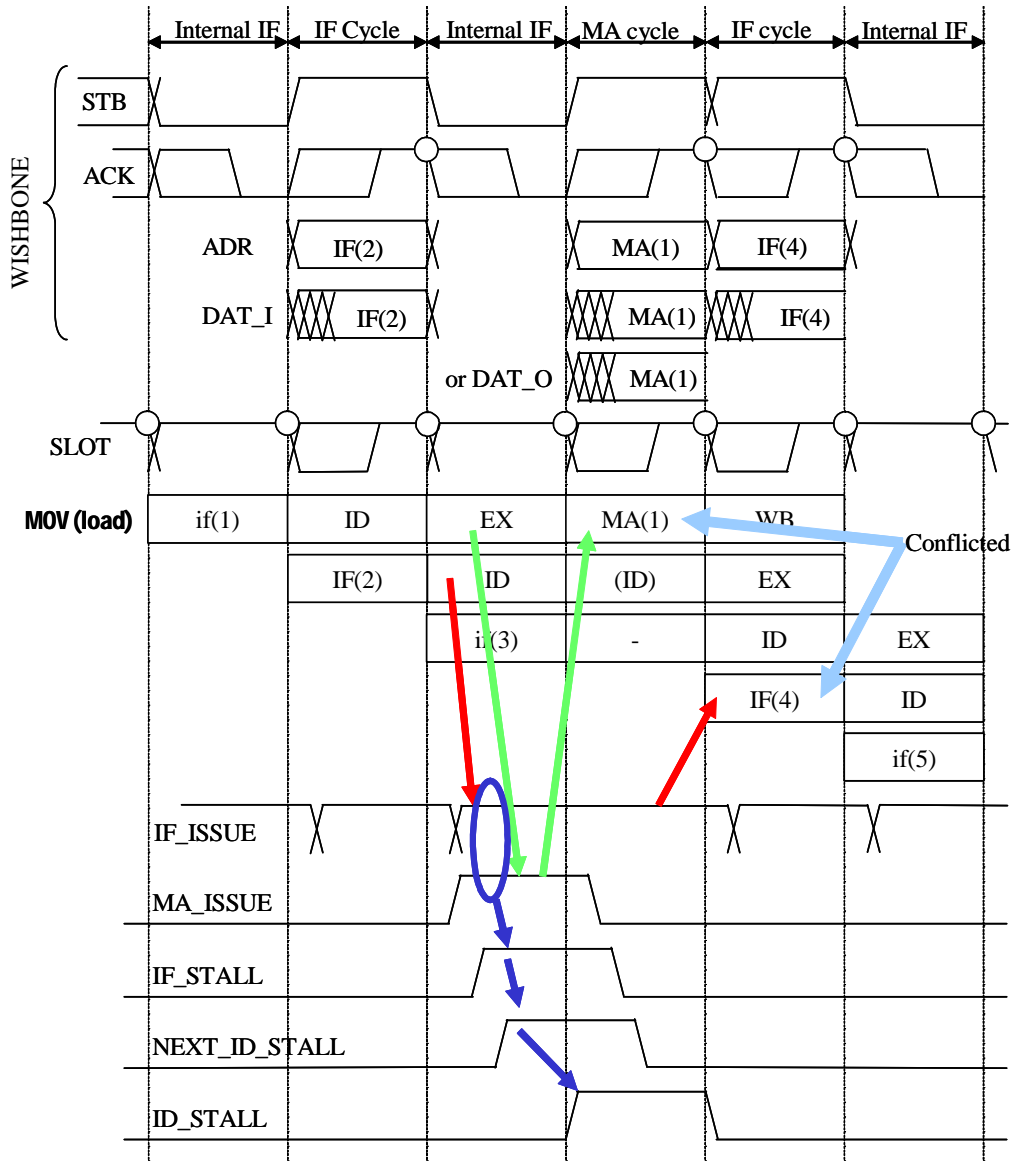


Figure: 4. 15 Memory Access Cycle

For a memory write operation then MA\_DW should have valid data when MA\_ISSUE is high and for memory read operation MA\_DR, should be valid in the next slot of MA cycle.

**IF\_MA conflict**

When IF\_ISSUE and MA\_ISSUE are asserted at the same time, IF\_MA is conflicted. This happens when IF gets an instruction from external memory. When IF\_MA conflicts, the memory access signal asserts IF\_STALL signal and gives information to the decoder unit.



**Figure: 4. 16 IF\_MA Conflict**

The MA cycle has a priority over IF cycle during IF\_MA conflict. Figure: 4.16 shows when IF\_ISSUE and MA\_ISSUE are asserted simultaneously, IF\_STALL signal goes high. The decoder makes the NEXT\_ID\_STALL high. ID\_STALL becomes high in the next slot. As shown in Wishbone signals the MA cycle MA (1) is started first and after completion, memory access control unit begins IF cycle.

**Read Modify Write Cycle (TAS.B instruction)**

Read modify write cycle performs read and write operation in a single cycle. During this operation cycle signal CYC is asserted for the read and write operations and does not allow any bus-arbitration. TAS.B instruction in SuperH-2 allows read-modify-write cycle. The operation is forced by decoder towards memory access control unit by asserting KEEP\_CYC signal high. Figure: 4.17 illustrate the timing diagram where the assertion in MA\_ISSUE and KEEP\_CYC signal indicates the starting of a read-modify-write cycle. During this period CYC remains high until the completion of read-write operations.

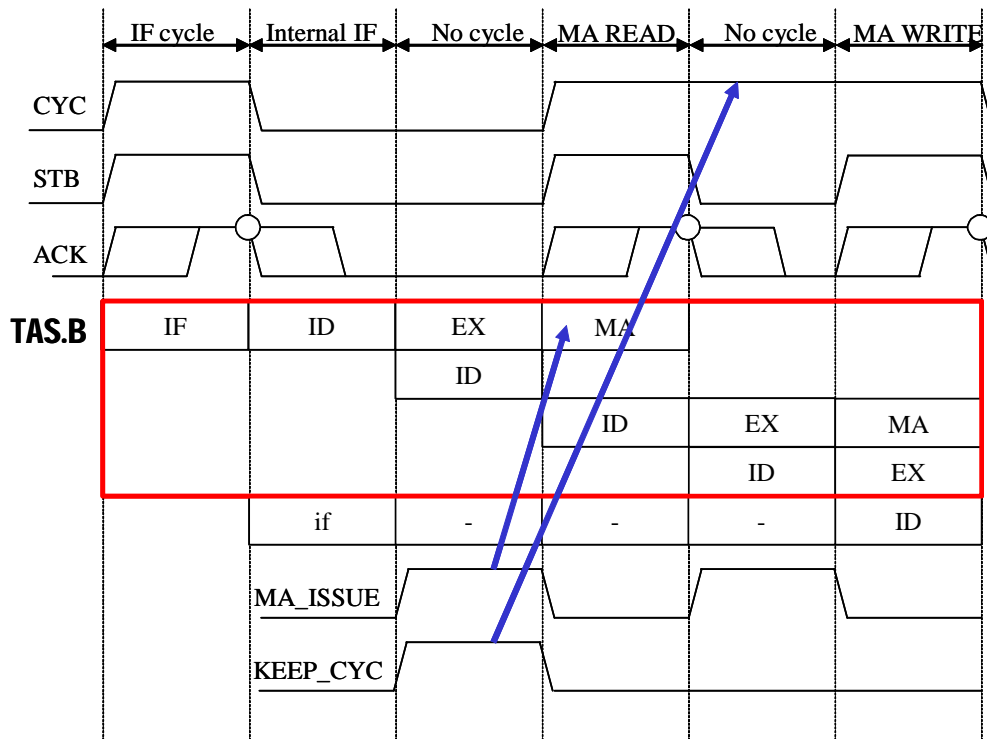


Figure: 4. 17 Read modify write cycle

### Data Path Unit

The data path of the CPU performs the operations like ALU, Comparator, shifter, and divider. The block diagram of the data path of the CPU is given in Figure: 4.18. The data path consists of 32-bit general purpose registers (R0-R15). It also has four internal buses, X-bus, Y-bus, Z-bus and W-bus. All these buses can handle 32 bit data. X-bus and Y-bus are used to handle data from each register source and such as (R0-R15), PR, PC, Temp, Const, SR, VBR and GBR. Z-bus is used to handle data from results of ALU or shifter. The data from memory load or data to be written back to registers use W-bus as path for data transfer. The register forwarding is possible by directing paths from W to Y buses. As the data path unit is fully controlled by the decoder unit, no state machines are used in designing the data path unit. The status registers of data path unit also supports T bit, Q bit and M bit. These bits are status bits for ADDC/ SUBC/ADDV/SUVV, SETT, COMPResult etc. Data path unit also supports a set of interfaces to/from memory access controller unit and multiplier unit to perform data transaction between them.

### Multiplier Unit

Multiply unit consists of 32-bit x 16-bit multiplier and its control circuit. Figure 4.19 shows the block diagram of the multiplier unit. A 32-bit x 32-bit multiplication is done in two clock cycle and a 16-bit x 16-bit multiplication is executed in one cycle. The block diagram consists of two latches M1, M2 and 32-bit x 16-bit multiplier and 32-bit Adder. Two multiply and accumulator registers MACH and MACL are used to hold the final results. The decoder unit sends two kinds of multiplication command to multiplication unit. MULCOM1 is one of the signal which is used for latching input data MACIN1[31:0] and MULCOM2[7:0] is the another one which latch the other input data MACIN2[31:0] and operation class. The MULCOM2(7) means latch signal. MULCOM2[6:0] is {INSTR-STATE[14:12], INSTR-STATE[3:0]}. MULCOM2[7] is zero indicates NOP.

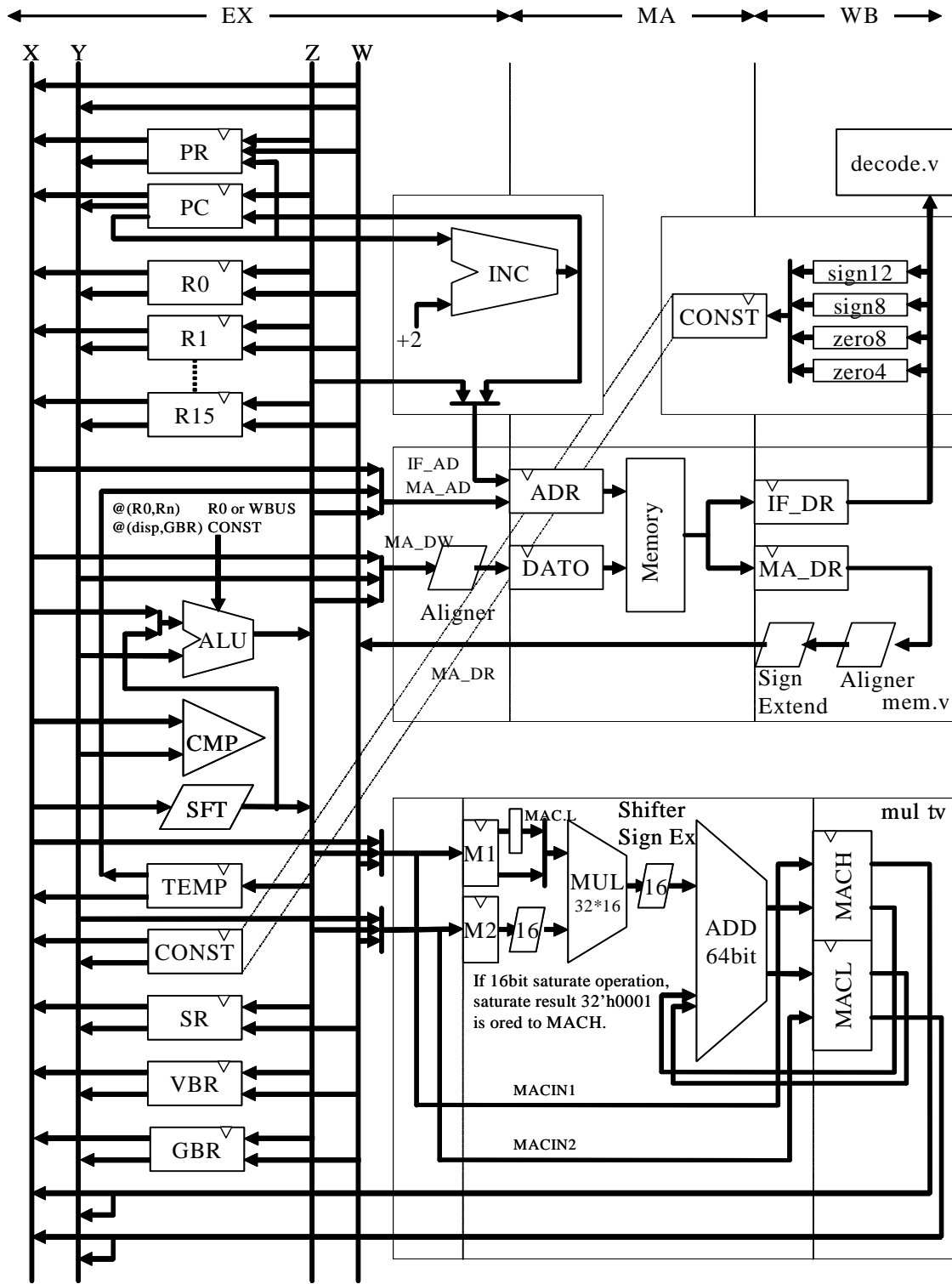


Figure: 4. 18 Block Diagram of Data Path Unit

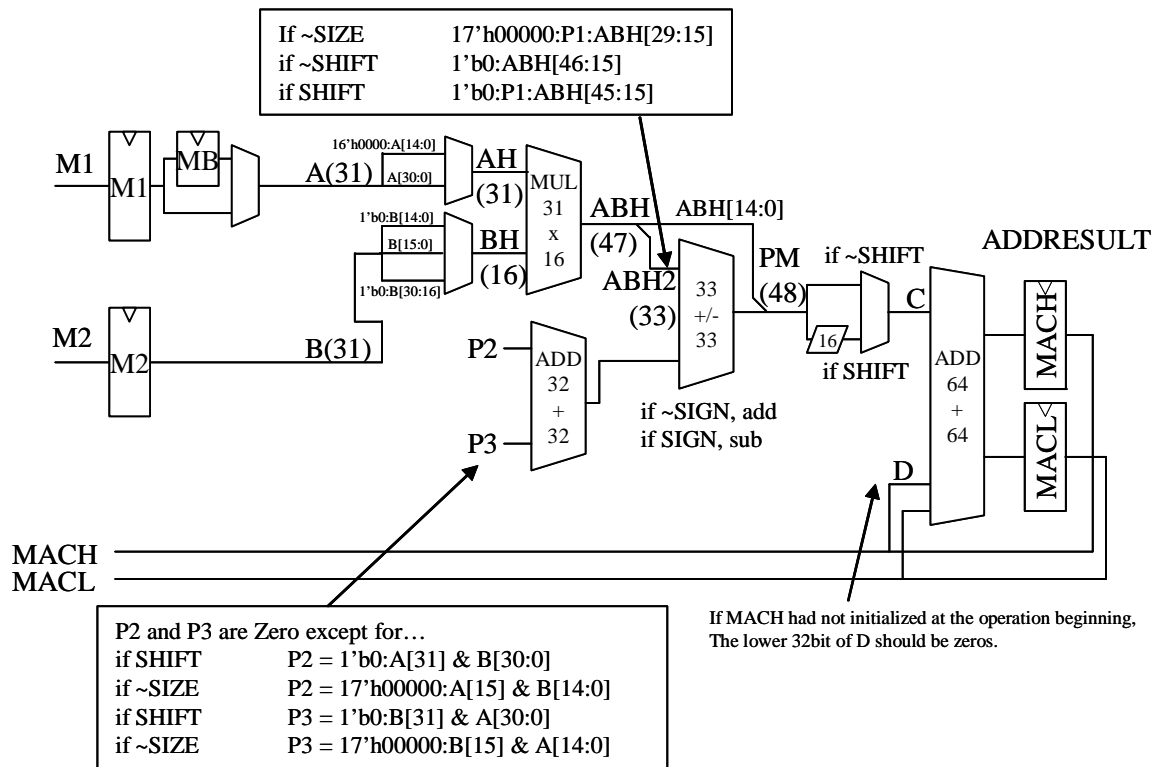


Figure: 4. 19 Block Diagram of Multiplier Unit

### 4.3.2 PIO: Parallel Input and Output

#### I. Specification

- 32-bit Input registers.
- 32-bit Output registers.

#### II. Structure of PIO

The **Parallel I/O (PIO)** has two 32-bit registers to control Port Pins. There are 4 byte-size registers for PORT Output and 4 byte-size registers for PORT Input. In order to access PORT input the registers have to read and to access PORT outputs the registers have to be written. Each registers can be accessed by byte, word or long operand size. The data is written to the write operation is done in the positive edge of clock pulse. During power on reset, PORT output registers are reset to 0x00. The PIO registers with its address are shown in Figure: 4.20. Table 4.2 shows the input output signals of the PIO.



Class	Signal Name	Direction	Meaning	Notes
System Signals	CLK	Input	System clock	
	RST	Input	Power On Reset	
Wishbone Bus Signals	CE	Input	Chip Select (Module Select)	STB
	WE	Input	Write Enable	
	SEL[3:0]	Input	Byte Lane Select	
	DATI[31:0]	Input	Data Input (Write Data)	
	DATO[31:0]	Output	Data Output (Read Data)	
PORT	PI[31:0]	Input	Port Input	
	PO[31:0]	Output	Port Output	

**Table: 4. 2 Input Output Signals of PIO**

**[PORT Output] Address=0xABCD0000 W only reserved**

31(7)	30(6)	29(5)	28(4)	27(3)	26(2)	25(1)	24(0)
reserved	reserved	reserved	reserved	reserved	reserved	reserved	reserved

**[PORT Output] Address=0xABCD0001 W only KEYYO (KEY Matrix Y-axis Output)**

23(7)	22(6)	21(5)	20(4)	19(3)	18(2)	17(1)	16(0)
reserved	reserved	reserved	KY4	KY3	KY2	KY1	KY0

**[PORT Output] Address=0xABCD0002 W only LCDCON (LCD Control Output)**

15(7)	14(6)	13(5)	12(4)	11(3)	10(2)	9(1)	8(0)
reserved	reserved	reserved	reserved	reserved	E	R/W	RS

**[PORT Output] Address=0xABCD0003 W only LCDOUT (LCD Write Data Output)**

7(7)	6(6)	5(5)	4(4)	3(3)	2(2)	1(1)	0(0)
DW7	DW6	DW5	DW4	DW3	DW2	DW1	DW0

**[PORT Input] Address=0xABCD0000 R only reserved**

31(7)	30(6)	29(5)	28(4)	27(3)	26(2)	25(1)	24(0)
reserved	reserved	reserved	reserved	reserved	reserved	reserved	reserved

**[PORT Input] Address=0xABCD0001 R only KEYXI (KEY Matrix X-axis Input)**

23(7)	22(6)	21(5)	20(4)	19(3)	18(2)	17(1)	16(0)
reserved	reserved	reserved	KX4	KX3	KX2	KX1	KX0

**[PORT Input] Address=0xABCD0002 R only reserved**

15(7)	14(6)	13(5)	12(4)	11(3)	10(2)	9(1)	8(0)
reserved	reserved	reserved	reserved	reserved	E	R/W	RS

**[PORT Input] Address=0xABCD0003 R only LCDIN (LCD Read Data Input)**

7(7)	6(6)	5(5)	4(4)	3(3)	2(2)	1(1)	0(0)
DR7	DR6	DR5	DR4	DR3	DR2	DR1	DR0

**Figure: 4. 20 Registers of PIO**

### 4.3.3 Serial Input Output (UART)

#### I. Specification

- 8-bit, 1 stop-bit, non-parity serial communication device
- Wishbone compatible interface
- 4-byte transmit and receive FIFO
- Handshaking signals CTS and RTS

#### II. Structure of PIO

The **UART** is a simple asynchronous serial communication device from the Open Core site and it has been made wishbone compliant. It is an 8-bit, 1 stop-bit, non-parity serial communication device. In the lower module it has a receiver unit, a transmitter unit and a baud rate generator. The transmitter unit is used to take bytes of data and send it serially to the host and at the destination receiver unit is used to process the bits into complete bytes. A 4 byte transmit and receive FIFO is used to process and store the data at transmitter and receiver end. It has two baud rate registers UARTBGO, UARTBG1 to determine proper baud rate to communicate with PC. Figure: 4.21 show the registers and its address which can control the functionality of the UART. Two band rate registers. During power on reset these registers are reset to zero.

Class	Signal Name	Direction	Meaning	Notes
System Signals	CLK RST	Input Input	System clock Power On Reset	
Wishbone Bus Signals	CE WE SEL[3:0] DATI[31:0] DATO[31:0]	Input Input Input Input Output	Chip Select (Module Select) Write Enable Byte Lane Select Data Input (Write Data) Data Output (Read Data)	STB
UART	RXD TXD CTS RTS	Input Output Input Output	Receive Serial Data Transmit Serial Data Clear To Send Request To Send	

**Table: 4. 3 UART Input Output Signals**

UARTCON and UARTRXD/TXD can be accessed by byte operation and size. UARTCON has 2 flags; TXF and RXE. When transmitter buffers are full the TXF flag is set, if TXF is clear transmit data can be written to the buffers. UARTRXD and UARTTXD are the receive buffer and transmit buffer registers, which have same address. UARTRXD is accessed during read operation and UARTTXD is accessed during write operation.

<b>[UART] Address=0xABCD0100      R/W    UARTBG0 (Baud rate Generator Div0)</b>							
31(7)	30(6)	29(5)	28(4)	27(3)	26(2)	25(1)	24(0)
B07	B06	B05	B04	B03	B02	B01	B00
<b>[UART] Address=0xABCD0101      R/W    UARTBG1 (Baud rate Generator Div1)</b>							
23(7)	22(6)	21(5)	20(4)	19(3)	18(2)	17(1)	16(0)
B17	B16	B15	B14	B13	B12	B11	B10
<b>[UART] Address=0xABCD0102      R only    UARTCON (TXF=full_o, RXE=empty_o)</b>							
15(7)	14(6)	13(5)	12(4)	11(3)	10(2)	9(1)	8(0)
reserved	reserved	Reserved	reserved	reserved	reserved	TXF	RXF
<b>[UART] Address=0xABCD0103      R only / UARTRXD, W only / UARTTXD</b>							
7(7)	6(6)	5(5)	4(4)	3(3)	2(2)	1(1)	0(0)
TR7	TR6	TR5	TR4	TR3	TR2	TR1	TR0

**Figure: 4. 21 UART Registers and its address**

Table 4.4 shows some examples of baud rate setting.

Baud Rate [bps]	f (CLK) [MHz]	UARTBG0	UARTBG1
1200	20	0x12 (18)	0xCF (207)
2400	20	0x12 (18)	0x67 (103)
4800	20	0x12 (18)	0x33 (51)
9600	20	0x12 (18)	0x19 (25)

**Table: 4. 4 Baud Rate Settings Example**

### 4.3.4 System Controller (SYS)

#### I. Specification

- Hardware Event Exception such as NMI, IRQ, CPU Address Error, DMA Address Error, Manual Reset
- SLEEP and Low Power Control.

## II. Structure of SYS

The **System Controller (SYS)** is used to generate and emulate exceptions of hardware event like NMI, IRQ and CPU address error and manual reset. It has 12 bit Interval Timer to generate IRQ. It also controls the priority level among the requests of hardware exception. The SYS has two 32-bit length registers INTCTL and BRKADR. The both registers can only accessed by long word operand size. The INTCTL is reset to 0x00000FFF and the BRKADR is reset to 0x00000000 when power on reset. It also controls the priority level of the hardware exception. The system controller detects address error by Wishbone bus signals. Figure 4.22 shows the system controller registers and its address. The input output signals are shown in Table 4.5.

Class	Signal Name	Direction	Meaning	Notes
System Signals	CLK_SRC	Input	System clock Source	
	CLK	Output	CLK , which stops at SLEEP	
	SLP	Input	SLEEP request from CPU	
	WAKEUP	Input	Wakeup Request	
	RST	Input	Power On Reset	
Wishbone Bus Signals	CE	Input	Chip Select (Module Select)	STB
	WE	Input	Write Enable	
	SEL[3:0]	Input	Byte Lane Select	
	ACK	Input	Bus Acknowledge	
	DATI[31:0]	Input	Data Input (Write Data)	
	DATO[31:0]	Output	Data Output (Read Data)	
	STB	Input	Strobe (Bus monitor to BRK)	
ADR[31:0]	Input	Address (Bus monitor to BRK)		
Hardware Events	EVENT_REQ[2:0]	Output	Event Request	
	EVENT_INFO[11:0]	Output	Event Information (IRQ)	
	EVENT_ACK	Input	Event Acknowledge from CPU	

**Table: 4. 5 System Controller Input Output Signals**

[SYS] Address=0xABCD0200 R/W INTCON (Interrupt Control)

31	30	29	28	27	26	25	24
E_NMI	E_IRQ	E_CER	E_DER	E_MRS	reserved	TMRON	BRKON
23	22	21	20	19	18	17	16
ILVL3	ILVL2	ILVL1	ILVL0	IVEC7	IVEC6	IVEC5	IVEC4
15	14	13	12	11	10	9	8
IVEC3	IVEC2	IVEC1	IVEC0	TMR11	TMR10	TMR9	TMR8
7	6	5	4	3	2	1	0
TMR7	TMR6	TMR5	TMR4	TMR3	TMR2	TMR1	TMR0

[SYS] Address=0xABCD0204 R/W BRKADR (Break Address)

31	30	29	28	27	26	25	24
ADR31	ADR30	ADR29	ADR28	ADR27	ADR26	ADR25	ADR24
23	22	21	20	19	18	17	16
ADR23	ADR22	ADR21	ADR20	ADR19	ADR18	ADR17	ADR16
15	14	13	12	11	10	9	8
ADR15	ADR14	ADR13	ADR12	ADR11	ADR10	ADR9	ADR8
7	6	5	4	3	2	1	0
ADR7	ADR6	ADR5	ADR4	ADR3	ADR2	ADR1	ADR0

**Figure: 4. 22 System Controller (SYS) Registers**

INTCTL: Interrupt Control Register

- E\_NMI**                      Emulate NMI. Write only bit. Read 0 only.

When you write 1, NMI exception sequence will start.
- E\_IRQ**                      Emulate IRQ. Write only bit. Read 0 only.

When you write 1, IRQ exception sequence will start if the IRQ priority level is higher than I bit in SR.

The priority level and the vector number of the IRQ is specified by ILVL3-ILVL0 and IVEC7-IVEC0 bits in INTCTL register.
- E\_CER**                      Emulate CPU Address Error. Write only bit. Read 0 only.

When you write 1, CPU Address Error exception will start.
- E\_DER**                      Emulate DMA Address Error. Write only bit. Read 0 only.

When you write 1, DMA Address Error exception will start.
- E\_MRES**                    Emulate Manual Reset. Write only bit. Read 0 only.

When you write 1, Manual Reset exception will start.
- TMRON**                      When 1, 12 bit Interval Timer starts.

When 0, the Interval Timer stops.

BRKON	When 1, start to compare BRKADR with WISHBONE address, and if these are equal, request NMI.
ILVL3-ILVL0IRQ	priority level to be requested (makes EVENT_INFO[11:8])
IVEC7-IVEC0IRQ	vector number to be requested (makes EVENT_INFO[7:0])
TMR11-TMR0	12 bit Interval Timer. When 0x000, it requests IRQ.

BRKADR : Break Address Register

ADR31-ADR0	Break address to be compared to WISHBONE address. It is valid only when BRKON=1.
------------	---

### 4.3.5 On chip memory

#### I. Specification

- 8 KB RAM and 8 KB ROM

#### II. Structure of SYS

The **on chip memory** is a simple memory module configured as ROM and RAM. The total size is 16 kb. The memory module has 8KB ROM and 8KB RAM. Xilinx BRAM is used as a memory module during FPGA implementation. The bit pattern of ROM is specified by “rom.v” description. The memory module’s input output signals are shown in Table: 4.6.

Class	Signal Name	Direction	Meaning	Notes
System Signals	CLK	Input	System clock	
	RST	Input	Power On Reset	
Wishbone Bus Signals	CE	Input	Chip Select (Module Select)	STB
	WE	Input	Write Enable	
	SEL[3:0]	Input	Byte Lane Select	
	ADR[13:0]	Input	Address	
	DATI[31:0]	Input	Data Input (Write Data)	
	DATO[31:0]	Output	Data Output (Read Data)	

**Table: 4. 6 On-chip Memory Input Output Signals**

## 4.4 Conclusions

A SOC architecture proposed which consisting of 32-bit RISC CPU, UART, PIO, System controller and on chip memory. These cores were collected from Open Core site. A design methodology is described is used to implement this SOC architecture on FPGA. The design methodology consists of hardware and software design flow. The hardware design flow implement the SOC architecture into target FPGA. Software design flow is to develop application program which can be ported in the system to verify the final functionality of the system. Finally, the internal structures of the cores were discussed.

# Chapter 5

## **SOC Integration, Verification and FPGA Implementation**

- Integration of IP Cores
- Verification of SOC
- Synthesis results
- FPGA Implementation
- ChipScope Pro Result
- Conclusions



After defining the SOC architecture model and the design methodology to design the SOC, the next step is to integrate all the IP cores to form the final architecture. The steps of integrating the IP cores are described in this section. A test bench is used to verify the top module of SOC using Xilinx ISE Simulator. A set of real time debugging signals are presented to illustrate the internal architecture functionality of the SOC. The steps involving FPGA implementation of the SOC architecture in Virtex-II Pro FPGA is demonstrated. Finally, application codes are developed and ported on to SOC architecture by a monitor program to observe, the SOC functionality.

### **5.1 Integration of IP Cores**

After the completion of both the hardware flow and the software flow, we obtained a hardware model of SOC architecture. The next step is to implement the SOC model on a target FPGA and to port application software on the SOC to verify the functionality of the model. One of the most important tasks in this process is to integrate all the cores collected. Hence there is a need of a top module HDL code which comprises a structural modeling of the IP cores used for the implementation. All the Verilog files of the cores are collected and a top module HDL code is written where Wishbone is the main communicating interface between the IP cores and all the IP cores are interconnected with the point to point interconnection. The 32-bit RISC CPU is the master for all the components. All other component cores are configured as slaves to this master processor. The integration process of point to point interconnection is easier than other types of interconnection architectures described earlier. A set of steps has been considered for the final integration is as follows:

- 1) Each slave component is defined by a specific address value. As the design uses a 32-bit address space, the CPU can access the slaves by their respective addresses. To implement this in the top module an address decoder is designed whose function is to decode the address of slaves and enable the corresponding CE signal of the slave. As described in the IN/OUT signals earlier, each slave is provided by a CE input signal in the design. This helps in avoiding the address conflict and selecting the corresponding slave according to the requirements. The peripheral devices are located in 0xABCDxxxx area. The address map of the peripherals is shown in the Table: 5.1.

Address	Devices	Size	Access Cycle	IF Width	Notes
0x00000000-0x00001FFF	ROM	8KB	1cyc	32bit	A
0x00002000-0x00003FFF	RAM	8KB	1cyc	32bit	B
0x00004000-0x0000FFFF	Shadow of 0x00000000-0x00003FFF				
0x00010000-0x00011FFF	ROM	8KB	4cyc	32bit	Shadow of A
0x00012000-0x00013FFF	RAM	8KB	4cyc	32bit	Shadow of B
0x00014000-0x0001FFFF	Shadow of 0x00010000-0x00013FFF				
0x00020000-0x00021FFF	ROM	8KB	1cyc	16bit	Shadow of A
0x00022000-0x00023FFF	RAM	8KB	1cyc	16bit	Shadow of B
0x00024000-0x0002FFFF	Shadow of 0x00020000-0x00023FFF				
0x00030000-0x00031FFF	ROM	8KB	4cyc	16bit	Shadow of A
0x00032000-0x00033FFF	RAM	8KB	4cyc	16bit	Shadow of B
0x00034000-0x0003FFFF	Shadow of 0x00030000-0x00033FFF				
0x00040000-0xABCCFFFF	Shadow of 0x00000000-0x0003FFFF				
0xABCD0000-0xABCD00FF	PIO	8KB	4cyc	32bit	
0xABCD0100-0xABCD01FF	UART	8KB	4cyc	32bit	
0xABCD0200-0xABCD02FF	SYS	8KB	4cyc	32bit	
0xABCD0300-0xFFFFFFFF	Shadow of 0x00000000-0x0003FFFF				

**Table: 5.1 Address Map of the Peripherals**

- 2) The second issue is the CPU must get proper data when the corresponding slave is enabled. Hence all the outputs of the slaves are passed through an OR gate and connected to the Data Input (DATI) of the CPU. The data output of the CPU DATO is directly connected to all the data input of the slaves.
- 3) All the memory RAM and ROM connected to the CPU has 32-bit data width. When CPU fetches instruction from 32-bit width memory, CPU can get 2 instructions. If the device data width is 16-bit, only one instruction can be sent to CPU at one fetch cycle. This may happen when CPU fetches its instruction from 16-bit width external bus. Hence, CPU must be informed by Wishbone glue logic about the instruction fetch space's width. If the address space is 32-bit width, Wishbone should return IF\_Width equals to 1, else should return IF\_Width as 0. All these have to be done

- before ACK\_I signal is asserted. All the CPU instruction should be verified in a various memory access cycle and instruction fetch size. So the memory access cycle and instruction fetch width are determined by its address. WISHBONE ACK and TAGO\_I (IF-Width) are generated in the top module Verilog file. A FSM is written to generate proper memory access cycles.
- 4) A provision is made during FPGA implementation to interface a LCD and a keyboard with the PIO. Hence several LCD and key control signals are mapped to PIO module. All the input output signals of the top module of the SOC are given in Table: 5.2.

Class	Signal Name	Direction	Meaning	Notes
System Signals	CLK_SRC	Input	System clock	
Parallel I/O Port	RST_n	Input	Power On Reset	Negated
	LCDRS	Output	LCD Register Select	PO[8]
	LCDRW	Output	LCD Read/Write	PO[9]
	LCDE	Output	LCD Enable Signal	PO[10]
	LCDDBO[7:0]	Output	LCD Data Bus Output	PO[7:0]
	LCDDBI[7:0]	Input	LCD Data Bus Input	PI[7:0]
	KEYYO[4:0]	Output	KEY Matrix Y Output	PO[20:16]
	KEYXI[4:0]	Input	KEY Matrix X Input	PI[20:16]
UART	RXD	Input	Receive Serial Data	
	TXD	Output	Transmit Serial Data	
	CTS	Input	Clear To Send	
	RTS	Output	Request To Send	

**Table: 5. 2 Top module Input Output Signals**

Whenever an instruction requires use of the peripheral, the address decoder decodes the address and enables the corresponding peripherals. Then this peripheral takes part in the bus transaction with the CPU Master.

## 5.2 Verification of SOC

A verification step plays an important role in SOC design flow. The peripheral cores used are pre-verified cores, which function accurately. Hence, a test bench is written in Verilog that verifies the CPU's operation. The instructions of the CPU are simulated considering bus transactions, signal levels and register contents, etc. This is done by using an open source simulator Icarus Verilog [19].

### 5.2.1 Verification Environment

The environment used for verifying the instructions are described in this section. The verification program and application program has been developed with the help of GNU [24] assembler and C compiler for Super H-2. SuperH-2 assembler/compiler and simulator for Verilog HDL runs on the UNIX environment. Hence Cygwin [21] is selected as a preferred environment so that all the UNIX based tools can be operated in windows platform. Hence the packages like GNU “Binutils”, “GCC”, “Newlib” and “GDB” are downloaded and installed in the Cygwin environment. Three script files “asm”, “sim”, “genrom” have been provided in the with the project in Open Core site. A verification program is written which contains the CPU instructions. The S-Format object file for this program is created by using “asm” script. After compiling the “genrom” file, a “genrom” executable file is created which converts the S-Format object file to “rom.v” file. The “rom.v” is the rom module which contains the CPU verification instructions. After the “rom.v” file has been created the entire Verilog source file for CPU, UART, SYS and PIO, integrated in a top module, and collected in the home directory of Cygwin environment along with the script files and test bench file. Finally, with the help of “sim” script simulation is accomplished using Icarus Verilog simulator. The writing of test-bench and the outputs simulation are discussed in the next section.

### 5.2.2 Test Bench Development

A test bench is a model which is used to verify the correctness of the design. It generally consists of three parts. It generally consists of three parts:

- To Generate of stimulus for simulation
- To apply the stimulus to “design under test” (DUT), and
- To monitor the output and compare with the expected values.

A test bench is written for the top module of proposed SOC architecture to verify the CPU operation for a set of assembly language program. The test bench contains a clock generator, a reset generator and a set of input pattern generator. As only CPU's functionality is only monitored, therefore the LCD data input LCDDBI is made equal to zero. CTS signal of UART is mapped to '0'. The "top" module is instantiated in the test bench by module instantiation. RXD is supplied by a start bit of '0' followed by 8-bit of data and a stop bit of '1'. Finally, all the observed signals are monitored using \$fdisplay function and written to a result file which is opened by \$fopen Verilog function. Icarus Verilog supports only text mode of output viewer. Hence to view the output a wave form GTKWave [26] is used. The following line should be included in the test bench in order to view the output in GTKWave.

```
initial
begin
    $dumpfile ("test.vcd");
    $dumpvars (0, test);
end
```

where "test.vcd" is the file generated after simulation of the test bench file "test.v".

Upon simulation the Icarus Verilog generates a Value Change Dump (VCD) file. GTKWave open this VCD file to show the wave form of the simulation. GTKWAVE is supported by all the platforms including Linux and Windows. Table: 5.3 contain a list of assembly language instructions. It also lists the corresponding hex code, the bus transaction and output values. As an explanation for the instruction, "LDC R0, SR" the hex code is E0FF, the instruction loads the value of R0 to the SR (Status Register) where the X-Bus and Z-Bus of data path carries the values of R0 and SR respectively.

Sl. No.	ASM Instruction	Hex Code	X-Bus	Y-Bus	Z-Bus	Output
1	MOV #0XFF , R0	E0FF		0XFF	R0	R0 = 0XFF
2	MOV.L _P01234567,	D10C			MAAD	R1= 01234567

	R1					
3	MOV.L _P89ABCDEF, R2	D20C			MAAD	R2= 89ABCDEF
4	LDC R0, SR	400E	R0		SR	SR= 0XFF
5	MOV.L 0X3F3, R0	D014			MAAD	R0= 3F3
6	STC SR, R3	0302		SR	R3	R3= 0XFF
7	LDC R1, GBR	411E	R1		GBR	GBR=01234567
8	STC GBR, R4	0412		GBR	R4	R4=01234567
9	LDC R2, VBR	422E	R2		VBR	VBR=89ABCDEF
10	STC VBR, R5	0522		VBR	R5	R5= 89ABCDEF
11	ADD # 4, R5	7504	R5	4	R5	R5= 89ABCDF3
12	MUL.L R1, R5	0517				MACL= CDDDB5BC5
13	NOP	0009				

**Table: 5. 3 Assembly Instruction with Hex Code, Bus transaction and Output.**

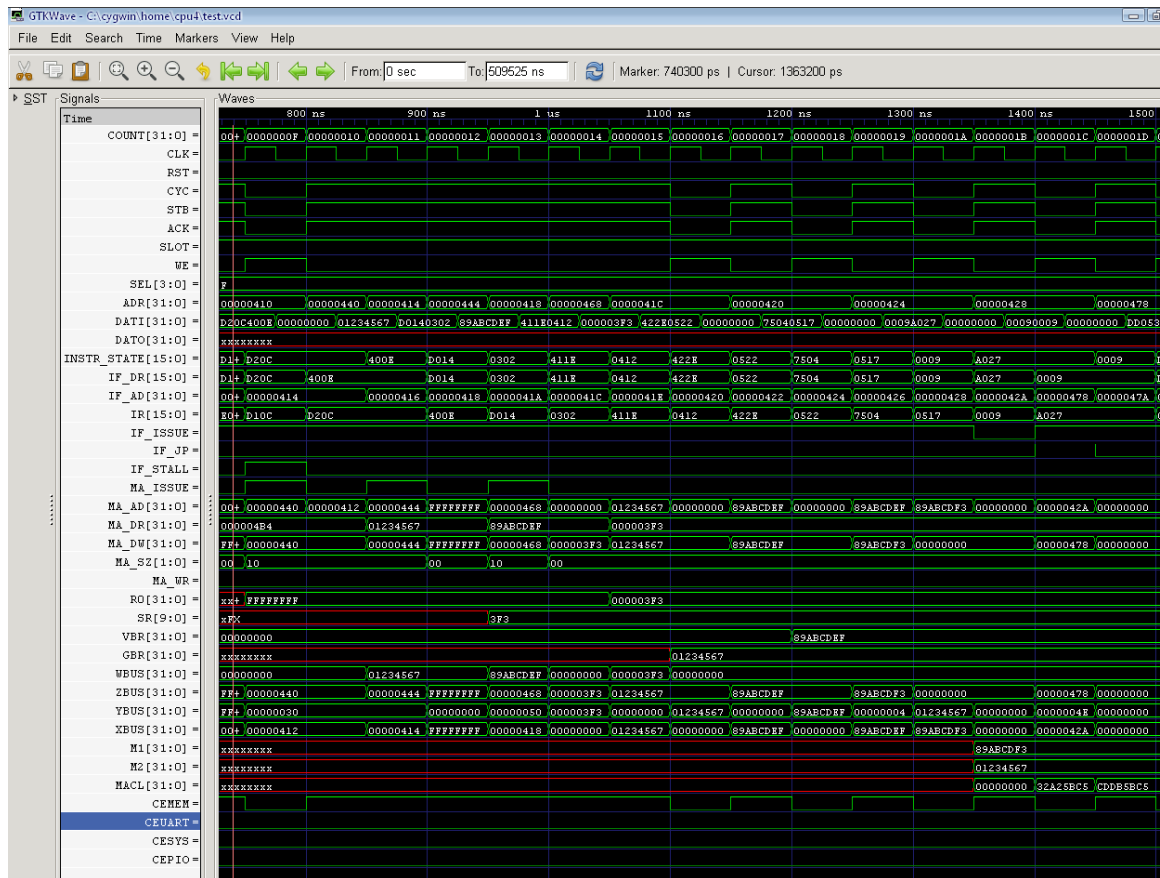
### 5.2.3 Simulation Results

The simulation results are shown in the GTKWave viewer in Figure: 5.1. The simulation result shows the WISHBONE signals and internal signals of CPU for the given assembly language instructions.

It is observed from the waveforms that, the system works on positive edge of clock pulse (CLK) when reset (RST) is active low. The cycle (CYC) indicates the single and block read/write cycles. CYC high indicates a block read/write cycle is uninitiated. During CYC is high, CPU makes strobe (STB) high to inform Slave that a valid bus transaction is initiated. Write enable (WE) high indicates a write operation else a read operation is initiated. As a response Slave responds the CPU Master by asserting the ACK signal as shown in the figure. The select signal (SEL0 is continuously high indicating “F” in the SEL bus of the waveform. The address signal (ADR) show the 32-bit address bus of the system, and DATI and DATO show the 32-bit data bus of the system. All the CPU signal descriptions are given in chapter-4.

CPU transaction for some of the instructions listed in Table: 5.3 are explained as follows:

- For the instruction E0FF, IF\_ISSUE =”1” indicates instruction fetch started and memory access controller sends the instruction to INSTR\_STATE [15:0] of the decoder unit. In the next clock pulse as no interrupt or hardware exception happens, the instruction is latched to instruction register IR [15:0]. Hence, IR [15:0] =”E0FF”. The valid data to be written is at MA\_DW= 0xFF. When CLK is asserted the data is moved to R0 as shown in the figure below.



**Figure: 5. 1 Simulation result of CPU and WISHBONE Bus Transactions**

- For the instruction code D10C and D20C, the long data move to R1 and R2 respectively. The data in the R1 is placed in DATI and DATI placed the data to WBUS of data path. It is observed from the waveform that first WBUS gets a R1 value of “01234567” and then updated to R2 value of “89ABCDEF”.

- Similarly for instruction code 411E, the value of R1 is loaded to GBR. The data path uses Z-bus to contain the value of GBR and X-Bus to contain the value of R1 and we can see from the figure that after IR [15:0] = 411E, GBR updated with a value of “01234567”.
- For the ADD instruction, the immediate value “4” is added to the content of R5. During IR [15:0] = 7504 YBUS contain the immediate value “4” and XBUS contains the old value of R5= “89ABCDEF”. After the instruction is completed the value of R5 (XBUS) is incremented by “4” and gets updated to new value “89ABCDF3”.
- For the MUL instruction R1 and R5 are multiplied. The R1 value from YBUS and R5 value from XBUS are transferred to multiplier latch M1 and M2. Hence, M1= “89ABCDF3” and M2=”01234567”. In the next clock pulse when ACK is high M1 and M2 multiplied and the output register MACL contains the value of “CDD5BC5”.
- It is also observed that during when MA\_ISSUE and IF\_ISSUE are both high (IF\_MA conflict), memory access (MA) gets a priority than instruction fetch (IF). In the final instruction “NOP” no operation is performed by the CPU.
- We can also observe that all the chip enable signal of peripherals such as, CEPIO, CEUART, CESYS are low. The assertion in CEMEM indicates CPU memory transactions are only taken place.

### 5.3 Synthesis results

One of the important steps in hardware design flow described earlier is synthesis of the top module design. The synthesis is the process where RTL level code is converted to real hardware. For this a synthesis tool is required. Xilinx XST is used to compile the RTL behavior of the design to generate a gate level net list for the FPGA. Xilinx Virtex-II pro FPGA is used as a platform for synthesis. The operating frequency is set as 20 MHz.

The synthesis has been done with taking constraints of minimum area and maximum speed. Table: 5.4 and Table: 5.5 show the synthesis results of the designed SOC with area and speed constraints. Table: 5.6 show the comparison of device



utilization for the area and speed constraints. It is observe that with area optimization the design consumes 97% of the available resources and in case of speed optimization synthesis the device utilization is 100%.

<b><u>Design Information</u></b>			
<b>Target Device: xc2vp30-7ff896</b>			
<b><u>Device Utilization Summary</u></b>			
<b>Logic Utilization</b>	<b>used</b>	<b>available</b>	<b>utilization</b>
Number of Slices	<b>2847</b>	<b>13696</b>	<b>20%</b>
Number of Slice Flip Flops	<b>1378</b>	<b>27392</b>	<b>5%</b>
Number of 4 input LUTs	<b>5131</b>	<b>27392</b>	<b>18%</b>
Number of bonded IOBs	<b>37</b>	<b>556</b>	<b>6%</b>
Number of BRAMs	<b>32</b>	<b>136</b>	<b>23%</b>
Number of MULT18X18s	<b>2</b>	<b>136</b>	<b>1%</b>
Number of GCLKs	<b>2</b>	<b>16</b>	<b>12%</b>
Number of DCMs	<b>1</b>	<b>8</b>	<b>12%</b>

**Table: 5. 4 Synthesis Results with Area Optimization**

<b><u>Design Information</u></b>			
<b>Target Device: xc2vp30-7ff896</b>			
<b><u>Device Utilization Summary</u></b>			
<b>Logic Utilization</b>	<b>used</b>	<b>available</b>	<b>utilization</b>
Number of Slices	<b>2925</b>	<b>13696</b>	<b>21%</b>
Number of Slice Flip Flops	<b>1415</b>	<b>27392</b>	<b>5%</b>
Number of 4 input LUTs	<b>5558</b>	<b>27392</b>	<b>20%</b>
Number of bonded IOBs	<b>37</b>	<b>556</b>	<b>6%</b>
Number of BRAMs	<b>32</b>	<b>136</b>	<b>23%</b>
Number of MULT18X18s	<b>2</b>	<b>136</b>	<b>1%</b>
Number of GCLKs	<b>2</b>	<b>16</b>	<b>12%</b>
Number of DCMs	<b>1</b>	<b>8</b>	<b>12%</b>

**Table: 5. 5 Synthesis Results with Speed Optimization**

Synthesis	Slices	Consumed	Frequency
Area 20MHz	2847	97%	153.672 MHz
Speed 20MHz	2925	100%	221.715 MHz

**Table: 5. 6 Comparison of Synthesis Results**

The maximum operating frequency in Virtex-II Pro platform is also listed in Table: 5.6. The final observation from this table is that the operating frequency of the implemented SOC design increases in speed optimized synthesis at the cost of the device utilized.

## **5.4 FPGA Implementation**

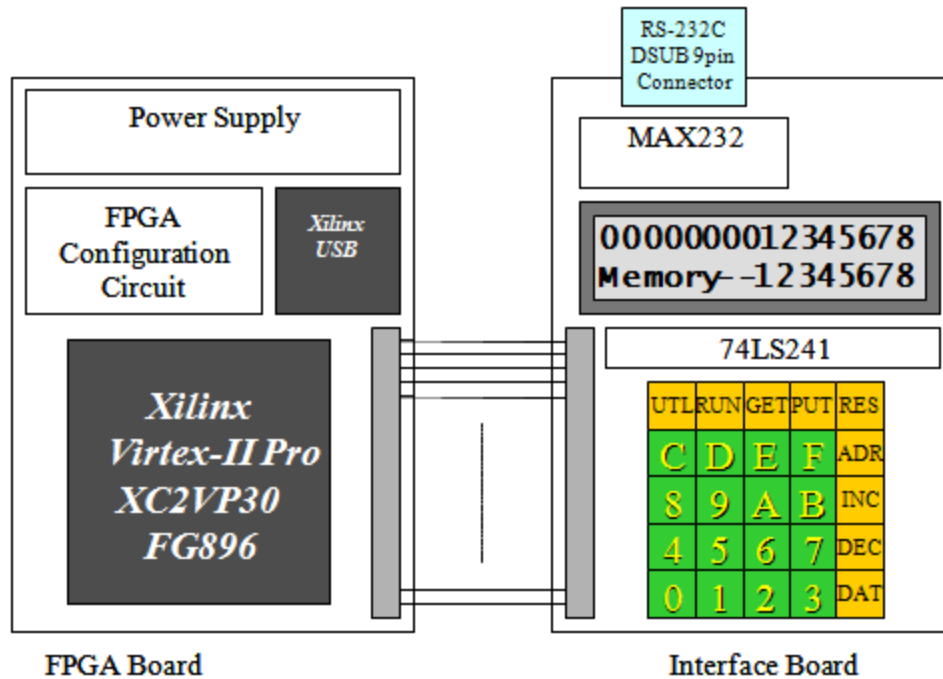
### **5.4.1 FPGA development tool and board**

The final step in hardware design flow is to implement the design in to a FPGA device. FPGA is a hardware logic emulator, where the verification speed is faster than vector logic simulation and the CPU in FPGA can execute very large and long programs quickly, so the verification quality will be improved. A Xilinx Virtex-II Pro (XC2VP30) is used for final hardware implementation of the SOC. Some external circuits are being designed which consists of LCD display, hex key board and RS-232 interface. This helps to verify the hardware functionality smoothly.

### **5.4.2 Interface Board Circuit Diagram**

Figure: 5.2 shows the block diagram of the FPGA implementation system in which an interface board is used to interface with the FPGA board. The interface board consists of a 5x5 hex key pad, a LCD and a RS 232 interface. In real experiment we have used two different boards, one for LCD and Keypad and other one for UART and other circuit connection. Some of the PIO terminals are configured in the top module to use as an input and output terminal of the system. The keypads and LCD terminals are connected

to the port inputs and outputs of the SOC. The keypad helps in sending input data and to view the output result LCD is used.



**Figure: 5.2 Block Diagram of Experimental Set-Up for FPGA Implementation**

Figure: 5.3 shows the circuit diagram of interface board which consists of a 5x5 keypad, LCD module and RS-232 interface for cross cable connection. The bus interface is bi-direction, so 74LS241 buffers are used to interface LCD terminals with the FPGA. 100 ohm registers are inserted between 74LS241 [27] output and FPGA input to make the FPGA terminal voltage tolerant. MAX232 IC [28] with a DB-9 connector with cross-cable connection is used to implement serial I/O functionality of SOC. The key matrix 5x5 contains 25 numbers of keys to input hex data, and some commands. To avoid conflicts on FPGA output pins when multiple keys are pushed, 1kohm registers are connected in series with the output pins. Figure: 5.4 show the experimental set up of FPGA implementation.

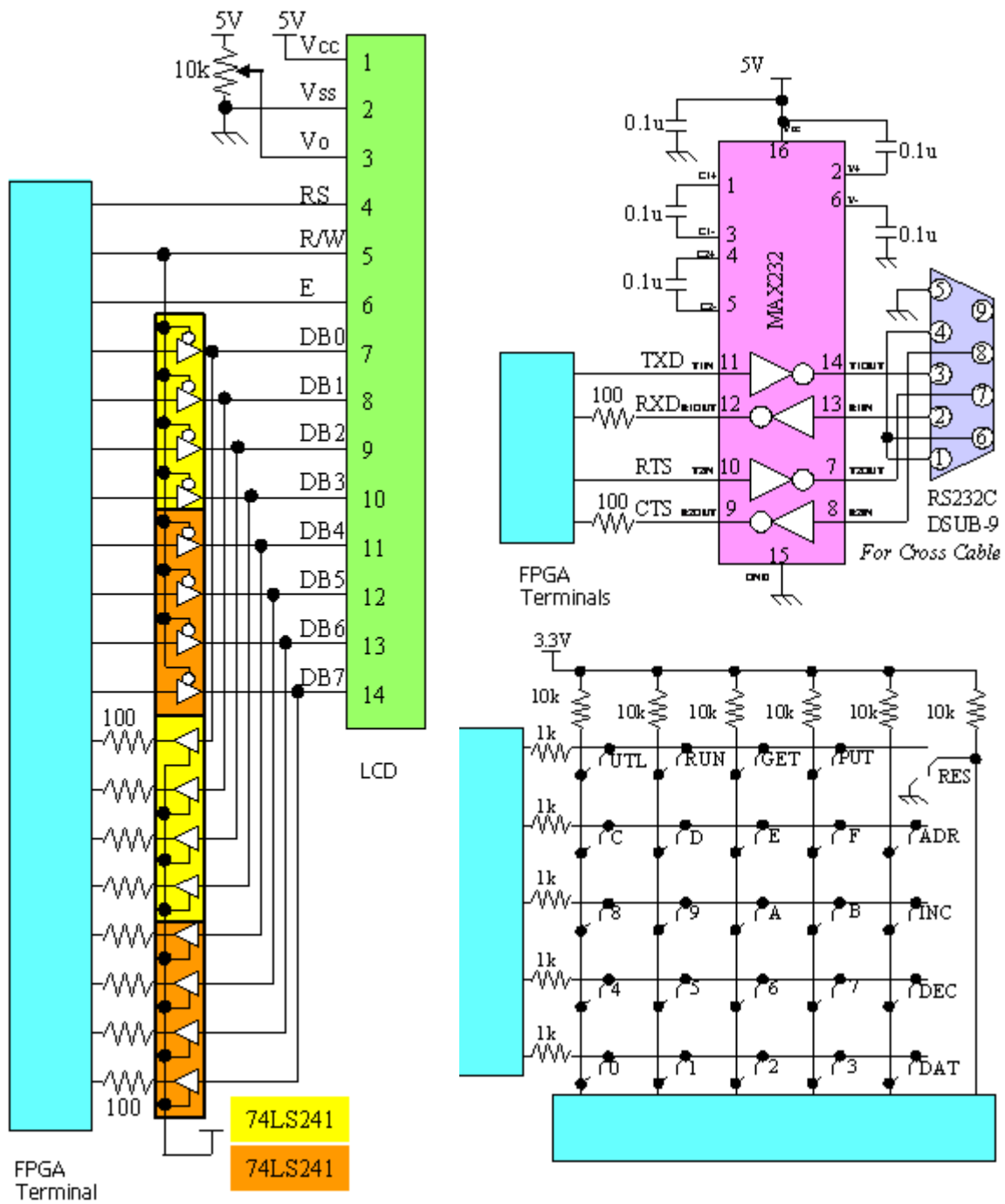
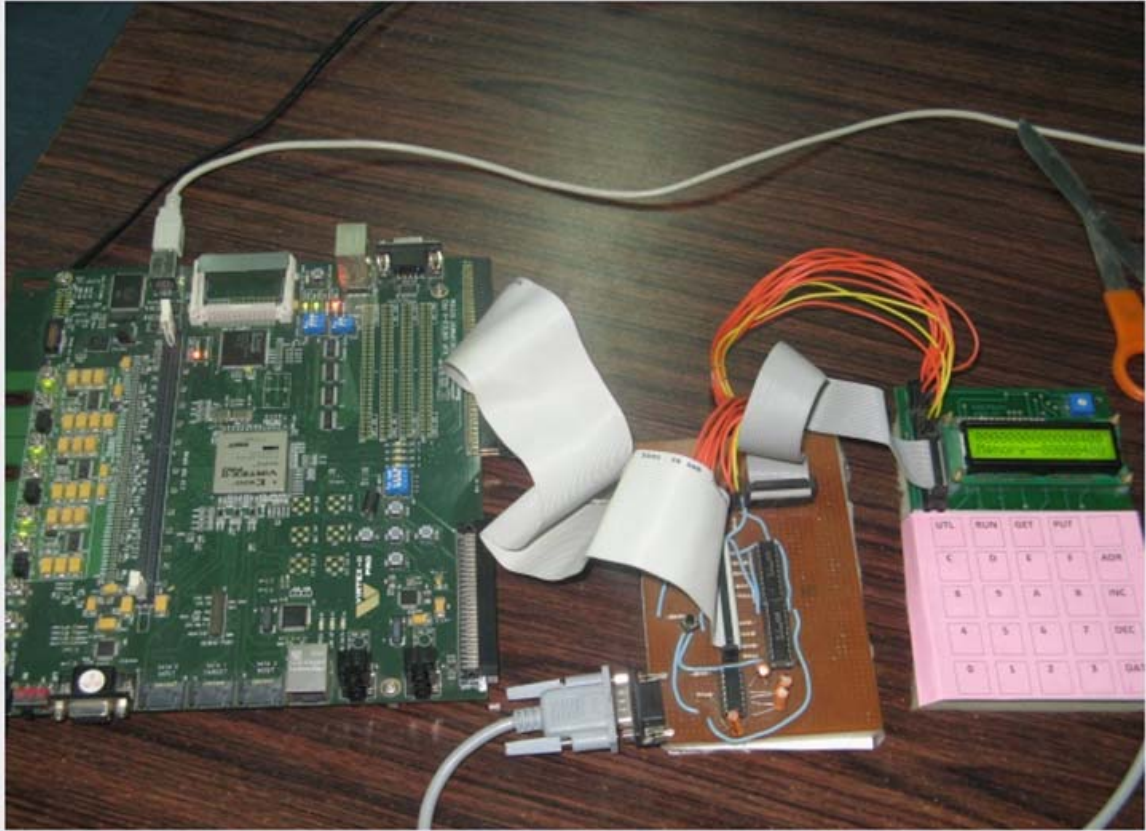


Figure: 5.3 Circuit diagram of interfacing board



**Figure: 5. 4 Experimental Set-Up pf FPGA Implementation**

### **5.4.3 FPGA Configuration**

The final step in hardware design flow is FPGA implementation. The gate level net list generated during the synthesis step is used by Xilinx place and route tools to perform mapping, placing, and routing for target FPGA. For this a user constraints file (UCF) has been made where assignment, timing constraints are specified. Xilinx uses block ram to serve as a ROM and RAM module. Hence the instructions have to be converted in to ASCII file and block ram should be initialized with these values. The INIT statement uses “INST” directive followed by memory module name and its initial values written in UCF files to initialize a block ram.

All the application code written in C after compilation generates an S-Format object file. By using a “genram” script file given in Open Core project site this S-Format file can be converted to block ram INIT statement.

Then Place and route is done using Xilinx ISE tools and finally, after the place and route is over, Xilinx Impact tool is used to generate a bit stream file to program the FPGA. Finally, the FPGA implementation of the SOC architecture has been completed successfully.

## 5.5 ChipScope Pro Result

The real time signal of the CPU showing only the chip enable of peripherals high is given in Figure: 5.5. It is observed that whenever the chip enable of memory (CEMEM) is low and a trigger is given to the “GET” in the keypad, the corresponding chip enable of UART (CEUART) is high indicates the UART peripheral is enabled and waits for the data to be transmitted by the programmer.

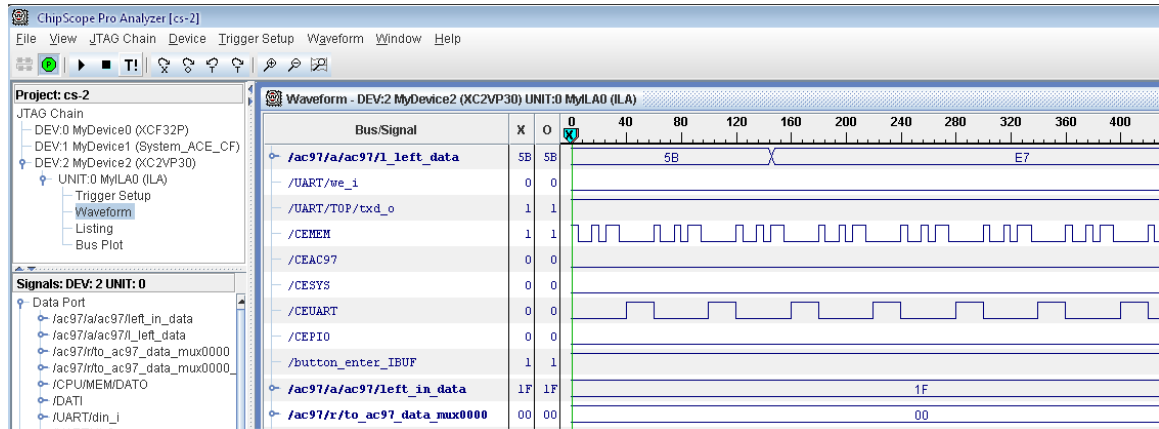


Figure: 5.5 Real time chip enable signal of UART during serial transmission with PC

## 5.6 Conclusion

The cores are integrated in a point-to-point interconnection with a specific address map. After integration the SOC functionality is verified in simulation level and found that it functions accurately for a given assembly instructions. Finally, the FPGA implementation of SOC architecture is done and found that it is utilizing 97 % of resources available in Xilinx Virtex-II Pro FPGA with a minim slice count of 2847. It is also observed that it can be operated in a maximum frequency of 221.715 MHz in the specified FPGA architecture.

# Chapter 6

## Application Development for SOC

- **Application Programs**
- **Monitor Program Application**
- **Digital Clock Application**
- **Audio Processing Application**
- **Conclusions**

The final stage of SOC design flow is the real time functionality verification of designed SOC architecture. A set of applications are developed in order to verify the functionality. The application includes are monitor program, and clock application. Finally, an AC97 WISHBONE compatible controller core is designed and integrated with SOC for audio processing application.

## **6.1 Application Programs**

One of the important flows in SOC design methodology is development of application program which when loaded on the SOC architecture implemented in FPGA performs some specific operations. The application program development requires a software environment to develop it. Cygwin [21] is selected as the preferred environment for this purpose. SuperH-2 assembler, compiler and debugger are used to build the application program. Application program written in ‘C’ is compiled by GNU GCC [24] and then debug by GNU GDB debugger. Finally by using monitor program provided by Open Core the application is loaded in the SOC architecture and the functionality of SOC is verified. The monitor program is converted to ASCII values and the values are written to BRAM during FPGA implementation. Two programs written in C used for the application development are

- Monitor program for memory editing and program loading.
- Timer application code for verification of functionality of the SOC.

While compiling the ‘C’ codes a start up program (crt0.s) and linker script (sh.x) provided in Open Core project site is used along with a C compiler header file files. A make file is used to compile and link the C files.

## **6.2 Monitor Program Application**

### **6.2.1 Algorithm for monitor program**

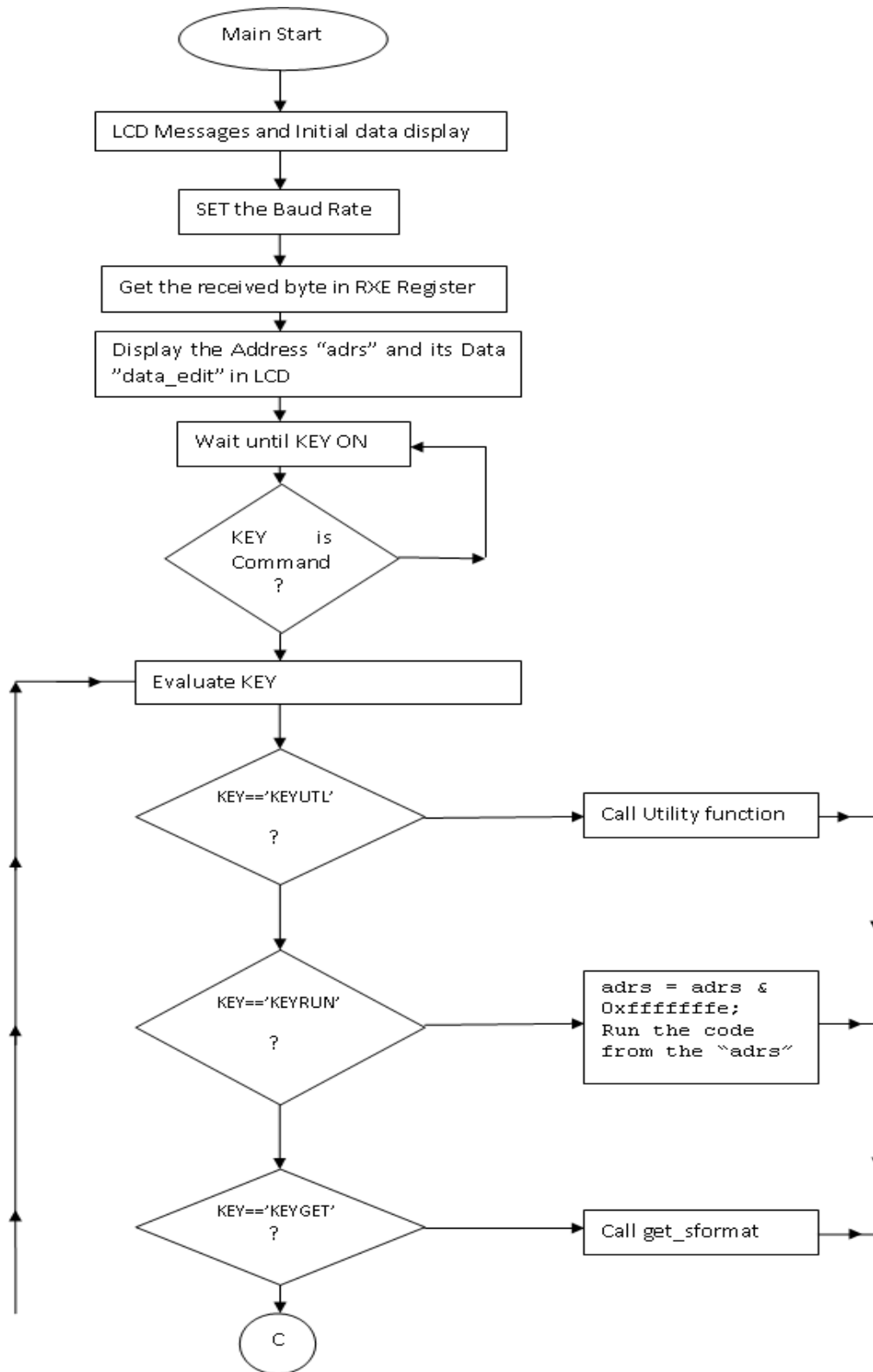
The monitor program along with LCD display, keyboard and RS-232 interface circuit performs debugging operation such as memory editor and program loader from PC to SOC architecture. It also has additional capabilities like jumping to program and debugging features such as setting of break point and reading registers. To write the monitor program many functions are created in “C” and in a main program this functions are called. Some of the functions are written below in the Table: 6.1.



<b>Service Functions</b>	
Utility functions set	Break point Set and show register value
Command	Command handler take input command pressing key
Error and Illegal	Indicates address error and illegal instruction
NMI_handler	Handle non maskable interrupt
Irq_handler	Handle IRQ
Get_S format	Get S-format and return Top address of the binary value
Get_byte_rx_echo	Get byte from Rx with echo
Hex2asc	Converts the hex values to ascii values
Asc2hex	Converts the ascii values to hex values.(nibble)
<b>Key utilities</b>	
WaitNms	It creates a delay of N ms
Key_scan ( )	Output push key code
Key_wait_on	Wait until key on
Key_wait_off	Wait until key off
<b>UART utility functions</b>	
Uart_tx	Take input data to transmit
Uart_rx	Output receive data
Uart_rx_echo	Receive Rx with echo to Tx
Uart_rx_flush	Flush RxD FIFO
Uart_set_baudrate	Set baudrate value
<b>LCD utility functions</b>	
Lcd_disp_long	LCD displays long Hex data (8 digit)
Lcd_cursor	Cursor on/off
Lcd_erase	Erase one line from the position
Lcd_messge	Print a message from current position
Lcd_disp	Display one character on current position
Lcd_pos	Set LCD display position
Lcd_ready	Wait until LCD ready
Lcd_rd	LCD read
Lcd_wr, Lcd_init	LCD write, LCD initialize

**Table: 6. 1 List of Functions used in Monitor Program**

The flowchart of the monitor program written in “C” is given in Figure: 6.1



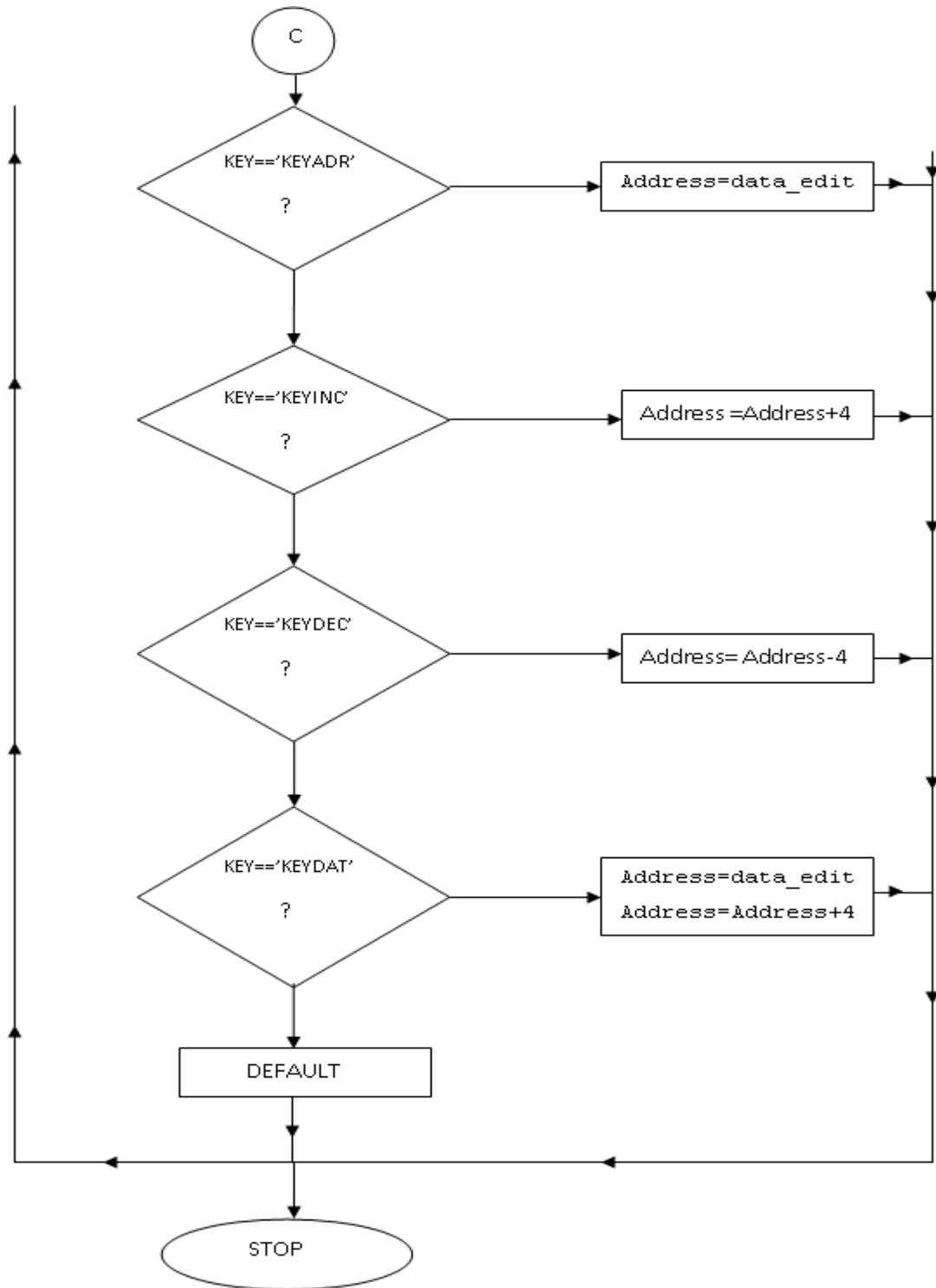


Figure: 6. 1 Flow Chart of Monitor Program.

## 6.2.2 How Monitor Program Works

The working procedure of how the monitor program works in real time environment is described as follows. The corresponding LCD outputs in pictorial form are presented in Figure: 6.2.

### A. Memory editor:

#### a. Power On Reset (Start Up):

It shows a long-word sized data in the LCD. In the top line the left 8 hex numbers shows memory address and right 8 hex numbers shows the data at this addresses.

#### b. Increment Address:

The “INC” key on the hex key pad increases the address by 4-byte and the corresponding data at this address appears at the right side hex numbers.

#### c. Decrement Address:

The “DEC” key on the key pad decreases the address by -4-byte, and the corresponding data at this address appears at the right side hex numbers.

#### d. Enter And Set Address:

In order to view a data at other address location, enter a 4-byte address at the bottom and push “ADR” key and the data will appear at the right side of the top line. If address entered is not multiple of 4, the lower 2-bits of address are cleared to 0, to avoid address error.

#### e. Enter And Write Data:

In order to change the data displayed in an address location, enter the new data at the bottom line and press “DAT” key will update the new data and increases the address by 4-byte. To verify the data written press “DEC” key.

### B. Program Loader.

#### f. Program Loading From PC

#### g. Loading

#### h. Finish Loading

The S-Format (S3) object file can be downloaded to PC via RS-232 interface. The default baud rate used for this is 1200 bps. The baud rate can be changed by changing UARTBG0 and UARTBG1 register values in monitor program. The S-Format records comprises S0 (comment), S3 (actual object), and S7 (end of record). By using

the Makefile and “asm” script file the S-Format file can be generated. Pressing “GET” key in the key pad, the FPGA system waits for sending data. The data can be sent to FPGA by using hyper terminal application of PC. During the transfer of objects the top address of every record is shown in the LCD. If any check sum error is found by the monitor, the transfer will stop. When S7 is received by the monitor, the program loading is stopped.

#### C. Run

i. Target Address Set And Goes To Program

j. Running Program

An application code for LCD display is developed and the S-Format file is loaded to the FPGA system. This program is located at 0x00003000 (vector table present here) and to start the program jump to the actual address 0x00003008 by pressing “ADR” key. To start running the program “RUN” button is used and the LCD displays some preset characters such as “SOC @ NIT RKL”. “RST” is used to make the system power on reset.

#### D. Debug Utility

k. Select Register Reading And Check All CPU Registers

Pressing “UTL” and “1” key all register content can be checked.

l. Enter Break Address

Pressing “UTL” key and “2” and the break address from the key pad t

m. Set Break Point, Try A Break,

n. Break Happens.

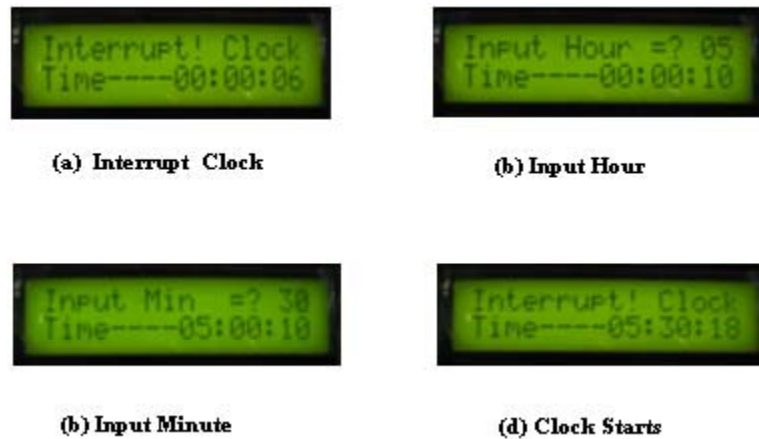
Pressing ‘UTL’ key and entering “2” and the break address from the key pad can be sent to the FPGA system. Then pressing DAT confirms the break operation. If a value 0x00003800 is set as break point, then accessing 0x00003800 monitor reports BRK has happened.



Figure: 6. 2 Monitor output presented in a pictorial form

### 6.3 Digital Clock Application

After the monitor program is verified an application example of digital clock is verified in the SOC architecture. The digital clock uses IRQ from interval timer. The timer request IRQ and the IRQ routine controls the internal software counter to display time. The program vector table is located from address 0x00002000 but actual program starts by jumping to the address 0x00002400 by monitor program. The clock “DAT” key is pushed two times to enter hour and minute. Finally, the clock starts after pushing the DAT key.



**Figure: 6. 3 Output of Real Time Clock Application**

Figure: 6.3 shows the output of real time clock which shows the current time

### 6.4 Audio Processing Application

A new application is developed whose function is to create a SOC platform for audio processing. A SOC platform in FPGA has already been built which is having capability of processing 32-bit data and communicating with the PC and e applications can be developed using C and run on the proposed SOC architecture. In order to perform audio processing application in FPGA, two major things are required and those are, an interface between analog world of audio components (headphones and microphones) and digital world of FPGA. Virtex-II Pro FPGA board is equipped with an AC97 Audio Codec chip LM4550 [25] which serves as an interface between FPGA and analog world components. The second one is an IP core that will control the AC97 audio codec by sending and receiving appropriate signals between the FPGA and analog world. Hence for processing the audio signal the SOC architecture should support an AC97 audio codec controller. For this purpose an AC97 controller core is required to be integrated with the proposed SOC architecture.

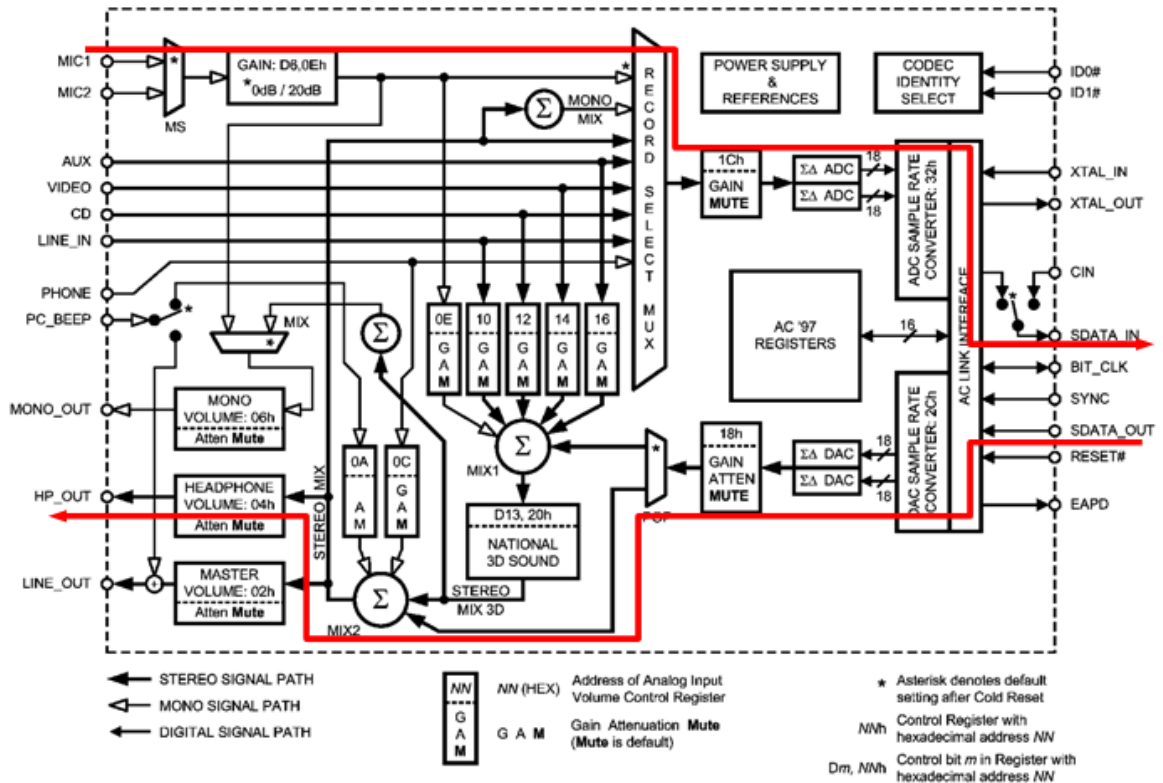


Figure: 6. 4 Block diagram of LM4550 audio codec.



Therefore, an AC97 core is designed and made WISHBONE compatible. The details of the internal structure of the core with its verification results for a loop back tests are presented in this section.

### 6.4.1 AC97 Codec

The block diagram shown in Figure: 6.4 present an idea of how AC97 audio codec functions in real time environment. The AC'97 codec on Virtex-II Pro board is used for providing a path to capture all types of analog signal that can be processed digitally. The features of this codec are

- full duplex stereo ADCs and DACs and analog mixers
- 4 stereo and 4 mono inputs.
- Each mixer input has separate gain, attenuation and mute control
- The AC'97 provides a stereo headphone amplifier as one of its stereo outputs.

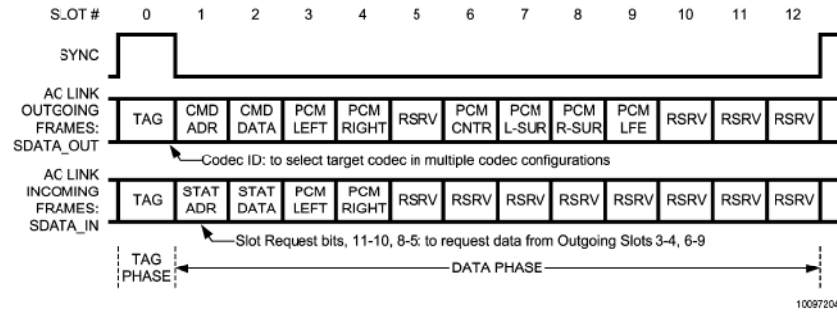
#### *Incoming audio from microphone*

The incoming audio data from the microphone is amplified by +20 db by an on-chip amplifier. The amplified data is fed to one of the two 18-bit sigma-delta ADCs ( $\Sigma\Delta$ ADCs) which samples the analog data at 48 kHz, digitizes the sample voltages and produce an output sequences of 18-bit two's complement numbers (termed as PCM data). Each pair (left and right channel) of PCM samples is packaged along with other status data into a 256-bit frame which is then transmitted serially at 12.288 MHz ( $= 256 * 48\text{Khz}$ ) to the FPGA via the SDATA-IN pin.

#### *Outgoing audio to headphones*

The FPGA transmits a 256-bit frame of serial data to the AC97 chip via the SDATA-OUT pin. Each frame contains two 18-bit fields with PCM data for the left and right audio channels. The PCM data is converted to two 48 kHz analog waveforms by the sigma-delta digital-to-analog converters ( $\Sigma\Delta$ DACs). The analog waveforms are amplified and sent to the stereo headphones.

### AC Link Serial Interface Protocol



**Figure: 6.5 AC link serial interface protocol**

Figure: 6.5 shows the AC link serial interface protocol where SDATA\_OUT and SDATA\_IN signal carries AC link outgoing frames and AC link incoming frames respectively. SDATA\_IN is an output signal from the AC97 controller and input to the codec. Output frames are consists of one Tag SLOT and twelve data SLOTS. Output frame starts with a low-to-high transition of SYNC which should be clocked from the controller on a rising edge of BIT\_CLK (not shown in the figure). Each frame consists of 256-bits with each of the twelve data SLOTS containing 20-bits. The first bit of SLOT 0 is designated as “valid frame”. If this bit is 1, it indicates that the current output frame contains at least one slot of valid data and the codec will check further tag bits for valid data in the expected data SLOTS. SLOT 1 is used by a controller to indicate both the address of a target register in the codec and whether the access operation is register read or register write. SLOT 2 is used to transmit 16-bit control data to the codec when the access operation is “write”. SLOTS 3 and 4 are 20-bit fields used to transmit PCM data to the left and right channels of the stereo DAC when the codec is in Primary mode or Secondary mode 1. SLOTS 7 and 8 are 20-bit fields used to transmit PCM data to the left and right channels of the stereo DAC when the codec is in Secondary mode 2. Any unused bits should be stuffed with zeros. SLOTS 6 and 9 are 20-bit fields used to transmit PCM data to the left and right channels of the stereo DAC when the codec is in Secondary mode 3. Any unused bits should be stuffed with zeros. SLOTS 5, 10, 11, 12 are reserved SLOTS, are not used by the codec and should all be stuffed with zeros by the AC97 Controller.

SDATA\_IN signal is an input to the AC97 Digital Audio Controller and an output from the codec. Input Frames consists of one Tag SLOT followed by twelve Data SLOTS. SLOT 1 echoes (in bits 18 – 12) the 7-bit address of the codec control/status register received from the controller as part of a read-request in the previous frame. By default, data is requested in every frame, corresponding to a sample rate equal to the frame rate (SYNC frequency) – 48 kHz when XTAL\_IN = 24.576 MHz.

The SLOT 2 returns 16-bit status data read from a codec control/ status register. The codec sends the data in the frame following a read-request by the controller. This SLOT 3 and SLOT 4 contain sampled data from the left and right channel of the stereo ADC. The signal to be digitized is selected using the Record Select register (1Ah) and subsequently routed through the Record Select Multiplexer and the Record Gain amplifier to the ADC. This is a 20-bit SLOT and the digitized 18-bit PCM data is transmitted in MSB justified format. The remaining 2 LSBs are stuffed with zeros. Slots 5-12 of the AC Link Input Frame are reserved slot not used for data by the codec and are always stuffed with zeros.

#### **6.4.2 Wishbone compatible AC97 Controller core design and Verification**

AC97 codec follows the AC serial link protocol to send or receive the PCM data. Therefore, an AC97 controller core is required to keep up with the codec's data rates. With considering these design criteria, AC97 controller is being designed that has the following components:

*Top*: This module is the top module that includes instances of the *AC97\_top* and *recorder* blocks. This also has the WISHBONE bus interface.

*AC97\_Top*: This block is a wrapper around the *AC97\_interface* and *AC97\_commands*. This module has three ports: a ready output which indicates that a new sample is ready, and two 8-bit data ports, one for incoming PCM data and one for outgoing PCM data.

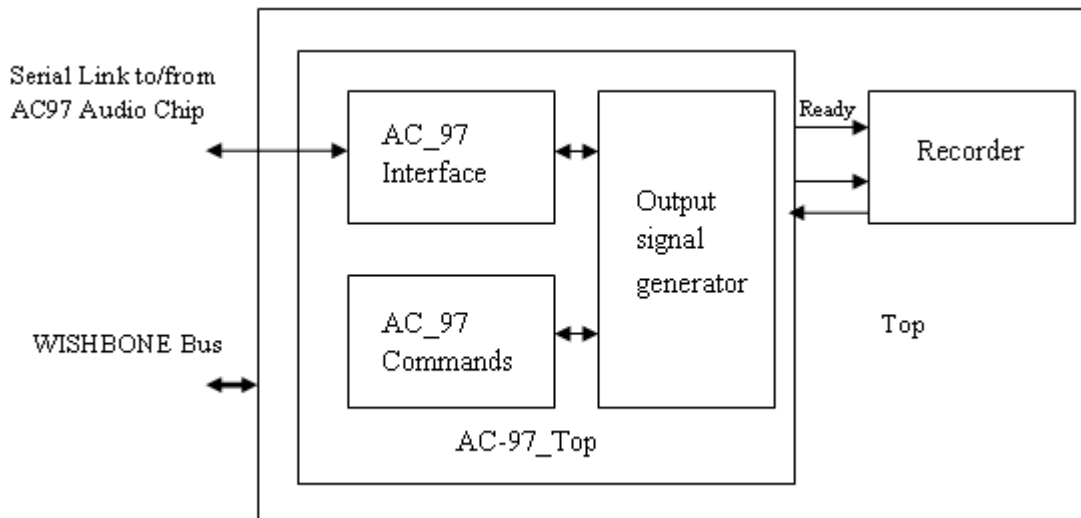
*AC97\_Interface*: This block has ports for incoming and outgoing 18-bit stereo PCM data. It provides interface to the AC97 codec and transmit and receive the 256-bit serial data streams.

*AC97\_Commands*: This block generates commands to write to the AC97 command registers for performing the appropriate initialization. The various commands are

selecting the amplifier gains, selecting the microphone as the input source, setting headphone volume.

*Recorder:* This module checks the basic functionality of head phone and microphone. In playback mode, it loops incoming samples from microphone back to the outgoing data stream, so that voice can be listened in the headphone.

Figure: 6.6 show the block diagram of AC97 controller module. The core is made wishbone compatible and it supports the WISHBONE signals such as, DATI, DATO, CE (STB) and SEL. AC97 controller receives the serial audio data from microphone at *ac97\_sdata\_in* and inputs it to AC97\_top module that converts the input to 8-bit PCM data and sends to *audio\_in\_data* output signal which is connected to the lower 8-bit of DATO output terminal.



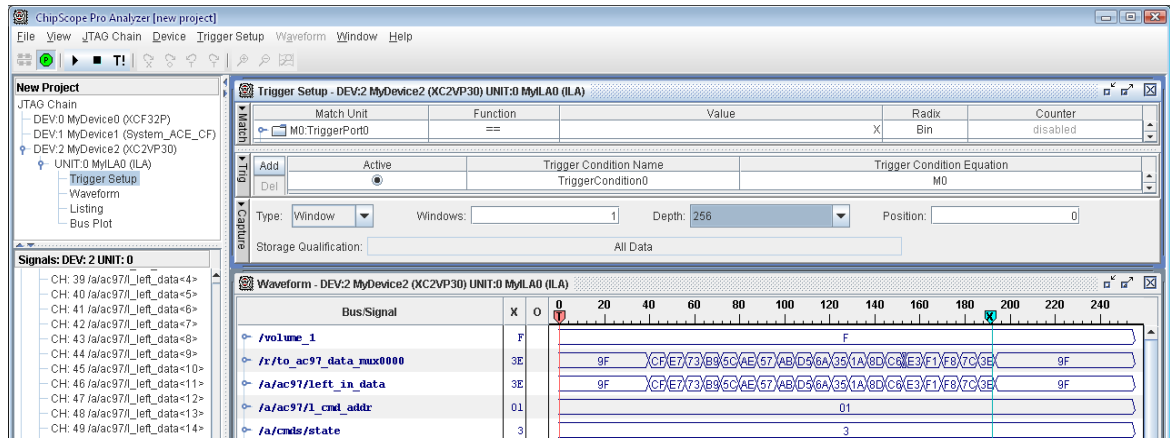
**Figure: 6. 6 Block Diagram of AC97 Controller Core**

The 8-bit PC data from DATI input is latched to the recorder input terminal *from\_ac97\_data* at raising edge of clock pulse. The recorder sends the data to the *ac97\_top* module. The *ac97\_top* module adds the appropriate command address to this data and serially sends it to the output terminal *ac97\_sdata\_out* where a head phone can be used to hear the audio input.

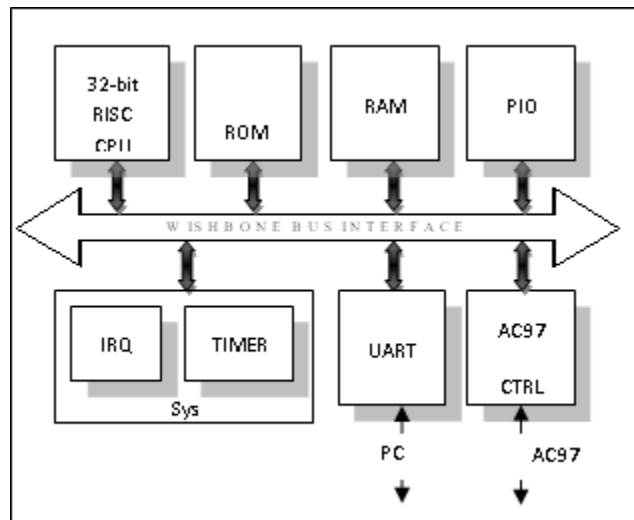
To perform the real time experiment the design is implemented in Xilinx Virtex-II Pro and a loop back test is performed to verify the module's functionality. In loop back test the PCM data output at the DATO terminal is fed back to the DATI terminal so that the audio input from the microphone at *ac97\_sdata\_in* can be heard with a head phone at

*ac97\_sdata\_out*. The verification of the functionality of the core for loop back test is observed using Xilinx ChipScope Pro tools.

Figure: 6.7 shows the real time signals of the loop back test performed. The audio signal at *ac97\_sdata\_in* is converted to 8-bit PCM data by A97\_Top module and available at *left\_in\_data* which is again latched to the input of the recorder module at the rising edge of clock pulse. During playback mode the recorder module the data is routed to the *to\_ac97\_data\_mux0000* terminal of AC97\_Top module. AC97\_Top module adds the PCM data with appropriate command address and the audio signal can available for hearing at *ac97\_sdata\_out*. Hence it is observed from the figure that the data input and output are same set of PCM data.



**Figure: 6. 7 real time signals of AC 97 Controller for the loop back test performed**



**Figure: 6. 8 SOC Architecture for Audio Processing Application**

<b><u>Design Information</u></b>			
<b>Target Device: xc2vp30-7ff896 (Virtex-II Pro)</b>			
<b><u>Device Utilization Summary</u></b>			
<b>Logic Utilization</b>	<b>used</b>	<b>available</b>	<b>utilization</b>
Number of Slices	<b>3028</b>	<b>13696</b>	<b>20%</b>
Number of Slice Flip Flops	<b>1564</b>	<b>27392</b>	<b>5%</b>
Number of 4 input LUTs	<b>5448</b>	<b>27392</b>	<b>18%</b>
Number of bonded IOBs	<b>73</b>	<b>556</b>	<b>6%</b>
Number of BRAMs	<b>32</b>	<b>136</b>	<b>23%</b>
Number of MULT18X18s	<b>2</b>	<b>136</b>	<b>1%</b>
Number of GCLKs	<b>3</b>	<b>16</b>	<b>12%</b>
Number of DCMs	<b>1</b>	<b>8</b>	<b>12%</b>

**Table: 6. 2 Device Utilization Summary for Audio Processing application**

Finally the A97 controller core is integrated to the proposed SOC architecture and the address of the core is defined at 0xABCD03xxx. Figure: 6.8 show the new SOC architecture for audio processing application. Table: 6.2 show the device utilization summary for a Virtex-II Pro FPGA board.

## **6.5 Conclusions**

Applications such as monitor programming, real time clock are developed and the functionality of the designed SOC architecture was by verified by porting application code to the FOGA system. Finally an audio processing SOC architecture was designed and implemented in Xilinx Virtex-II Pro FPGA platform.

# Chapter 7

## Conclusions

- **Conclusions**
- **Scope for Future Work**



## 7.1 Conclusions

The recent advances in silicon technology now enable new levels of system integration onto a single chip and allow building of chips consisting of millions of transistors. With the evolution of technology and the increase in demands of more powerful products System-on-chip (SOC) design has moved from leading edge to main-stream design practice. Hence, there is a need of SOC design methodologies that are reliable and requires shorter time to market. After a complete literature survey we observe that “Design-reuse” is the key factor behind SOC design. This thesis investigated two design methodologies such as PBD and open core based SOC design methodology. PBD design is an emerging technology that utilizes previously design platform of abstraction level to design the SOC, but it requires a library of platform which can only be possible in industry environment. On the other hand open core SOC design utilizes standard WISHBONE bus interface for design reuse and help in plug and play integration of freely available IP cores to produce low cost, reliable, time-to-market SOC design.

The complete Wishbone literature has been reviewed and compared with two standard bus interface AMBA and CoreConnect and the following conclusions are made:

- It is a standard interface available freely and can be used SOC integration without any additional cost.
- It supports variable interconnection and variable time-specification.
- It supports single Read/Write; block Read/Write bus cycles. It also supports RMW cycle as compared to split transaction of AMBA and core connect to share memory used in multiprocessor SOC environment.
- It can be coded using any hardware description language like VHDL and Verilog and for implementation it takes simple logic gates supported by most of the FPGA and ASIC devices.

Two small system designs have been developed using both point-to-point and share-bus interconnections. The issues related to design and integration of point-to-point and shared bus interconnections are discussed and verification of the designs has been done using Xilinx ISE Simulator. Here two types of FPGA devices have been used as emulation platforms for validation of the functionality of the systems.



The following points are observed from these experiments:

- Point-to-point interconnection is the simplest interconnection architecture where a single Master communicates with many Slaves. An address decoder is used by the Master to decode the Slaves to communicate. The minimum size required to form this system is 40 slices in FPGA. The operating frequency is more than 100 MHz. Operating frequency depends on the target platform. For high speed FPGA like Virtex-II Pro the operating frequency is higher than that of low speed FPGA Spartan3e with almost same implementation size.
- The shared bus interconnection is very useful for more than one Masters. It requires an arbiter which grants the access to the requesting Master. For this a round robin arbiter has been chosen than a priority arbiter. Multiplexor bus logic is used for interconnection logic as multiplexors are supported by most of the FPGA and ASIC devices.

It is observed that the operating frequency of this type of interconnection is more than 100 MHz and depends on the target platform technology. In Virtex-II Pro the frequency is higher than the Spantan3e FPGA but it uses an approximately 292 slices to implement the interconnection in the two FPGAs.

Finally, SOC architecture is proposed and the design methodology for designing the SOC is presented. The SOC design utilizes reusable IP cores from Open Core. The various issues related to the integration, verification, and FPGA implementation in Virtex-II Pro has been discussed. It is observed from the area optimized synthesis results that the SOC is utilizing 97% of the available resources of FPGA. In case synthesis is done using speed optimization the device utilization is 100 %. The power consumption as calculated by Xilinx XPower is 43 mw. The operating frequency is 20 MHz but it can be operated to a maximum frequency of 221.715 MHz in Virtex –II Pro FPGA Platform. The final validation of the SOC architecture has been done by developing a monitor program in C which performs memory editing and program loading from the PC to FPGA. An interrupt clock program is developed that displays the current time. An audio processing SOC platform has been made by integrating an AC97 controller core to the proposed SOC architecture and the device utilization is 3028 slice count. We have successfully

implemented the proposed SOC architecture and developed a few applications that validate the SOC concept.

## **7.2 Scope for Future Work**

Solving the problems faced by industry in designing System on Chip research like:

1. More complex architectures like multi master multi slave configuration using shared bus interconnection can be designed.
2. Verification of the complete SOC system using professional verification techniques like Constraint random coverage driven methods.
3. Adding more complex IP's in both digital and Analog arena like Ethernet and high speed ADC's will give more applications for designed SoC.
4. Designing better Testability features to SoC.

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**DISSEMINATION OF THE RESEARCH WORK :**

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